



EBU WAN PLL

IDT82V3202

Version 5
September 11, 2009

6024 Silver Creek Valley Road, San Jose, CA 95138
Telephone: (800) 345-7015 • TWX: 910-338-2070 • FAX: (408) 284-2775
Printed in U.S.A.
© 2009 Integrated Device Technology, Inc.

DISCLAIMER

Integrated Device Technology, Inc. reserves the right to make changes to its products or specifications at any time, without notice, in order to improve design or performance and to supply the best possible product. IDT does not assume any responsibility for use of any circuitry described other than the circuitry embodied in an IDT product. The Company makes no representations that circuitry described herein is free from patent infringement or other rights of third parties which may result from its use. No license is granted by implication or otherwise under any patent, patent rights or other rights, of Integrated Device Technology, Inc.

LIFE SUPPORT POLICY

Integrated Device Technology's products are not authorized for use as critical components in life support devices or systems unless a specific written agreement pertaining to such intended use is executed between the manufacturer and an officer of IDT.

1. Life support devices or systems are devices or systems which (a) are intended for surgical implant into the body or (b) support or sustain life and whose failure to perform, when properly used in accordance with instructions for use provided in the labeling, can be reasonably expected to result in a significant injury to the user.
 2. A critical component is any components of a life support device or system whose failure to perform can be reasonably expected to cause the failure of the life support device or system, or to affect its safety or effectiveness.
-



Table of Contents

FEATURES	9
HIGHLIGHTS	9
MAIN FEATURES	9
OTHER FEATURES	9
APPLICATIONS	9
DESCRIPTION	10
FUNCTIONAL BLOCK DIAGRAM	11
1 PIN ASSIGNMENT	12
2 PIN DESCRIPTION	14
3 FUNCTIONAL DESCRIPTION	18
3.1 RESET	18
3.2 MASTER CLOCK	18
3.3 INPUT CLOCKS & FRAME SYNC SIGNALS	19
3.3.1 Input Clocks	19
3.3.2 Frame SYNC Input Signals	19
3.4 INPUT CLOCK PRE-DIVIDER	20
3.5 INPUT CLOCK QUALITY MONITORING	21
3.5.1 Activity Monitoring	21
3.5.2 Frequency Monitoring	22
3.6 DPLL INPUT CLOCK SELECTION	23
3.6.1 External Fast Selection	23
3.6.2 Forced Selection	24
3.6.3 Automatic Selection	24
3.7 SELECTED INPUT CLOCK MONITORING	25
3.7.1 DPLL Locking Detection	25
3.7.1.1 Fast Loss	25
3.7.1.2 Coarse Phase Loss	25
3.7.1.3 Fine Phase Loss	25
3.7.1.4 Hard Limit Exceeding	25
3.7.2 Locking Status	25
3.7.3 Phase Lock Alarm	25
3.8 SELECTED INPUT CLOCK SWITCH	27
3.8.1 Input Clock Validity	27
3.8.2 Selected Input Clock Switch	27
3.8.2.1 Revertive Switch	27
3.8.2.2 Non-Revertive Switch	27
3.8.3 Selected / Qualified Input Clocks Indication	27
3.9 SELECTED INPUT CLOCK STATUS VS. DPLL OPERATING MODE	29
3.10 DPLL OPERATING MODE	31
3.10.1 Six Operating Modes	31
3.10.1.1 Free-Run Mode	31
3.10.1.2 Pre-Locked Mode	31
3.10.1.3 Locked Mode	31
3.10.1.3.1 Temp-Holdover Mode	31
3.10.1.4 Lost-Phase Mode	31
3.10.1.5 Holdover Mode	31

3.10.1.5.1	Automatic Instantaneous	32
3.10.1.5.2	Automatic Slow Averaged	32
3.10.1.5.3	Automatic Fast Averaged	32
3.10.1.5.4	Manual	32
3.10.1.5.5	Holdover Frequency Offset Read	32
3.10.1.6	Pre-Locked2 Mode	32
3.11	DPLL OUTPUT	34
3.11.1	PFD Output Limit	34
3.11.2	Frequency Offset Limit	34
3.11.3	PBO	34
3.11.4	Four Paths of T0 DPLL Outputs	34
3.12	T0 / T4 APLL	36
3.13	OUTPUT CLOCKS & FRAME SYNC SIGNALS	36
3.13.1	Output Clocks	36
3.13.2	Frame SYNC Output Signal	38
3.14	INTERRUPT SUMMARY	40
3.15	T0 SUMMARY	40
3.16	LINE CARD APPLICATION	41
4	I2C PROGRAMMING INTERFACE	42
4.1	FUNCTION DESCRIPTION	42
4.1.1	Data Transfer Format	43
4.1.1.1	Slave-receiver Mode (Write)	43
4.1.1.2	Slave-transmitter Mode (Read)	43
4.1.2	Address Assignment	44
4.2	TIMING DEFINITION	44
5	JTAG	46
6	PROGRAMMING INFORMATION	47
6.1	REGISTER MAP	47
6.2	REGISTER DESCRIPTION	51
6.2.1	Global Control Registers	51
6.2.2	Interrupt Registers	58
6.2.3	Input Clock Frequency & Priority Configuration Registers	62
6.2.4	Input Clock Quality Monitoring Configuration & Status Registers	67
6.2.5	T0 DPLL Input Clock Selection Registers	75
6.2.6	T0 DPLL State Machine Control Registers	77
6.2.7	T0 DPLL & T0/T4 APLL Configuration Registers	79
6.2.8	Output Configuration Registers	90
6.2.9	PBO & Phase Offset Control Registers	93
6.2.10	Synchronization Configuration Registers	94
7	THERMAL MANAGEMENT	95
7.1	JUNCTION TEMPERATURE	95
7.2	EXAMPLE OF JUNCTION TEMPERATURE CALCULATION	95
7.3	HEATSINK EVALUATION	95
7.4	VFQFPN EPAD THERMAL RELEASE PATH	96
8	ELECTRICAL SPECIFICATIONS	97
8.1	ABSOLUTE MAXIMUM RATING	97
8.2	RECOMMENDED OPERATION CONDITIONS	97
8.3	I/O SPECIFICATIONS	98
8.3.1	CMOS Input / Output Port	98
8.3.2	PECL / LVDS Output Port	100
8.3.2.1	PECL Output Port	100
8.3.2.2	LVDS Output Port	101
8.4	JITTER & WANDER PERFORMANCE	102

8.5	OUTPUT WANDER GENERATION	105
8.6	INPUT / OUTPUT CLOCK TIMING	106
8.7	OUTPUT CLOCK TIMING	107
PACKAGE DIMENSIONS.....		112
ORDERING INFORMATION.....		117
DATASHEET DOCUMENT HISTORY.....		117



List of Tables

Table 1: Pin Description	14
Table 2: Related Bit / Register in Chapter 3.2	18
Table 3: Related Bit / Register in Chapter 3.3	19
Table 4: Related Bit / Register in Chapter 3.4	20
Table 5: Related Bit / Register in Chapter 3.5	22
Table 6: Input Clock Selection	23
Table 7: External Fast Selection	23
Table 8: 'n' Assigned to the Input Clock	24
Table 9: Related Bit / Register in Chapter 3.6	24
Table 10: Coarse Phase Limit Programming (the selected input clock of 2 kHz, 4 kHz or 8 kHz)	25
Table 11: Coarse Phase Limit Programming (the selected input clock of other than 2 kHz, 4 kHz and 8 kHz)	25
Table 12: Related Bit / Register in Chapter 3.7	26
Table 13: Related Bit / Register in Chapter 3.8	28
Table 14: T0 DPLL Operating Mode Control	29
Table 15: Related Bit / Register in Chapter 3.9	30
Table 16: Frequency Offset Control in Temp-Holdover Mode	31
Table 17: Frequency Offset Control in Holdover Mode	32
Table 18: Holdover Frequency Offset Read	32
Table 19: Related Bit / Register in Chapter 3.10	33
Table 20: Related Bit / Register in Chapter 3.11	35
Table 21: Related Bit / Register in Chapter 3.12	36
Table 22: Outputs on OUT1 & OUT2 if Derived from T0 DPLL Outputs	36
Table 23: Outputs on OUT1 & OUT2 if Derived from T0/T4 APLL	37
Table 24: Frame Sync Input Signal Selection	38
Table 25: Synchronization Control	38
Table 26: Related Bit / Register in Chapter 3.13	39
Table 27: Related Bit / Register in Chapter 3.14	40
Table 28: Definition of S/Sr and P Conditions	42
Table 29: Timing Definition for Standard Mode and Fast Mode(1)	45
Table 30: JTAG Timing Characteristics	46
Table 31: Register List and Map	47
Table 32: Power Consumption and Maximum Junction Temperature	95
Table 33: Thermal Data	95
Table 34: Absolute Maximum Rating	97
Table 35: Recommended Operation Conditions	97
Table 36: CMOS Input Port Electrical Characteristics	98
Table 37: CMOS Input Port with Internal Pull-Up Resistor Electrical Characteristics	98
Table 38: CMOS Input Port with Internal Pull-Down Resistor Electrical Characteristics	98
Table 39: CMOS Output Port Electrical Characteristics	99
Table 40: PECL Output Port Electrical Characteristics	100
Table 41: LVDS Output Port Electrical Characteristics	101
Table 42: Output Clock Jitter Generation	102
Table 43: Output Clock Phase Noise	103
Table 44: Input Jitter Tolerance (155.52 MHz)	103
Table 45: Input Jitter Tolerance (1.544 MHz)	103
Table 46: Input Jitter Tolerance (2.048 MHz)	103
Table 47: Input Jitter Tolerance (8 kHz)	104

Table 48: T0 DPLL Jitter Transfer & Damping Factor	104
Table 49: Input/Output Clock Timing	106
Table 50: Output Clock Timing	107



List of Figures

Figure 1. Functional Block Diagram	11
Figure 2. Pin Assignment (NL68 Top View)	12
Figure 3. Pin Assignment (TQFP 64 Top View)	13
Figure 4. Pre-Divider for An Input Clock	20
Figure 5. Input Clock Activity Monitoring	21
Figure 6. External Fast Selection	23
Figure 7. T0 Selected Input Clock vs. DPLL Automatic Operating Mode	29
Figure 8. On Target Frame Sync Input Signal Timing	38
Figure 9. 0.5 UI Early Frame Sync Input Signal Timing	38
Figure 10. 0.5 UI Late Frame Sync Input Signal Timing	39
Figure 11. 1 UI Late Frame Sync Input Signal Timing	39
Figure 12. Line Card Application	41
Figure 13. Data Transfer on the I2C-bus	42
Figure 14. Slave-receiver Mode	43
Figure 15. Slave-transmitter Mode	43
Figure 16. Address Assignment	44
Figure 17. Timing Definition of I2C-bus	44
Figure 18. JTAG Interface Timing Diagram	46
Figure 19. Assembly for Expose Pad thermal Release Path (Side View)	96
Figure 20. Recommended PECL Output Port Line Termination	100
Figure 21. Recommended LVDS Output Port Line Termination	101
Figure 22. Output Wander Generation	105
Figure 23. Input / Output Clock Timing	106
Figure 24. 68-Pin NL Package Dimensions (a) (in Millimeters)	112
Figure 25. 68-Pin NL Package Dimensions (b) (in Millimeters)	113
Figure 26. 64-Pin EDG Package Dimensions (a) (in Millimeters)	114
Figure 27. 64-Pin EDG Package Dimensions (b) (in Millimeters)	115
Figure 28. EDG64 Recommended Land Pattern with Exposed Pad (in Millimeters)	116



FEATURES

HIGHLIGHTS

- The first single PLL chip:
 - Features 0.1 Hz to 560 Hz bandwidth
 - Exceeds GR-253-CORE (OC-12) and ITU-T G.813 (STM-16/Option I) jitter generation requirements
 - Provides node clocks for Cellular and WLL base-station (GSM and 3G networks)
 - Provides clocks for DSL access concentrators (DSLAM), especially for Japan TCM-ISDN network timing based ADSL equipments

MAIN FEATURES

- Provides an integrated single-chip solution for Synchronous Equipment Timing Source, including Stratum 3, SMC, 4E and 4 clocks
- Employs DPLL and APLL to feature excellent jitter performance and minimize the number of the external components
- Supports Forced or Automatic operating mode switch controlled by an internal state machine; the primary operating modes are Free-Run, Locked and Holdover
- Supports programmable DPLL bandwidth (0.1 Hz to 560 Hz in 11 steps) and damping factor (1.2 to 20 in 5 steps)
- Supports 1.1×10^{-5} ppm absolute holdover accuracy and 4.4×10^{-8} ppm instantaneous holdover accuracy
- Supports PBO to minimize phase transients on T0 DPLL output to be no more than 0.61 ns
- Supports phase absorption when phase-time changes on T0 selected input clock are greater than a programmable limit over an interval of less than 0.1 seconds
- Limits the phase and frequency offset of the outputs
- Supports manual and automatic selected input clock switch
- Supports automatic hitless selected input clock switch on clock failure
- Supports three types of input clock sources: recovered clock from STM-N or OC-n, PDH network synchronization timing and external synchronization reference timing
- Provides two 2 kHz, 4 kHz or 8 kHz frame sync input signals, and an 8 kHz frame sync output signal
- Provides two input clocks whose frequency cover from 2 kHz to 155.52 MHz
- Provides two output clocks whose frequency cover from 1 Hz to 622.08 MHz
- Provides output clocks for BITS, GPS, 3G, GSM, etc.
- Supports CMOS input/output and PECL/LVDS output technologies
- Supports master clock calibration
- Supports Line Card application
- Meets Telcordia GR-1244-CORE, GR-253-CORE, ITU-T G.812, ITU-T G.813 and ITU-T G.783 criteria

OTHER FEATURES

- I²C programming interface
- IEEE 1149.1 JTAG Boundary Scan
- Single 3.3 V operation with 5 V tolerant CMOS I/Os
- 68-pin VFQFPN package and 64-pin TQFP package, Green package options available

APPLICATIONS

- BITS / SSU
- SMC / SEC (SONET / SDH)
- DWDM cross-connect and transmission equipments
- Central Office Timing Source and Distribution
- Core and access IP switches / routers
- Gigabit and Terabit IP switches / routers
- IP and ATM core switches and access equipments
- Cellular and WLL base-station node clocks
- Broadband and multi-service access equipments
- Any other telecom equipments that need synchronous equipment system timing

DESCRIPTION

The IDT82V3202 is an integrated, single-chip solution for the Synchronous Equipment Timing Source for Stratum 3, SMC, 4E and 4 clocks in SONET / SDH equipments, DWDM and Wireless base station, such as GSM, 3G, DSL concentrator, Router and Access Network applications.

The device supports three types of input clock sources: recovered clock from STM-N or OC-n, PDH network synchronization timing and external synchronization reference timing.

An input clock is automatically or manually selected for DPLL locking. The DPLL supports three primary operating modes: Free-Run, Locked and Holdover. In Free-Run mode, the DPLL refers to the master clock. In Locked mode, the DPLL locks to the selected input clock. In Holdover mode, the DPLL resorts to the frequency data acquired in Locked mode. Whatever the operating mode is, the DPLL gives a stable

performance without being affected by operating conditions or silicon process variations.

If the DPLL outputs are processed by T0/T4 APLL, the outputs of the device will be in a better jitter/wander performance.

The device provides programmable DPLL bandwidths: 0.1 Hz to 560 Hz in 11 steps and damping factors: 1.2 to 20 in 5 steps. Different settings cover all SONET / SDH clock synchronization requirements.

A high stable input is required for the master clock in different applications. The master clock is used as a reference clock for all the internal circuits in the device. It can be calibrated within ± 741 ppm.

All the read/write registers are accessed only through an I²C programming interface.

The device can be used typically in Line Card application.

FUNCTIONAL BLOCK DIAGRAM

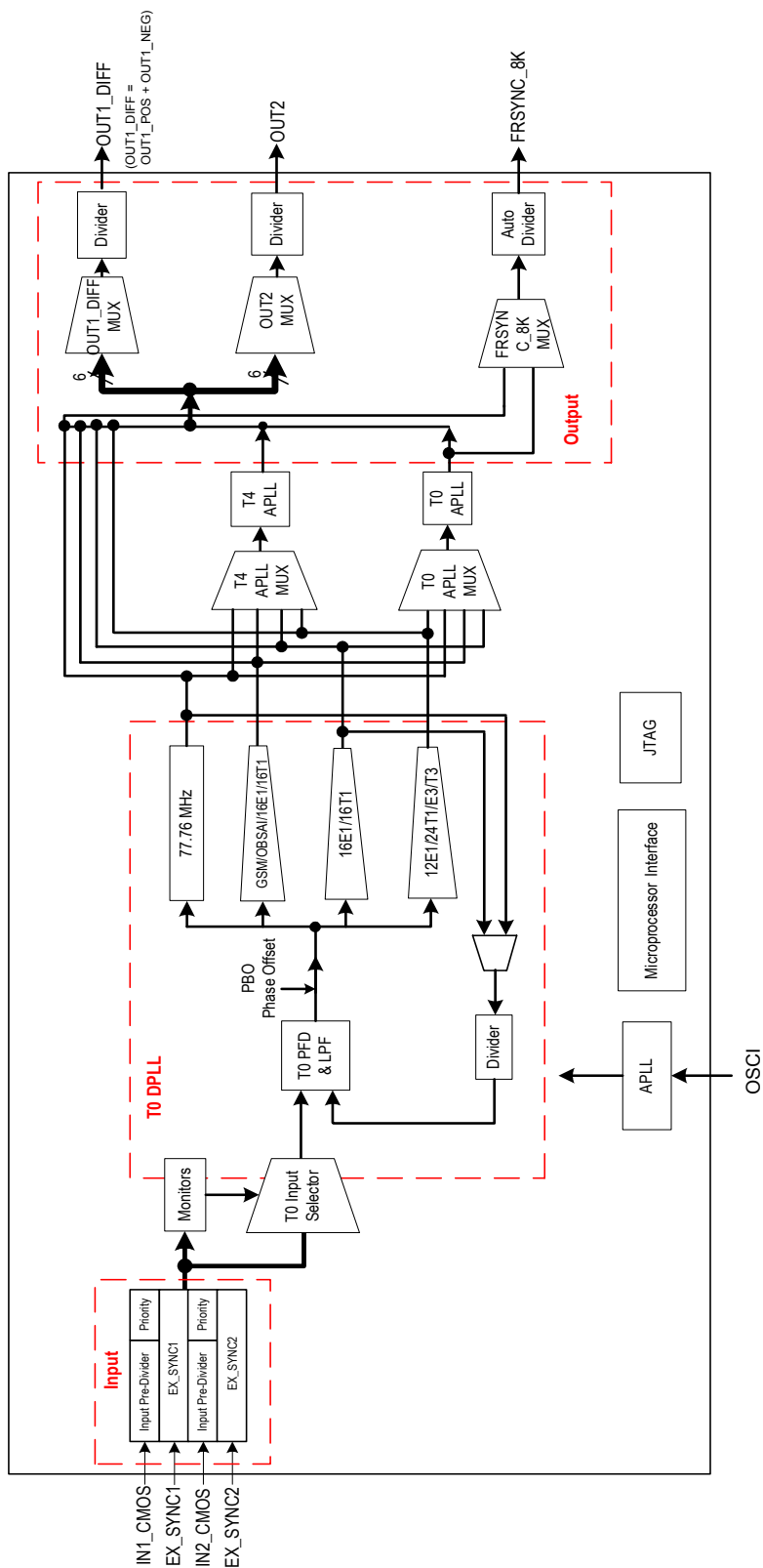


Figure 1. Functional Block Diagram

1 PIN ASSIGNMENT

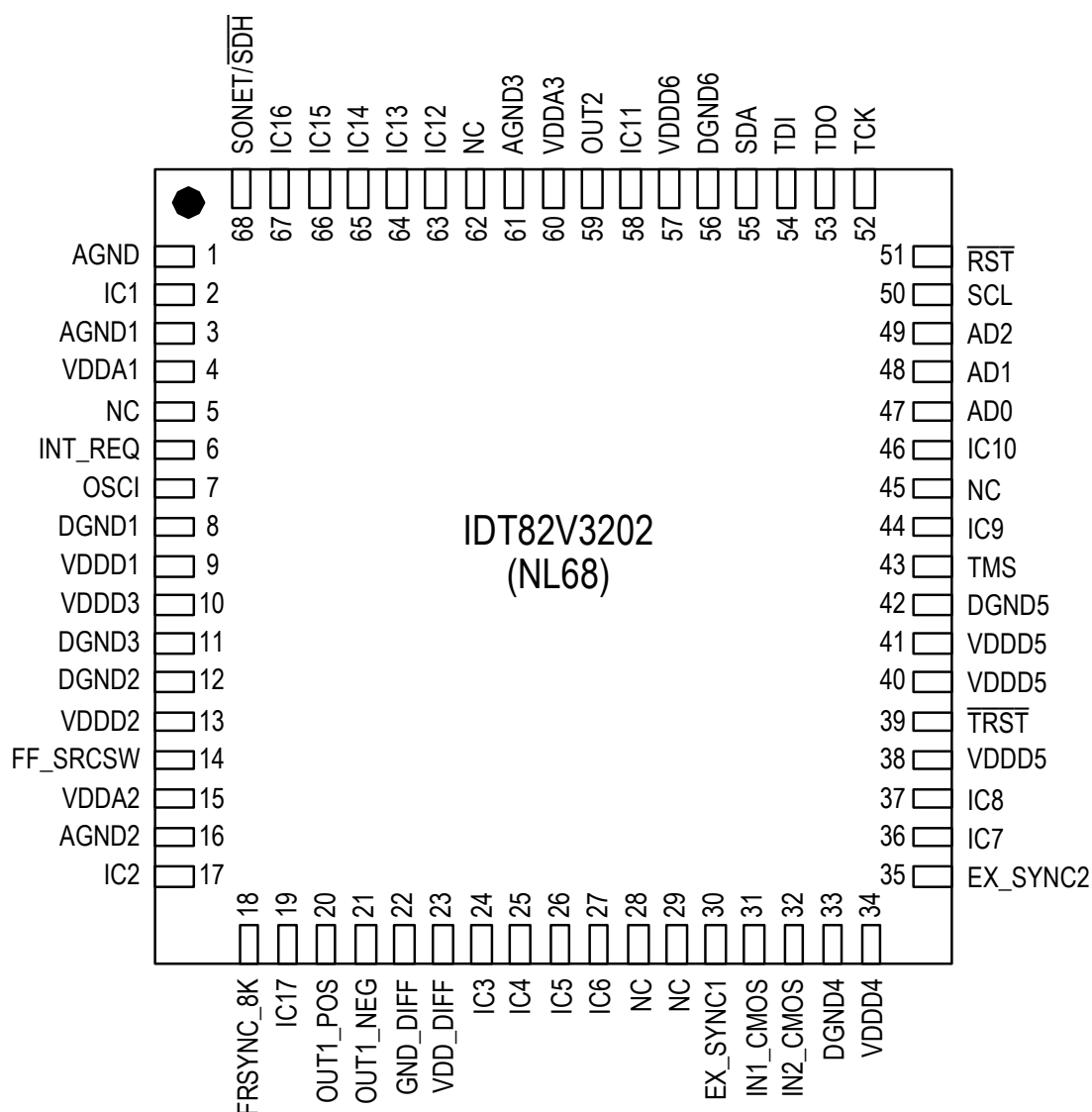


Figure 2. Pin Assignment (NL68 Top View)

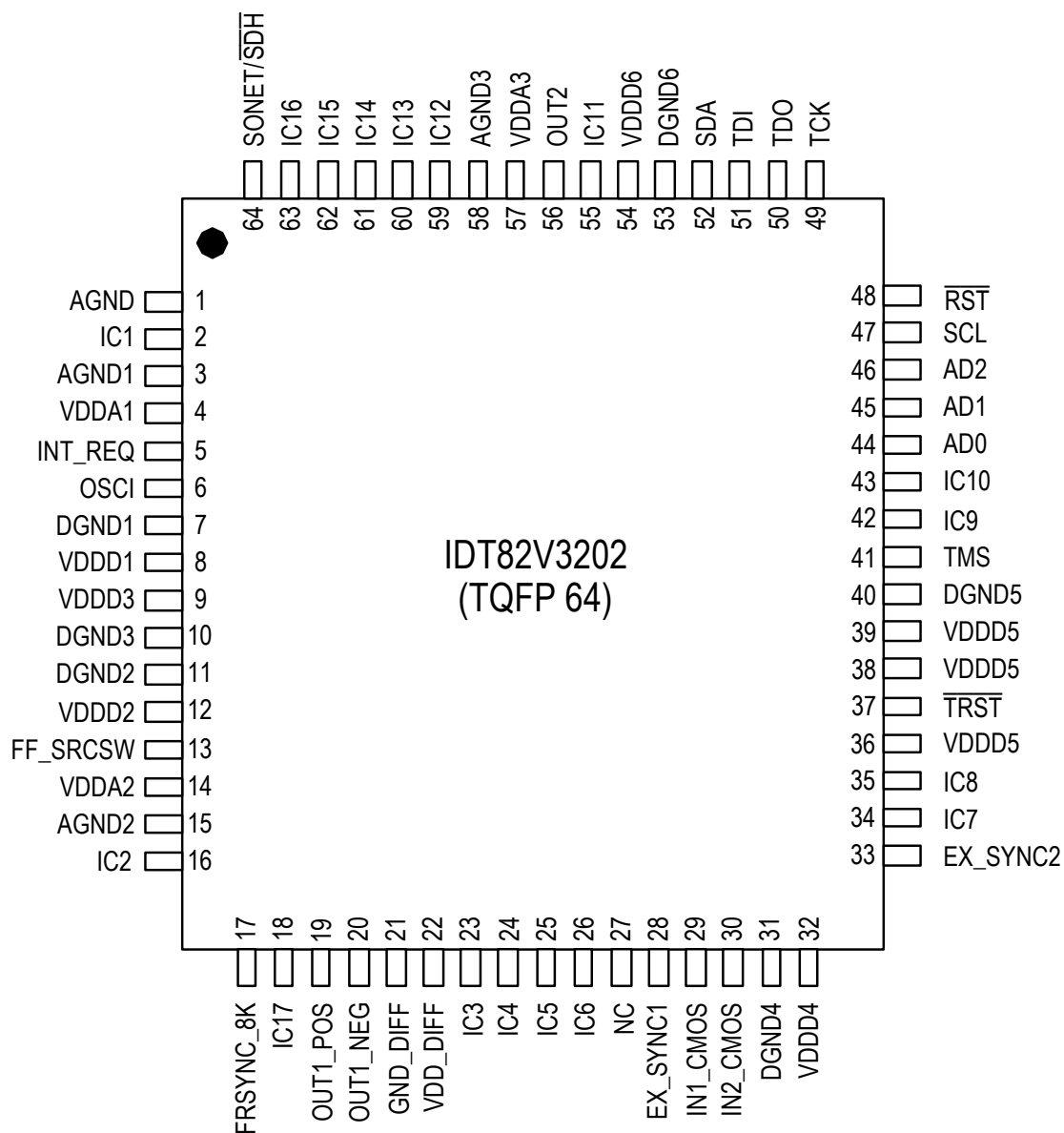


Figure 3. Pin Assignment (TQFP 64 Top View)

2 PIN DESCRIPTION

Table 1: Pin Description

Name	Pin No. (NL68)	Pin No. (TQFP 64)	I/O	Type	Description ¹
Global Control Signal					
OSCI	7	6	I	CMOS	OSCI: Crystal Oscillator Master Clock A nominal 12.8000 MHz clock provided by a crystal oscillator is input on this pin. It is the master clock for the device.
FF_SRC SW	14	13	I pull-down	CMOS	FF_SRC SW: External Fast Selection Enable During reset, this pin determines the default value of the EXT_SW bit (b4, 0BH) ² . The EXT_SW bit determines whether the External Fast Selection is enabled. High: The default value of the EXT_SW bit (b4, 0BH) is '1' (External Fast selection is enabled); Low: The default value of the EXT_SW bit (b4, 0BH) is '0' (External Fast selection is disabled). After reset, this pin selects an input clock for the T0 DPLL if the External Fast selection is enabled: High: IN1_CMOS is selected. Low: IN2_CMOS is selected. After reset, the input on this pin takes no effect if the External Fast selection is disabled.
SONET/SDH	68	64	I pull-down	CMOS	SONET/SDH: SONET / SDH Frequency Selection During reset, this pin determines the default value of the IN_SONET_SDH bit (b2, 09H): High: The default value of the IN_SONET_SDH bit is '1' (SONET); Low: The default value of the IN_SONET_SDH bit is '0' (SDH). After reset, the value on this pin takes no effect.
RST	51	48	I pull-up	CMOS	RST: Reset A low pulse of at least 50 μ s on this pin resets the device. After this pin is high, the device will still be held in reset state for 500 ms (typical).
Frame Synchronization Input Signal					
EX_SYNC1	30	28	I pull-down	CMOS	EX_SYNC1: External Sync Input 1 A 2 kHz, 4 kHz or 8 kHz signal is input on this pin.
EX_SYNC2	35	33	I pull-down	CMOS	EX_SYNC2: External Sync Input 2 A 2 kHz, 4 kHz or 8 kHz signal is input on this pin.
Input Clock					
IN1_CMOS	31	29	I pull-down	CMOS	IN1_CMOS: Input Clock 1 A 2 kHz, 4 kHz, N x 8 kHz ³ , 1.544 MHz (SONET) / 2.048 MHz (SDH), 6.48 MHz, 19.44 MHz, 25.92 MHz, 38.88 MHz, 51.84 MHz, 77.76 MHz or 155.52 MHz clock is input on this pin.
IN2_CMOS	32	30	I pull-down	CMOS	IN2_CMOS: Input Clock 2 A 2 kHz, 4 kHz, N x 8 kHz ³ , 1.544 MHz (SONET) / 2.048 MHz (SDH), 6.48 MHz, 19.44 MHz, 25.92 MHz, 38.88 MHz, 51.84 MHz, 77.76 MHz or 155.52 MHz clock is input on this pin.
Output Frame Synchronization Signal					
FRSYNC_8K	18	17	O	CMOS	FRSYNC_8K: 8 kHz Frame Sync Output An 8 kHz signal is output on this pin.
Output Clock					
OUT1_POS OUT1_NEG	20 21	19 20	O	PECL/LVDS	OUT1_POS / OUT1_NEG: Positive / Negative Output Clock 1 A 1 Hz, 400 Hz, 2 kHz, 8 kHz, 64 kHz, N x E1 ⁴ , N x T1 ⁵ , N x 13.0 MHz ⁶ , N x 3.84 MHz ⁷ , E3, T3, 6.48 MHz, 19.44 MHz, 25.92 MHz, 38.88 MHz, 51.84 MHz, 77.76 MHz, 155.52 MHz, 311.04 MHz or 622.08 MHz clock is differentially output on this pair of pins.

Table 1: Pin Description (Continued)

Name	Pin No. (NL68)	Pin No. (TQFP 64)	I/O	Type	Description ¹
OUT2	59	56	O	CMOS	OUT2: Output Clock 2 A 1 Hz, 400 Hz, 2 kHz, 8 kHz, 64 kHz, N x E1 ⁴ , N x T1 ⁵ , N x 13.0 MHz ⁶ , N x 3.84 MHz ⁷ , E3, T3, 6.48 MHz, 19.44 MHz, 25.92 MHz, 38.88 MHz, 51.84 MHz, 77.76 MHz or 155.52 MHz clock is output on this pin.
I²C Programming Interface					
INT_REQ	6	5	O	CMOS	INT_REQ: Interrupt Request This pin is used as an interrupt request. The output characteristics are determined by the HZ_EN bit (b1, 0CH) and the INT_POL bit (b0, 0CH).
AD0	47	44	I	CMOS	AD[2:0]: Address Input 2 to 0 The address is input on these pins.
AD1	48	45			
AD2	49	46			
SCL	50	47	I	CMOS	SCL: Serial Clock Line The serial clock is input on this pin. The clock is 400 kbit/s in Fast-mode and 3.4 Mbit/s in High-speed mode.
SDA	55	52	I/O	CMOS	SDA: Serial Data Input/Output This pin is used as the input/output for the serial data.
JTAG (per IEEE 1149.1)					
$\overline{\text{TRST}}$	39	37	I pull-down	CMOS	$\overline{\text{TRST}}$: JTAG Test Reset (Active Low) A low signal on this pin resets the JTAG test port. This pin should be connected to ground when JTAG is not used.
TMS	43	41	I pull-up	CMOS	TMS: JTAG Test Mode Select The signal on this pin controls the JTAG test performance and is sampled on the rising edge of TCK.
TCK	52	49	I pull-down	CMOS	TCK: JTAG Test Clock The clock for the JTAG test is input on this pin. TDI and TMS are sampled on the rising edge of TCK and TDO is updated on the falling edge of TCK. If TCK is idle at a low level, all stored-state devices contained in the test logic will indefinitely retain their state.
TDI	54	51	I pull-up	CMOS	TDI: JTAG Test Data Input The test data is input on this pin. It is clocked into the device on the rising edge of TCK.
TDO	53	50	O	CMOS	TDO: JTAG Test Data Output The test data is output on this pin. It is clocked out of the device on the falling edge of TCK. TDO pin outputs a high impedance signal except during the process of data scanning. This pin can indicate the interrupt of T0 selected input clock fail, as determined by the LOS_FLAG_ON_TDO bit (b6, 0BH). Refer to Chapter 3.8.1 Input Clock Validity for details.
Power & Ground					
VDDD1	9	8	Power	-	VDDDn: 3.3 V Digital Power Supply Each VDDDn should be paralleled with ground through a 0.1 μ F capacitor.
VDDD2	13	12			
VDDD3	10	9			
VDDD4	34	32			
VDDD5	38, 40, 41	36, 38, 39			
VDDD6	57	54			

Table 1: Pin Description (Continued)

Name	Pin No. (NL68)	Pin No. (TQFP 64)	I/O	Type	Description ¹
VDDA1	4	4	Power	-	VDDAn: 3.3 V Analog Power Supply Each VDDAn should be paralleled with ground through a 0.1 μ F capacitor.
VDDA2	15	14			
VDDA3	60	57			
VDD_DIFF	23	22	Power	-	VDD_DIFF: 3.3 V Power Supply for OUT1
DGND1	8	7	Ground	-	DGNDn: Digital Ground
DGND2	12	11			
DGND3	11	10			
DGND4	33	31			
DGND5	42	40			
DGND6	56	53			
AGND1	3	3	Ground	-	AGNDn: Analog Ground
AGND2	16	15			
AGND3	61	58			
GND_DIFF	22	21	Ground	-	GND_DIFF: Ground for OUT1
AGND	1	1	Ground	-	AGND: Analog Ground

Table 1: Pin Description (Continued)

Name	Pin No. (NL68)	Pin No. (TQFP 64)	I/O	Type	Description ¹
Others					
IC1	2	2			IC: Internal Connected Internal Use. These pins should be left open for normal operation.
IC2	17	16			
IC3	24	23			
IC4	25	24			
IC5	26	25			
IC6	27	26			
IC7	36	34			
IC8	37	35			
IC9	44	42	-	-	
IC10	46	43			
IC11	58	55			
IC12	63	59			
IC13	64	60			
IC14	65	61			
IC15	66	62			
IC16	67	63			
IC17	19	18			
NC	5, 28, 29, 45, 62	27	-	-	NC: Not Connected
Note: 1. All the unused input pins should be connected to ground; the output of all the unused output pins are don't-care. 2. The contents in the brackets indicate the position of the register bit/bits. 3. N x 8 kHz: $1 \leq N \leq 19440$. 4. N x E1: N = 1, 2, 3, 4, 6, 8, 12, 16, 24, 32, 48, 64. 5. N x T1: N = 1, 2, 3, 4, 6, 8, 12, 16, 24, 32, 48, 64, 96. 6. N x 13.0 MHz: N = 1, 2, 4. 7. N x 3.84 MHz: N = 1, 2, 4, 8, 16, 10, 20, 40.					

3 FUNCTIONAL DESCRIPTION

3.1 RESET

The reset operation resets all registers and state machines to their default value or status.

After power on, the device must be reset for normal operation.

For a complete reset, the $\overline{\text{RST}}$ pin must be asserted low for at least 50 μs . After the $\overline{\text{RST}}$ pin is pulled high, the device will still be in reset state for 500 ms (typical). If the $\overline{\text{RST}}$ pin is held low continuously, the device remains in reset state.

3.2 MASTER CLOCK

A nominal 12.8000 MHz clock, provided by a crystal oscillator, is input on the OSCI pin. This clock is provided for the device as a master clock. The master clock is used as a reference clock for all the internal circuits. A better active edge of the master clock is selected by the OSC_EDGE bit to improve jitter and wander performance.

In fact, an offset from the nominal frequency may input on the OSCI pin. This offset can be compensated by setting the NOMINAL_FREQ_VALUE[23:0] bits. The calibration range is within ± 741 ppm.

The performance of the master clock should meet GR-1244-CORE, GR-253-CORE, ITU-T G.812 and G.813 criteria.

Table 2: Related Bit / Register in Chapter 3.2

Bit	Register	Address (Hex)
NOMINAL_FREQ_VALUE[23:0]	NOMINAL_FREQ[23:16]_CNFG, NOMINAL_FREQ[15:8]_CNFG, NOMINAL_FREQ[7:0]_CNFG	06, 05, 04
OSC_EDGE	DIFFERENTIAL_IN_OUT_OSCI_CNFG	0A

3.3 INPUT CLOCKS & FRAME SYNC SIGNALS

Altogether two clocks and two frame sync signals are input to the device.

3.3.1 INPUT CLOCKS

The device provides two CMOS input clock ports: IN1_CMOS and IN2_CMOS.

According to the input clock source, the following clock sources are supported:

- T1: Recovered clock from STM-N or OC-n
- T2: PDH network synchronization timing
- T3: External synchronization reference timing

The clock sources can be from T1, T2 or T3.

For SDH and SONET networks, the default frequency is different. SONET / SDH frequency selection is controlled by the IN_SONET_SDH bit. During reset, the default value of the IN_SONET_SDH bit is deter-

mined by the SONET/SDH pin: high for SONET and low for SDH. After reset, the input signal on the SONET/SDH pin takes no effect.

3.3.2 FRAME SYNC INPUT SIGNALS

Two 2 kHz, 4 kHz or 8 kHz frame sync signals are input on the EX_SYNC1 and EX_SYNC2 pins respectively. They are CMOS inputs. The input frequency should match the setting in the SYNC_FREQ[1:0] bits. The frame sync signals are only valid for the OC-n clock (6.48 MHz, 19.44 MHz, 38.88 MHz and 77.76 MHz) input.

Only one of the two frame sync input signals is used for frame sync output signal synchronization. Refer to [Chapter 3.13.2 Frame SYNC Output Signal](#) for details.

Table 3: Related Bit / Register in Chapter 3.3

Bit	Register	Address (Hex)
IN_SONET_SDH	INPUT_MODE_CNFG	09
SYNC_FREQ[1:0]		

3.4 INPUT CLOCK PRE-DIVIDER

Each input clock is assigned an internal Pre-Divider. The Pre-Divider is used to divide the clock frequency down to the DPLL required frequency, which is no more than 38.88 MHz. For each input clock, the DPLL required frequency is set by the corresponding IN_FREQ[3:0] bits.

If the input clock is of 2 kHz, 4 kHz or 8 kHz, the Pre-Divider is bypassed automatically and the corresponding IN_FREQ[3:0] bits should be set to match the input frequency; the input clock can be inverted, as determined by the IN_2K_4K_8K_INV bit.

Each Pre-Divider consists of a DivN Divider and a Lock 8k Divider, as shown in Figure 4.

Either the DivN Divider or the Lock 8k Divider can be used or both can be bypassed, as determined by the DIRECT_DIV bit and the LOCK_8K bit.

When the DivN Divider is used, the division factor setting should observe the following order:

1. Select an input clock by the PRE_DIV_CH_VALUE[3:0] bits;
2. Write the lower eight bits of the division factor to the PRE_DIVN_VALUE[7:0] bits;
3. Write the higher eight bits of the division factor to the PRE_DIVN_VALUE[14:8] bits.

Once the division factor is set for the input clock selected by the PRE_DIV_CH_VALUE[3:0] bits, it is valid until a different division factor is set for the same input clock. The division factor is calculated as follows:

$$\text{Division Factor} = (\text{the frequency of the clock input to the DivN Divider} \div \text{the frequency of the DPLL required clock set by the IN_FREQ[3:0] bits}) - 1$$

The DivN Divider can only divide the input clock whose frequency is lower than (<) 155.52 MHz.

When the Lock 8k Divider is used, the input clock is divided down to 8 kHz automatically.

The Pre-Divider configuration and the division factor setting depend on the input clock on one of the clock input pin and the DPLL required clock. Here is an example:

The input clock on the IN2_CMOS pin is 155.52 MHz; the DPLL required clock is 6.48 MHz by programming the IN_FREQ[3:0] bits of register IN2_CMOS_CNFG to '0010'. Do the following to divide the input clock:

Use the DivN Divider to divide the clock down to 6.48 MHz:

Set the PRE_DIV_CH_VALUE[3:0] bits to '0011';

Set the DIRECT_DIV bit in Register IN2_CMOS_CNFG to '1' and the LOCK_8K bit in Register IN2_CMOS_CNFG to '0';
 $155.52 \div 6.48 = 24$; $24 - 1 = 23$, so set the PRE_DIVN_VALUE[14:0] bits to '10111'.

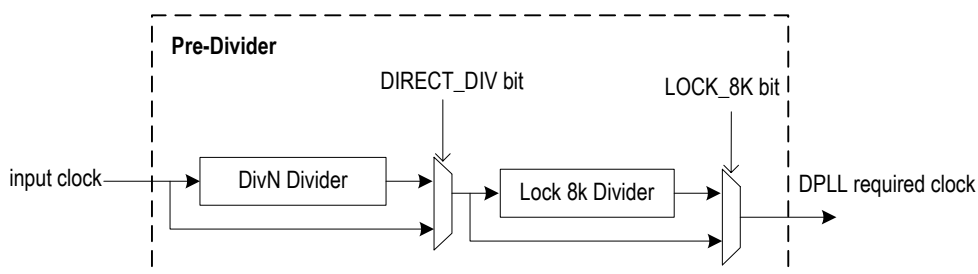


Figure 4. Pre-Divider for An Input Clock

Table 4: Related Bit / Register in Chapter 3.4

Bit	Register	Address (Hex)
IN_FREQ[3:0]	IN1_CMOS_CNFG, IN2_CMOS_CNFG	16, 17
DIRECT_DIV		
LOCK_8K		
IN_2K_4K_8K_INV	FR_SYNC_CNFG	74
PRE_DIV_CH_VALUE[3:0]	PRE_DIV_CH_CNFG	23
PRE_DIVN_VALUE[14:0]	PRE_DIVN[14:8]_CNFG, PRE_DIVN[7:0]_CNFG	25, 24

3.5 INPUT CLOCK QUALITY MONITORING

The qualities of the input clocks are always monitored in the following aspects:

- Activity
- Frequency

The qualified clocks are available for T0 DPLL selection. The T0 selected input clock has to be monitored further. Refer to [Chapter 3.7 Selected Input Clock Monitoring](#) for details.

3.5.1 ACTIVITY MONITORING

Activity is monitored by using an internal leaky bucket accumulator, as shown in [Figure 5](#).

Each input clock is assigned an internal leaky bucket accumulator. The input clock is monitored for each period of 128 ms and the internal leaky bucket accumulator increases by 1 when an event is detected; it decreases by 1 if no event is detected within the period set by the decay rate. The event is that an input clock drifts outside ($>$) ± 500 ppm with respect to the master clock within a 128 ms period.

There are four configurations (0 - 3) for a leaky bucket accumulator. The leaky bucket configuration for an input clock is selected by the cor-

responding BUCKET_SEL[1:0] bits. Each leaky bucket configuration consists of four elements: upper threshold, lower threshold, bucket size and decay rate.

The bucket size is the capability of the accumulator. If the number of the accumulated events reach the bucket size, the accumulator will stop increasing even if further events are detected. The upper threshold is a point above which a no-activity alarm is raised. The lower threshold is a point below which the no-activity alarm is cleared. The decay rate is a certain period during which the accumulator decreases by 1 if no event is detected.

The leaky bucket configuration is programmed by one of four groups of register bits: the BUCKET_SIZE_n_DATA[7:0] bits, the UPPER_THRESHOLD_n_DATA[7:0] bits, the LOWER_THRESHOLD_n_DATA[7:0] bits and the DECAY_RATE_n_DATA[1:0] bits respectively; 'n' is 0 ~ 3.

The no-activity alarm status of the input clock is indicated by the INn_CMOS_NO_ACTIVITY_ALARM bit (n = 1 or 2).

The input clock with a no-activity alarm is disqualified for clock selection for T0 DPLL.

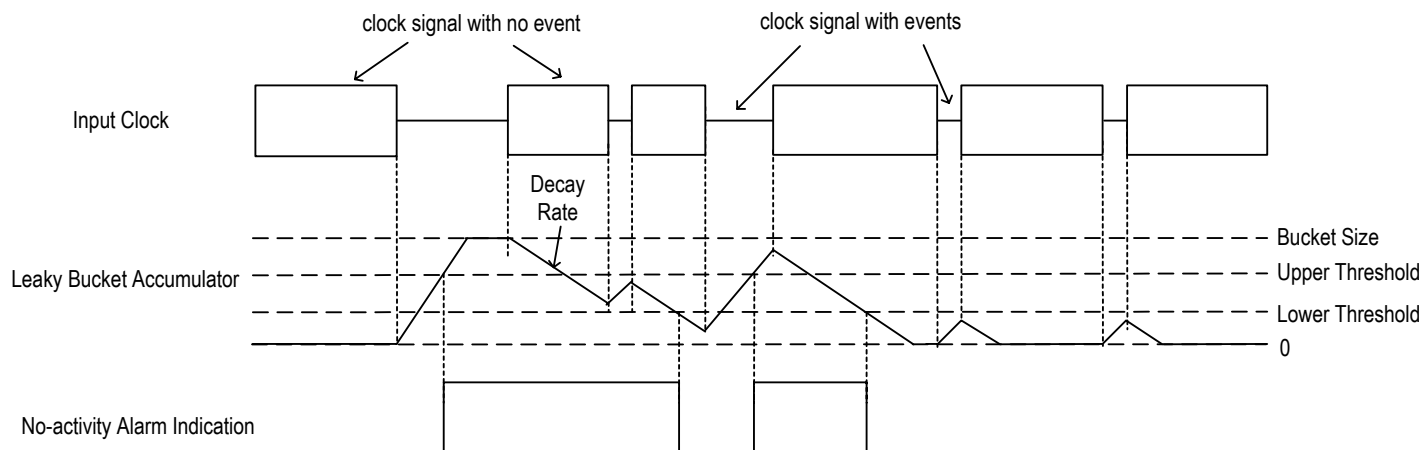


Figure 5. Input Clock Activity Monitoring

3.5.2 FREQUENCY MONITORING

Frequency is monitored by comparing the input clock with a reference clock. The reference clock can be derived from the master clock or the output of T0 DPLL, as determined by the `FREQ_MON_CLK` bit.

A frequency hard alarm threshold is set for frequency monitoring. If the `FREQ_MON_HARD_EN` bit is '1', a frequency hard alarm is raised when the frequency of the input clock with respect to the reference clock is above the threshold; the alarm is cleared when the frequency is below the threshold.

The frequency hard alarm threshold can be calculated as follows:

$$\text{Frequency Hard Alarm Threshold (ppm)} = (\text{ALL_FREQ_HARD_THRESHOLD}[3:0] + 1) \times \text{FREQ_MON_FACTOR}[3:0]$$

If the `FREQ_MON_HARD_EN` bit is '1', the frequency hard alarm status of the input clock is indicated by the `INn_CMOS_FREQ_HARD_ALARM` bit ($n = 1$ or 2). When the `FREQ_MON_HARD_EN` bit is '0', no frequency hard alarm is raised even if the input clock is above the frequency hard alarm threshold.

The input clock with a frequency hard alarm is disqualified for clock selection for T0 DPLL.

In addition, if the input clock is 2 kHz, 4 kHz or 8 kHz, its clock edges with respect to the reference clock are monitored. If any edge drifts outside $\pm 5\%$, the input clock is disqualified for clock selection for T0 DPLL. The input clock is qualified if any edge drifts inside $\pm 5\%$. This function is supported only when the `IN_NOISE_WINDOW` bit is '1'.

The frequency of each input clock with respect to the reference clock can be read by doing the following step by step:

1. Select an input clock by setting the `IN_FREQ_READ_CH[3:0]` bits;
2. Read the value in the `IN_FREQ_VALUE[7:0]` bits and calculate as follows:

$$\text{Input Clock Frequency (ppm)} = \text{IN_FREQ_VALUE}[7:0] \times \text{FREQ_MON_FACTOR}[3:0]$$

Note that the value set by the `FREQ_MON_FACTOR[3:0]` bits depends on the application.

Table 5: Related Bit / Register in Chapter 3.5

Bit	Register	Address (Hex)
BUCKET_SIZE_n_DATA[7:0] ($3 \geq n \geq 0$)	BUCKET_SIZE_0_CNFG ~ BUCKET_SIZE_3_CNFG	33, 37, 3B, 3F
UPPER_THRESHOLD_n_DATA[7:0] ($3 \geq n \geq 0$)	UPPER_THRESHOLD_0_CNFG ~ UPPER_THRESHOLD_3_CNFG	31, 35, 39, 3D
LOWER_THRESHOLD_n_DATA[7:0] ($3 \geq n \geq 0$)	LOWER_THRESHOLD_0_CNFG ~ LOWER_THRESHOLD_3_CNFG	32, 36, 3A, 3E
DECAY_RATE_n_DATA[1:0] ($3 \geq n \geq 0$)	DECAY_RATE_0_CNFG ~ DECAY_RATE_3_CNFG	34, 38, 3C, 40
BUCKET_SEL[1:0]	IN1_CMOS_CNFG, IN2_CMOS_CNFG	16, 17
INn_CMOS_NO_ACTIVITY_ALARM ($n = 1$ or 2)	IN1_IN2_CMOS_STS	44
INn_CMOS_FREQ_HARD_ALARM ($n = 1$ or 2)		
FREQ_MON_CLK	MON_SW_PBO_CNFG	0B
FREQ_MON_HARD_EN		
ALL_FREQ_HARD_THRESHOLD[3:0]	ALL_FREQ_MON_THRESHOLD_CNFG	2F
FREQ_MON_FACTOR[3:0]	FREQ_MON_FACTOR_CNFG	2E
IN_NOISE_WINDOW	PHASE_MON_PBO_CNFG	78
IN_FREQ_READ_CH[3:0]	IN_FREQ_READ_CH_CNFG	41
IN_FREQ_VALUE[7:0]	IN_FREQ_READ_STS	42

3.6 DPLL INPUT CLOCK SELECTION

The EXT_SW bit and the T0_INPUT_SEL[3:0] bits determine the input clock selection, as shown in [Table 6](#):

Table 6: Input Clock Selection

Control Bits		Input Clock Selection
EXT_SW	T0_INPUT_SEL[3:0]	
1	don't-care	External Fast selection
0	other than 0000	Forced selection
	0000	Automatic selection

External Fast selection is done between IN1_CMOS and IN2_CMOS.

Forced selection is done by setting the related registers.

Automatic selection is done based on the results of input clocks quality monitoring and the related registers configuration.

The selected input clock is attempted to be locked by T0 DPLL.

3.6.1 EXTERNAL FAST SELECTION

In External Fast selection, only IN1_CMOS and IN2_CMOS are available for selection. Refer to [Figure 6](#). The results of input clocks

quality monitoring (refer to [Chapter 3.5 Input Clock Quality Monitoring](#)) do not affect input clock selection.

The T0 input clock selection is determined by the FF_SRC SW pin after reset (this pin determines the default value of the EXT_SW bit during reset, refer to [Chapter 2 Pin Description](#)), the IN1_CMOS_SEL_PRIORITY[3:0] bits and the IN2_CMOS_SEL_PRIORITY[3:0] bits, as shown in [Figure 6](#) and [Table 7](#):

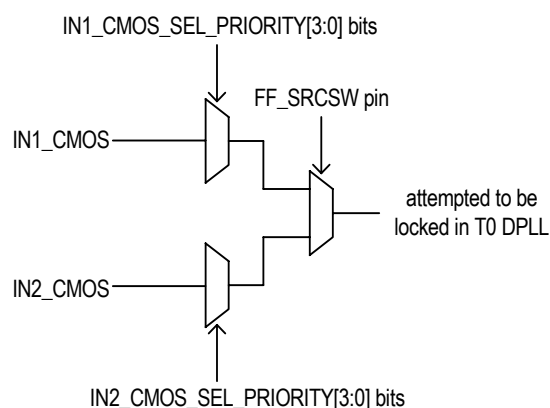


Figure 6. External Fast Selection

Table 7: External Fast Selection

Control Pin & Bits			the Selected Input Clock
FF_SRC SW (after reset)	IN1_CMOS_SEL_PRIORITY[3:0]	IN2_CMOS_SEL_PRIORITY[3:0]	
high	other than 0000	don't-care	IN1_CMOS
low	don't-care	other than 0000	IN2_CMOS

3.6.2 FORCED SELECTION

In Forced selection, the selected input clock is set by the T0_INPUT_SEL[3:0] bits. The results of input clocks quality monitoring (refer to [Chapter 3.5 Input Clock Quality Monitoring](#)) do not affect the input clock selection.

3.6.3 AUTOMATIC SELECTION

In Automatic selection, the input clock selection is determined by its validity and priority. The validity depends on the results of input clock quality monitoring (refer to [Chapter 3.5 Input Clock Quality Monitoring](#)). In the qualified input clocks, the one with the higher priority is selected.

The priority is configured by the corresponding INn_CMOS_SEL_PRIORITY[3:0] bits (n = 1 or 2). If more than one qualified input clock is available and has the same priority, the input clock with the smaller 'n' is selected. See [Table 8](#) for the 'n' assigned to the input clock.

Table 8: 'n' Assigned to the Input Clock

Input Clock	'n' Assigned to the Input Clock
IN1_CMOS	1
IN2_CMOS	3

Table 9: Related Bit / Register in Chapter 3.6

Bit	Register	Address (Hex)
EXT_SW	MON_SW_PBO_CNFG	0B
T0_INPUT_SEL[3:0]	T0_INPUT_SEL_CNFG	50
INn_CMOS_SEL_PRIORITY[3:0] (n = 1 or 2)	IN1_IN2_CMOS_SEL_PRIORITY_CNFG	27

3.7 SELECTED INPUT CLOCK MONITORING

The quality of the selected input clock is always monitored (refer to [Chapter 3.5 Input Clock Quality Monitoring](#)) and the DPLL locking status is always monitored.

3.7.1 DPLL LOCKING DETECTION

The following events is always monitored:

- Fast Loss;
- Coarse Phase Loss;
- Fine Phase Loss;
- Hard Limit Exceeding.

3.7.1.1 Fast Loss

A fast loss is triggered when the selected input clock misses 2 consecutive clock cycles. It is cleared once an active clock edge is detected.

The occurrence of the fast loss will result in T0 DPLL unlocked if the FAST_LOS_SW bit is '1'.

3.7.1.2 Coarse Phase Loss

The T0 DPLL compares the selected input clock with the feedback signal. If the phase-compared result exceeds the coarse phase limit, a coarse phase loss is triggered. It is cleared once the phase-compared result is within the coarse phase limit.

When the selected input clock is of 2 kHz, 4 kHz or 8 kHz, the coarse phase limit depends on the MULTI_PH_8K_4K_2K_EN bit, the WIDE_EN bit and the PH_LOS_COARSE_LIMIT[3:0] bits. Refer to [Table 10](#). When the selected input clock is of other frequencies but 2 kHz, 4 kHz and 8 kHz, the coarse phase limit depends on the WIDE_EN bit and the PH_LOS_COARSE_LIMIT[3:0] bits. Refer to [Table 11](#).

Table 10: Coarse Phase Limit Programming (the selected input clock of 2 kHz, 4 kHz or 8 kHz)

MULTI_PH_8K_4K_2K_EN	WIDE_EN	Coarse Phase Limit
0	don't-care	±1 UI
1	0	±1 UI
	1	set by the PH_LOS_COARSE_LIMIT[3:0] bits

Table 11: Coarse Phase Limit Programming (the selected input clock of other than 2 kHz, 4 kHz and 8 kHz)

WIDE_EN	Coarse Phase Limit
0	±1 UI
1	set by the PH_LOS_COARSE_LIMIT[3:0] bits

The occurrence of the coarse phase loss will result in T0 DPLL unlocked if the COARSE_PH_LOS_LIMIT_EN bit is '1'.

3.7.1.3 Fine Phase Loss

The T0 DPLL compares the selected input clock with the feedback signal. If the phase-compared result exceeds the fine phase limit programmed by the PH_LOS_FINE_LIMIT[2:0] bits, a fine phase loss is triggered. It is cleared once the phase-compared result is within the fine phase limit.

The occurrence of the fine phase loss will result in T0 DPLL unlocked if the FINE_PH_LOS_LIMIT_EN bit is '1'.

3.7.1.4 Hard Limit Exceeding

Two limits are available for this monitoring. They are DPLL soft limit and DPLL hard limit. When the frequency of the DPLL output with respect to the master clock exceeds the DPLL soft / hard limit, a DPLL soft / hard alarm will be raised; the alarm is cleared once the frequency is within the corresponding limit. The occurrence of the DPLL soft alarm does not affect the T0 DPLL locking status. The DPLL soft alarm is indicated by the corresponding T0_DPLL_SOFT_FREQ_ALARM bit. The occurrence of the DPLL hard alarm will result in T0 DPLL unlocked if the FREQ_LIMIT_PH_LOS bit is '1'.

The DPLL soft limit is set by the DPLL_FREQ_SOFT_LIMIT[6:0] bits and can be calculated as follows:

$$\text{DPLL Soft Limit (ppm)} = \text{DPLL_FREQ_SOFT_LIMIT}[6:0] \times 0.724$$

The DPLL hard limit is set by the DPLL_FREQ_HARD_LIMIT[15:0] bits and can be calculated as follows:

$$\text{DPLL Hard Limit (ppm)} = \text{DPLL_FREQ_HARD_LIMIT}[15:0] \times 0.0014$$

3.7.2 LOCKING STATUS

The DPLL locking status depends on the locking monitoring results. The DPLL is in locked state if none of the following events is triggered during 2 seconds; otherwise, the DPLL is unlocked.

- Fast Loss (the FAST_LOS_SW bit is '1');
- Coarse Phase Loss (the COARSE_PH_LOS_LIMIT_EN bit is '1');
- Fine Phase Loss (the FINE_PH_LOS_LIMIT_EN bit is '1');
- DPLL Hard Alarm (the FREQ_LIMIT_PH_LOS bit is '1').

If the FAST_LOS_SW bit, the COARSE_PH_LOS_LIMIT_EN bit, the FINE_PH_LOS_LIMIT_EN bit or the FREQ_LIMIT_PH_LOS bit is '0', the DPLL locking status will not be affected even if the corresponding event is triggered. If all these bits are '0', the DPLL will be in locked state in 2 seconds.

The DPLL locking status is indicated by the T0_DPLL_LOCK bit.

3.7.3 PHASE LOCK ALARM

A phase lock alarm will be raised when the selected input clock can not be locked in T0 DPLL within a certain period. This period can be calculated as follows:

$$\text{Period (sec.)} = \text{TIME_OUT_VALUE}[5:0] \times \text{MULTI_FACTOR}[1:0]$$

The phase lock alarm is indicated by the corresponding INn_CMOS_PH_LOCK_ALARM bit (n = 1 or 2).

The phase lock alarm can be cleared by the following two ways, as selected by the PH_ALARM_TIMEOUT bit:

- Be cleared when a '1' is written to the corresponding IN_n_CMOS_PH_LOCK_ALARM bit;
- Be cleared after the period ($= \text{TIME_OUT_VALUE}[5:0] \times \text{MULTI_FACTOR}[1:0]$ in second) which starts from when the alarm is raised.

The selected input clock with a phase lock alarm is disqualified for T0 DPLL locking.

Table 12: Related Bit / Register in Chapter 3.7

Bit	Register	Address (Hex)
FAST_LOS_SW	PHASE_LOSS_FINE_LIMIT_CNFG	5B
PH_LOS_FINE_LIMIT[2:0]		
FINE_PH_LOS_LIMIT_EN		
MULTI_PH_8K_4K_2K_EN	PHASE_LOSS_COARSE_LIMIT_CNFG	5A
WIDE_EN		
PH_LOS_COARSE_LIMIT[3:0]		
COARSE_PH_LOS_LIMIT_EN		
T0_DPLL_SOFT_FREQ_ALARM	OPERATING_STS	52
T0_DPLL_LOCK		
DPLL_FREQ_SOFT_LIMIT[6:0]	DPLL_FREQ_SOFT_LIMIT_CNFG	65
FREQ_LIMIT_PH_LOS		
DPLL_FREQ_HARD_LIMIT[15:0]	DPLL_FREQ_HARD_LIMIT[15:8]_CNFG, DPLL_FREQ_HARD_LIMIT[7:0]_CNFG	67, 66
TIME_OUT_VALUE[5:0]	PHASE_ALARM_TIME_OUT_CNFG	08
MULTI_FACTOR[1:0]		
IN _n _CMOS_PH_LOCK_ALARM (n = 1 or 2)	IN1_IN2_CMOS_STS	44
PH_ALARM_TIMEOUT	INPUT_MODE_CNFG	09

3.8 SELECTED INPUT CLOCK SWITCH

If the input clock is selected by External Fast selection or by Forced selection, it can be switched by setting the related registers (refer to [Chapter 3.6.1 External Fast Selection](#) & [Chapter 3.6.2 Forced Selection](#)) any time. In this case, whether the input clock is qualified for DPPLL locking does not affect the clock switch.

When the input clock is selected by Automatic selection, the input clock switch depends on its validity and priority. If the current selected input clock is disqualified, a new qualified input clock may be switched to.

3.8.1 INPUT CLOCK VALIDITY

For the input clocks, the validity depends on the results of input clock quality monitoring (refer to [Chapter 3.5 Input Clock Quality Monitoring](#)). When all of the following conditions are satisfied, the input clock is valid; otherwise, it is invalid.

- No no-activity alarm (the `INn_CMOS_NO_ACTIVITY_ALARM` bit is '0');
- No frequency hard alarm (the `INn_CMOS_FREQ_HARD_ALARM` bit is '0');
- If the `IN_NOISE_WINDOW` bit is '1', all the edges of the input clock of 2 kHz, 4 kHz or 8 kHz drift inside $\pm 5\%$; if the `IN_NOISE_WINDOW` bit is '0', this condition is ignored.
- No phase lock alarm, i.e., the `INn_CMOS_PH_LOCK_ALARM` bit is '0';
- If the `ULTR_FAST_SW` bit is '1', the T0 selected input clock misses less than (<) 2 consecutive clock cycles; if the `ULTR_FAST_SW` bit is '0', this condition is ignored.

The validities of the input clocks are indicated by the `INn_CMOS1` bit ($n = 1$ or 2). When the input clock validity changes (from 'valid' to 'invalid' or from 'invalid' to 'valid'), the `INn_CMOS2` bit will be set. If the `INn_CMOS3` bit is '1', an interrupt will be generated.

When the T0 selected input clock has failed, i.e., the validity of the T0 selected input clock changes from 'valid' to 'invalid', the `T0_MAIN_REF_FAILED1` bit will be set. If the `T0_MAIN_REF_FAILED2` bit is '1', an interrupt will be generated. This interrupt can also be indicated by hardware - the TDO pin, as determined by the `LOS_FLAG_TO_TDO` bit. When the TDO pin is used to indicate this interrupt, it will be set high when this interrupt is generated and will remain high until this interrupt is cleared.

3.8.2 SELECTED INPUT CLOCK SWITCH

Revertive and Non-Revertive switches are supported, as selected by the `REVERTIVE_MODE` bit.

The difference between Revertive and Non-Revertive switches is that whether the selected input clock is switched when another qualified input clock with a higher priority than the current selected input clock is available for selection. In Non-Revertive switch, input clock switch is minimized.

Conditions of the qualified input clocks available for T0 selection are as the following:

- Valid, i.e., the `INn_CMOS1` bit is '1';
- Priority enabled, i.e., the corresponding `INn_CMOS_SEL_PRIORITY[3:0]` bits are not '0000'.

The input clock is disqualified if any of the above conditions is not satisfied.

In summary, the selected input clock can be switched by:

- External Fast selection;
- Forced selection;
- Revertive switch;
- Non-Revertive switch.

3.8.2.1 Revertive Switch

In Revertive switch, the selected input clock is switched when another qualified input clock with a higher priority than the current selected input clock is available.

The selected input clock is switched if any of the following is satisfied:

- The selected input clock is disqualified;
- Another qualified input clock with a higher priority than the selected input clock is available.

A qualified input clock with the higher priority is selected by revertive switch. If more than one qualified input clock is available and has the same priority, the input clock with the smaller 'n' is selected. See [Table 8](#) for the 'n' assigned to each input clock.

3.8.2.2 Non-Revertive Switch

In Non-Revertive switch, the T0 selected input clock is not switched when another qualified input clock with a higher priority than the current selected input clock is available. In this case, the selected input clock is switched and a qualified input clock with the higher priority is selected only when the T0 selected input clock is disqualified. If more than one qualified input clock is available and has the same priority, the input clock with the smaller 'n' is selected. See [Table 8](#) for the 'n' assigned to each input clock.

3.8.3 SELECTED / QUALIFIED INPUT CLOCKS INDICATION

The selected input clock is indicated by the `CURRENTLY_SELECTED_INPUT[3:0]` bits.

The qualified input clocks with the two highest priorities are indicated by the `HIGHEST_PRIORITY_VALIDATED[3:0]` bits and the `SECOND_HIGHEST_PRIORITY_VALIDATED[3:0]` bits respectively. If more than one input clock has the same priority, the input clock with the smaller 'n' is indicated by the `HIGHEST_PRIORITY_VALIDATED[3:0]` bits. See [Table 8](#) for the 'n' assigned to the input clock.

When the device is configured in Automatic selection and Revertive switch is enabled, the input clock indicated by the `CURRENTLY_SELECTED_INPUT[3:0]` bits is the same as the one indicated by the `HIGHEST_PRIORITY_VALIDATED[3:0]` bits; otherwise, they are not the same.

Table 13: Related Bit / Register in Chapter 3.8

Bit	Register	Address (Hex)
INn_CMOS ¹ (n = 1 or 2)	INPUT_VALID1_STS	4A
INn_CMOS ² (n = 1 or 2)	INTERRUPTS1_STS, INTERRUPTS2_STS	0D, 0E
INn_CMOS ³ (n = 1 or 2)	INTERRUPTS1_ENABLE_CNFG, INTERRUPTS2_ENABLE_CNFG	10, 11
INn_CMOS_NO_ACTIVITY_ALARM (n = 1 or 2)	IN1_IN2_CMOS_STS	44
INn_CMOS_FREQ_HARD_ALARM (n = 1 or 2)		
INn_CMOS_PH_LOCK_ALARM (n = 1 or 2)		
IN_NOISE_WINDOW	PHASE_MON_PBO_CNFG	78
ULTR_FAST_SW	MON_SW_PBO_CNFG	0B
LOS_FLAG_TO_TDO		
T0_MAIN_REF_FAILED ¹	INTERRUPTS2_STS	0E
T0_MAIN_REF_FAILED ²	INTERRUPTS2_ENABLE_CNFG	11
REVERTIVE_MODE	INPUT_MODE_CNFG	09
INn_CMOS_SEL_PRIORITY[3:0] (n = 1 or 2)	IN1_IN2_CMOS_SEL_PRIORITY_CNFG	27
CURRENTLY_SELECTED_INPUT[3:0]	PRIORITY_TABLE1_STS	4E
HIGHEST_PRIORITY_VALIDATED[3:0]		
SECOND_HIGHEST_PRIORITY_VALIDATED[3:0]	PRIORITY_TABLE2_STS	4F

3.9 SELECTED INPUT CLOCK STATUS VS. DPLL OPERATING MODE

T0 DPLL supports three primary operating modes: Free-Run, Locked and Holdover, and three secondary, temporary operating modes: Pre-Locked, Pre-Locked2 and Lost-Phase. The operating mode of T0 DPLL can be switched automatically or by force, as controlled by the T0_OPERATING_MODE[2:0] bits.

When the operating mode is switched by force, the operating mode switch is under external control and the status of the selected input clock takes no effect to the operating mode selection. The forced operating mode switch is applicable for special cases, such as testing.

When the operating mode is switched automatically, the internal state machine for T0 automatically determine the operating mode.

The T0 DPLL operating mode is controlled by the T0_OPERATING_MODE[2:0] bits, as shown in Table 14:

Table 14: T0 DPLL Operating Mode Control

T0_OPERATING_MODE[2:0]	T0 DPLL Operating Mode
000	Automatic
001	Forced - Free-Run
010	Forced - Holdover
100	Forced - Locked
101	Forced - Pre-Locked2
110	Forced - Pre-Locked
111	Forced - Lost-Phase

When the operating mode is switched automatically, the operation of the internal state machine is shown in Figure 7.

Whether the operating mode is under external control or is switched automatically, the current operating mode is always indicated by the T0_DPLL_OPERATING_MODE[2:0] bits. When the operating mode switches, the T0_OPERATING_MODE¹ bit will be set. If the T0_OPERATING_MODE² bit is '1', an interrupt will be generated.

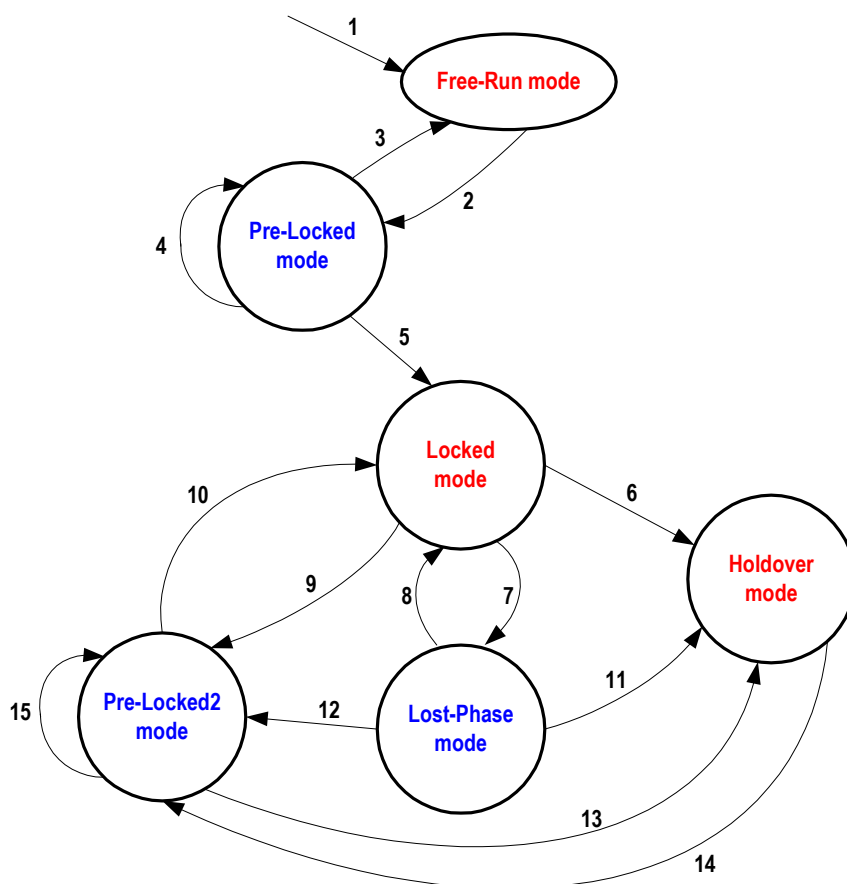


Figure 7. T0 Selected Input Clock vs. DPLL Automatic Operating Mode

Notes to Figure 7:

1. Reset.
2. An input clock is selected.
3. The T0 selected input clock is disqualified **AND** No qualified input clock is available.
4. The T0 selected input clock is switched to another one.
5. The T0 selected input clock is locked (the T0_DPLL_LOCK bit is '1').
6. The T0 selected input clock is disqualified **AND** No qualified input clock is available.
7. The T0 selected input clock is unlocked (the T0_DPLL_LOCK bit is '0').
8. The T0 selected input clock is locked again (the T0_DPLL_LOCK bit is '1').
9. The T0 selected input clock is switched to another one.
10. The T0 selected input clock is locked (the T0_DPLL_LOCK bit is '1').
11. The T0 selected input clock is disqualified **AND** No qualified input clock is available.
12. The T0 selected input clock is switched to another one.
13. The T0 selected input clock is disqualified **AND** No qualified input clock is available.
14. An input clock is selected.
15. The T0 selected input clock is switched to another one.

The causes of Item 4, 9, 12, 15 - 'the T0 selected input clock is switched to another one' - are: (The T0 selected input clock is disqualified **AND** Another input clock is switched to) **OR** (In Revertive switch, a qualified input clock with a higher priority is switched to) **OR** (The T0 selected input clock is switched to another one by External Fast selection or Forced selection).

Refer to [Chapter 3.8.2 Selected Input Clock Switch](#) for details about T0 input clock qualification.

Table 15: Related Bit / Register in Chapter 3.9

Bit	Register	Address (Hex)
T0_OPERATING_MODE[2:0]	T0_OPERATING_MODE_CNFG	53
T0_DPLL_OPERATING_MODE[2:0]	OPERATING_STS	52
T0_DPLL_LOCK		
T0_OPERATING_MODE ¹	INTERRUPTS2_STS	0E
T0_OPERATING_MODE ²	INTERRUPTS2_ENABLE_CNFG	11

3.10 DPLL OPERATING MODE

The T0 DPLL gives a stable performance in different applications without being affected by operating conditions or silicon process variations. It integrates a PFD (Phase & Frequency Detector), a LPF (Low Pass Filter) and a DCO (Digital Controlled Oscillator), which forms a closed loop. If no input clock is selected, the loop is not closed, and the PFD and LPF do not function.

The PFD detects the phase error, including the fast loss, coarse phase loss and fine phase loss (refer to [Chapter 3.7.1.1 Fast Loss](#) to [Chapter 3.7.1.3 Fine Phase Loss](#)). The averaged phase error of the T0 DPLL feedback with respect to the selected input clock is indicated by the CURRENT_PH_DATA[15:0] bits. It can be calculated as follows:

$$\text{Averaged Phase Error (ns)} = \text{CURRENT_PH_DATA}[15:0] \times 0.61$$

The LPF filters jitters. Its 3 dB bandwidth and damping factor are programmable. A range of bandwidths and damping factors can be set to meet different application requirements. Generally, the lower the damping factor is, the longer the locking time is and the more the gain is.

The DCO controls the DPLL output. The frequency of the DPLL output is always multiplied on the basis of the master clock. The phase and frequency offset of the DPLL output may be locked to those of the selected input clock. The current frequency offset with respect to the master clock is indicated by the CURRENT_DPLL_FREQ[23:0] bits, and can be calculated as follows:

$$\text{Current Frequency Offset (ppm)} = \text{CURRENT_DPLL_FREQ}[23:0] \times 0.000011$$

3.10.1 SIX OPERATING MODES

The T0 DPLL loop is closed except in Free-Run mode and Holdover mode.

For a closed loop, different bandwidths and damping factors can be used depending on DPLL locking stages: starting, acquisition and locked.

In the first two seconds when the T0 DPLL attempts to lock to the selected input clock, the starting bandwidth and damping factor are used. They are set by the T0_DPLL_START_BW[4:0] bits and the T0_DPLL_START_DAMPING[2:0] bits respectively.

During the acquisition, the acquisition bandwidth and damping factor are used. They are set by the T0_DPLL_ACQ_BW[4:0] bits and the T0_DPLL_ACQ_DAMPING[2:0] bits respectively.

When the T0 selected input clock is locked, the locked bandwidth and damping factor are used. They are set by the T0_DPLL_LOCKED_BW[4:0] bits and the T0_DPLL_LOCKED_DAMPING[2:0] bits respectively.

The corresponding bandwidth and damping factor are used when the T0 DPLL operates in different DPLL locking stages: starting, acquisition and locked, as controlled by the device automatically.

Only the locked bandwidth and damping factor can be used regardless of the T0 DPLL locking stage, as controlled by the AUTO_BW_SEL bit.

3.10.1.1 Free-Run Mode

In Free-Run mode, the T0 DPLL output refers to the master clock and is not affected by any input clock. The accuracy of the T0 DPLL output is equal to that of the master clock.

3.10.1.2 Pre-Locked Mode

In Pre-Locked mode, the T0 DPLL output attempts to track the selected input clock.

The Pre-Locked mode is a secondary, temporary mode.

3.10.1.3 Locked Mode

In Locked mode, the T0 selected input clock is locked. The phase and frequency offset of the T0 DPLL output track those of the T0 selected input clock.

In this mode, if the T0 selected input clock is in fast loss status and the FAST_LOS_SW bit is '1', the T0 DPLL is unlocked (refer to [Chapter 3.7.1.1 Fast Loss](#)) and will enter Lost-Phase mode when the operating mode is switched automatically; if the T0 selected input clock is in fast loss status and the FAST_LOS_SW bit is '0', the T0 DPLL locking status is not affected and the T0 DPLL will enter Temp-Holdover mode automatically.

3.10.1.3.1 Temp-Holdover Mode

The T0 DPLL will automatically enter Temp-Holdover mode with a selected input clock switch or no qualified input clock available when the operating mode switch is under external control.

In Temp-Holdover mode, the T0 DPLL has temporarily lost the selected input clock. The T0 DPLL operation in Temp-Holdover mode and that in Holdover mode are alike (refer to [Chapter 3.10.1.5 Holdover Mode](#)) except the frequency offset acquiring methods. See [Chapter 3.10.1.5 Holdover Mode](#) for details about the methods. The method is selected by the TEMP_HOLDOVER_MODE[1:0] bits, as shown in [Table 16](#):

Table 16: Frequency Offset Control in Temp-Holdover Mode

TEMP_HOLDOVER_MODE[1:0]	Frequency Offset Acquiring Method
00	the same as that used in Holdover mode
01	Automatic Instantaneous
10	Automatic Fast Averaged
11	Automatic Slow Averaged

The device automatically controls the T0 DPLL to exit from Temp-Holdover mode.

3.10.1.4 Lost-Phase Mode

In Lost-Phase mode, the T0 DPLL output attempts to track the selected input clock.

The Lost-Phase mode is a secondary, temporary mode.

3.10.1.5 Holdover Mode

In Holdover mode, the T0 DPLL resorts to the stored frequency data acquired in Locked mode to control its output. The T0 DPLL output is not

phase locked to any input clock. The frequency offset acquiring method is selected by the MAN_HOLD OVER bit, the AUTO_AVG bit and the FAST_AVG bit, as shown in [Table 17](#):

Table 17: Frequency Offset Control in Holdover Mode

MAN_HOLD OVER	AUTO_AVG	FAST_AVG	Frequency Offset Acquiring Method
0	0	don't-care	Automatic Instantaneous
	1	0	Automatic Slow Averaged
		1	Automatic Fast Averaged
1	don't-care		Manual

3.10.1.5.1 Automatic Instantaneous

By this method, the T0 DPLL freezes at the operating frequency when it enters Holdover mode. The accuracy is 4.4×10^{-8} ppm.

3.10.1.5.2 Automatic Slow Averaged

By this method, an internal IIR (Infinite Impulse Response) filter is employed to get the frequency offset. The IIR filter gives a 3 dB attenuation point corresponding to a period of 110 minutes. The accuracy is 1.1×10^{-5} ppm.

3.10.1.5.3 Automatic Fast Averaged

By this method, an internal IIR (Infinite Impulse Response) filter is employed to get the frequency offset. The IIR filter gives a 3 dB attenuation point corresponding to a period of 8 minutes. The accuracy is 1.1×10^{-5} ppm.

3.10.1.5.4 Manual

By this method, the frequency offset is set by the T0_HOLD OVER_FREQ[23:0] bits. The accuracy is 1.1×10^{-5} ppm.

The frequency offset of the T0 DPLL output is indicated by the CURRENT_DPLL_FREQ[23:0] bits.

The device provides a reference for the value to be written to the T0_HOLD OVER_FREQ[23:0] bits. The value to be written can refer to the value read from the CURRENT_DPLL_FREQ[23:0] bits or the T0_HOLD OVER_FREQ[23:0] bits (refer to [Chapter 3.10.1.5.5 Holdover Frequency Offset Read](#)); or then be processed by external software filtering.

3.10.1.5.5 Holdover Frequency Offset Read

The offset value, which is acquired by Automatic Slow Averaged, Automatic Fast Averaged and is set by related register bits, can be read from the T0_HOLD OVER_FREQ[23:0] bits by setting the READ_AVG bit and the FAST_AVG bit, as shown in [Table 18](#).

Table 18: Holdover Frequency Offset Read

READ_AVG	FAST_AVG	Offset Value Read from T0_HOLD OVER_FREQ[23:0]
0	don't-care	The value is equal to the one written to.
1	0	The value is acquired by Automatic Slow Averaged method, not equal to the one written to.
	1	The value is acquired by Automatic Fast Averaged method, not equal to the one written to.

The frequency offset in ppm is calculated as follows:

$$\text{Holdover Frequency Offset (ppm)} = \text{T0_HOLD OVER_FREQ[23:0]} \times 0.000011$$

3.10.1.6 Pre-Locked2 Mode

In Pre-Locked2 mode, the T0 DPLL output attempts to track the selected input clock.

The Pre-Locked2 mode is a secondary, temporary mode.

Table 19: Related Bit / Register in Chapter 3.10

Bit	Register	Address (Hex)
CURRENT_PH_DATA[15:0]	CURRENT_DPLL_PHASE[15:8]_STS, CURRENT_DPLL_PHASE[7:0]_STS	69, 68
CURRENT_DPLL_FREQ[23:0]	CURRENT_DPLL_FREQ[23:16]_STS, CURRENT_DPLL_FREQ[15:8]_STS, CURRENT_DPLL_FREQ[7:0]_STS	64, 63, 62
T0_DPLL_START_BW[4:0]	T0_DPLL_START_BW_DAMPING_CNFG	56
T0_DPLL_START_DAMPING[2:0]		
T0_DPLL_ACQ_BW[4:0]	T0_DPLL_ACQ_BW_DAMPING_CNFG	57
T0_DPLL_ACQ_DAMPING[2:0]		
T0_DPLL_LOCKED_BW[4:0]	T0_DPLL_LOCKED_BW_DAMPING_CNFG	58
T0_DPLL_LOCKED_DAMPING[2:0]		
AUTO_BW_SEL	T0_BW_OVERSHOOT_CNFG	59
FAST_LOS_SW	PHASE_LOSS_FINE_LIMIT_CNFG	5B
TEMP_HOLD OVER_MODE[1:0]	T0_HOLD OVER_MODE_CNFG	5C
MAN_HOLD OVER		
AUTO_AVG		
FAST_AVG		
READ_AVG		
T0_HOLD OVER_FREQ[23:0]	T0_HOLD OVER_FREQ[23:16]_CNFG, T0_HOLD OVER_FREQ[15:8]_CNFG, T0_HOLD OVER_FREQ[7:0]_CNFG	5F, 5E, 5D

3.11 DPLL OUTPUT

The DPLL output is locked to the selected input clock. According to the phase-compared result of the feedback and the selected input clock, and the DPLL output frequency offset, the PFD output is limited and the DPLL output is frequency offset limited.

3.11.1 PFD OUTPUT LIMIT

The PFD output is limited to be within ± 1 UI or within the coarse phase limit (refer to [Chapter 3.7.1.2 Coarse Phase Loss](#)), as determined by the MULTI_PH_APP bit.

3.11.2 FREQUENCY OFFSET LIMIT

The DPLL output is limited to be within the DPLL hard limit (refer to [Chapter 3.7.1.4 Hard Limit Exceeding](#)).

The integral path value can be frozen when the DPLL hard limit is reached. This function, enabled by the T0_LIMT bit, will minimize the subsequent overshoot when T0 DPLL is pulling in.

3.11.3 PBO

When a PBO event is triggered, the phase offset of the selected input clock with respect to the T0 DPLL output is measured. The device then automatically accounts for the measured phase offset and compensates an appropriate phase offset into the DPLL output so that the phase transients on the T0 DPLL output are minimized.

A PBO event is triggered if any one of the following conditions occurs:

- T0 selected input clock switches (the PBO_EN bit is '1');
- T0 DPLL exits from Holdover mode or Free-Run mode (the PBO_EN bit is '1');
- Phase-time changes on the T0 selected input clock are greater than a programmable limit over an interval of less than 0.1 seconds (the PH_MON_PBO_EN bit is '1').

For the first two conditions, the phase transients on the T0 DPLL output are minimized to be no more than 0.61 ns with PBO. The PBO can also be frozen at the current phase offset by setting the PBO_FREZ bit. When the PBO is frozen, the device will ignore any further PBO events triggered by the above two conditions, and maintain the current phase offset. When the PBO is disabled, there may be a phase shift on the T0 DPLL output and the T0 DPLL output tracks back to 0 degree phase offset with respect to the T0 selected input clock.

The last condition is specially for stratum 2 and 3E clocks. The PBO requirement specified in the Telcordia GR-1244-CORE is: 'Input phase-time changes of 3.5 μ s or greater over an interval of less than 0.1 seconds or less shall be built-out by stratum 2 and 3E clocks to reduce the resulting clock phase-time change to less than 50 ns. Phase-time changes of 1.0 μ s or less over an interval of 0.1 seconds shall not be built-out.' Based on this requirement, phase-time changes of more than 1.0 μ s but less than 3.5 μ s that occur over an interval of less than 0.1 seconds may or may not be built-out.

An integrated Phase Transient Monitor can be enabled by the PH_MON_EN bit to monitor the phase-time changes on the T0 selected input clock. When the phase-time changes are greater than a limit over an interval of less than 0.1 seconds, a PBO event is triggered and the phase transients on the DPLL output are absorbed. The limit is programmed by the PH_TR_MON_LIMT[3:0] bits, and can be calculated as follows:

$$\text{Limit (ns)} = (\text{PH_TR_MON_LIMT}[3:0] + 7) \times 156$$

The phase offset induced by PBO will never result in a coarse or fine phase loss.

3.11.4 FOUR PATHS OF T0 DPLL OUTPUTS

The T0 DPLL output are phase aligned with the T0 selected input clock every 125 μ s period. T0 DPLL has four output paths as follows:

- 77.76 MHz path - outputs a 77.76 MHz clock;
- 16E1/16T1 path - outputs a 16E1 or 16T1 clock, as selected by the IN_SONET_SDH bit;
- GSM/OBSAI/16E1/16T1 path - outputs a GSM, OBSAI, 16E1 or 16T1 clock, as selected by the T0_GSM_OBSAI_16E1_16T1_SEL[1:0] bits;
- 12E1/24T1/E3/T3 path - outputs a 12E1, 24T1, E3 or T3 clock, as selected by the T0_12E1_24T1_E3_T3_SEL[1:0] bits.

T0 selected input clock is compared with a T0 DPLL output for DPLL locking. The output can only be derived from the 77.76 MHz path or the 16E1/16T1 path. The output path is automatically selected and the output is automatically divided to get the same frequency as the T0 selected input clock.

T0 DPLL outputs are provided for T0/T4 APLL or device output process.

Table 20: Related Bit / Register in Chapter 3.11

Bit	Register	Address (Hex)
MULTI_PH_APP	PHASE_LOSS_COARSE_LIMIT_CNFG	5A
T0_LIMIT	T0_BW_OVERSHOOT_CNFG	59
PBO_EN	MON_SW_PBO_CNFG	0B
PBO_FREZ		
PH_MON_PBO_EN	PHASE_MON_PBO_CNFG	78
PH_MON_EN		
PH_TR_MON_LIMIT[3:0]		
PH_OFFSET_EN	PHASE_OFFSET[9:8]_CNFG	7B
IN_SONET_SDH	INPUT_MODE_CNFG	09
T0_GSM_OBSAI_16E1_16T1_SEL[1:0]	T0_DPLL_APLL_PATH_CNFG	55
T0_12E1_24T1_E3_T3_SEL[1:0]		

3.12 T0 / T4 APLL

A T0 APLL and a T4 APLL are provided for a better jitter and wander performance of the device output clocks.

The bandwidths of the T0/T4 APLL are set by the T0_APLL_BW[1:0] / T4_APLL_BW[1:0] bits respectively. The lower the bandwidth is, the better the jitter and wander performance of the T0/T4 APLL output are.

The input of the T0/T4 APLL can be derived from one of the T0 DPLL outputs, as selected by the T0_APLL_PATH[3:0] / T4_APLL_PATH[3:0] bits respectively.

Both the APLL and DPLL outputs are provided for selection for the device output.

Table 21: Related Bit / Register in Chapter 3.12

Bit	Register	Address (Hex)
T0_APLL_BW[1:0]	T0_T4_APLL_BW_CNFG	6A
T4_APLL_BW[1:0]		
T0_APLL_PATH[3:0]	T0_DPLL_APLL_PATH_CNFG	55
T4_APLL_PATH[3:0]	T4_APLL_PATH_CNFG	60

3.13 OUTPUT CLOCKS & FRAME SYNC SIGNALS

The device supports 2 output clocks and 1 frame sync output signal altogether.

3.13.1 OUTPUT CLOCKS

The device provides 2 output clocks.

OUT1 outputs a PECL or LVDS signal, as selected by the OUT1_PECL_LVDS bit. OUT2 outputs a CMOS signal.

The outputs on OUT1 and OUT2 are variable, depending on the signals derived from the T0 DPLL and T0/T4 APLL outputs, and the corresponding OUTn_PATH_SEL[3:0] bits (n = 1 or 2). The derived signal can be from the T0 DPLL and T0/T4 APLL outputs, as selected by the corresponding OUTn_PATH_SEL[3:0] bits (n = 1 or 2). If the signal is derived from one of the T0 DPLL outputs, please refer to [Table 22](#) for the output frequency. If the signal is derived from the T0/T4 APLL output, please refer to [Table 23](#) for the output frequency.

The outputs on OUT1 and OUT2 can be inverted, as determined by the corresponding OUTn_INV bit (n = 1 or 2).

Both the output clocks derived from T0 selected input clock are aligned with the T0 selected input clock every 125 μ s period.

Table 22: Outputs on OUT1 & OUT2 if Derived from T0 DPLL Outputs

OUTn_DIVIDER[3:0] (Output Divider) ¹	outputs on OUT1 & OUT2 if derived from T0 DPLL outputs ²								
	77.76 MHz	12E1	16E1	24T1	16T1	E3	T3	GSM (26 MHz)	OBSAI (30.72 MHz)
0000	Output is disabled (output low).								
0001									
0010		12E1	16E1	24T1	16T1	E3	T3		
0011		6E1	8E1	12T1	8T1			13 MHz	15.36 MHz
0100		3E1	4E1	6T1	4T1				
0101		2E1		4T1					
0110			2E1	3T1	2T1				
0111		E1		2T1					
1000			E1		T1				
1001				T1					
1010	64 kHz								
1011	8 kHz								
1100	2 kHz								
1101	400 Hz								
1110	1Hz								
1111	Output is disabled (output high).								

Note:

1. n = 1 or 2. Each output is assigned a frequency divider.

2. E1 = 2.048 MHz, T1 = 1.544 MHz, E3 = 34.368 MHz, T3 = 44.736 MHz. The blank cell means the configuration is reserved.

Table 23: Outputs on OUT1 & OUT2 if Derived from T0/T4 APLL

OUTn_DIVIDER[3:0] (Output Divider) ¹	outputs on OUT1 & OUT2 if derived from T0/T4 APLL output ²								
	77.76 MHz X 4	12E1 X 4	16E1 X 4	24T1 X 4	16T1 X 4	E3	T3	GSM (26 MHz X 2)	OBSAI (30.72 MHz X 10)
0000	Output is disabled (output low).								
0001	622.08 MHz ³								
0010	311.04 MHz ³	48E1	64E1	96T1	64T1	E3	T3	52 MHz	
0011	155.52 MHz	24E1	32E1	48T1	32T1			26 MHz	153.6 MHz
0100	77.76 MHz	12E1	16E1	24T1	16T1			13 MHz	76.8 MHz
0101	51.84 MHz	8E1		16T1					
0110	38.88 MHz	6E1	8E1	12T1	8T1				38.4 MHz
0111	25.92 MHz	4E1		8T1					
1000	19.44 MHz	3E1	4E1	6T1	4T1				
1001		2E1		4T1					61.44 MHz ⁴
1010			2E1	3T1	2T1				30.72 MHz ⁴
1011	6.48 MHz	E1		2T1					15.36 MHz ⁴
1100			E1		T1				7.68 MHz ⁴
1101				T1					3.84 MHz ⁴
1110									
1111	Output is disabled (output high).								

Note:

1. n = 1 or 2. Each output is assigned a frequency divider.

2. In the APLL, the selected T0 DPPL output may be multiplied. E1 = 2.048 MHz, T1 = 1.544 MHz, E3 = 34.368 MHz, T3 = 44.736 MHz. The blank cell means the configuration is reserved.

3. The 622.08 MHz and 311.04 MHz differential signals are only output on OUT1.

4. The 61.44 MHz, 30.72 MHz, 15.36 MHz, 7.68 MHz and 3.84 MHz outputs are only derived from T0 APLL.

3.13.2 FRAME SYNC OUTPUT SIGNAL

An 8 kHz frame sync signal is output on the FRSYNC_8K pin if enabled by the 8K_EN bit. It is a CMOS output.

The frame sync signal is derived from the T0 APLL output and are aligned with the output clock. It can be synchronized to one of the two frame sync input signals.

One of the two frame sync input signals is selected, as determined by the SYNC_BYPASS bit and the T0 selected input clock, as shown in Table 24:

Table 24: Frame Sync Input Signal Selection

SYNC_BYPASS	T0 Selected Input Clock	Selected Frame Sync Input Signal
0	don't-care	EX_SYNC1
1	IN1_CMOS	EX_SYNC1
	IN2_CMOS	EX_SYNC2
	none	none

If the selected frame sync input signal with respect to the T0 selected input clock is above a limit set by the SYNC_MON_LIMT[2:0] bits, an external sync alarm will be raised and the selected frame sync input signal is disabled to synchronize the frame sync output signal. The external sync alarm is cleared once the selected frame sync input signal with respect to the T0 selected input clock is within the limit. If it is within the

limit, whether the selected frame sync input signal is enabled to synchronize the frame sync output signal is determined by the SYNC_BYPASS bit, the AUTO_EXT_SYNC_EN bit and the EXT_SYNC_EN bit. Refer to Table 25 for details.

When the selected frame sync input signal is enabled to synchronize the frame sync output signal, it should be adjusted to align itself with the T0 selected input clock. Nominally, the falling edge of the selected frame sync input signal is aligned with the rising edge of the T0 selected input clock. The selected frame sync input signal may be 0.5 UI early/late or 1 UI late due to the circuit and board wiring delays. Setting the sampling of the selected frame sync input signal by the SYNC_PHn[1:0] bits (n = 1 or 2 corresponding to EX_SYNC1 or EX_SYNC2 respectively) will compensate this early/late. Refer to Figure 8 to Figure 11.

The EX_SYNC_ALARM_MON bit indicates whether the selected frame sync input signal is in external sync alarm status. The external sync alarm is indicated by the EX_SYNC_ALARM¹ bit. If the EX_SYNC_ALARM² bit is '1', the occurrence of the external sync alarm will trigger an interrupt.

The 8 kHz frame sync output signal can be inverted by setting the 8K_INV bit. The frame sync output can be 50:50 duty cycle or pulsed, as determined by the 8K_PUL bit. When they are pulsed, the pulse width is defined by the period of OUT2; and they are pulsed on the position of the falling or rising edge of the standard 50:50 duty cycle, as selected by the 8K_PUL_POSITION bit.

Table 25: Synchronization Control

SYNC_BYPASS	AUTO_EXT_SYNC_EN	EXT_SYNC_EN	Synchronization
0	don't-care	0	Disabled
	0	1	Enabled
	1	1	Disabled
1	don't-care		Enabled

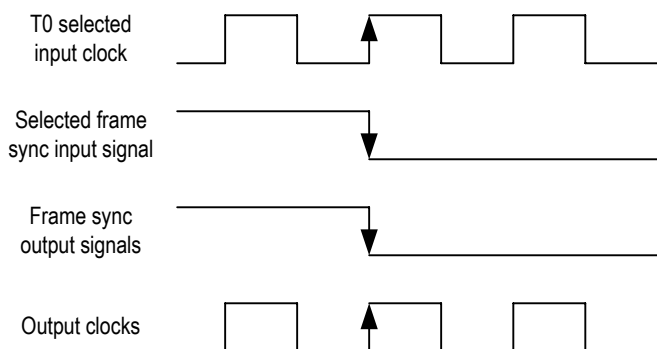


Figure 8. On Target Frame Sync Input Signal Timing

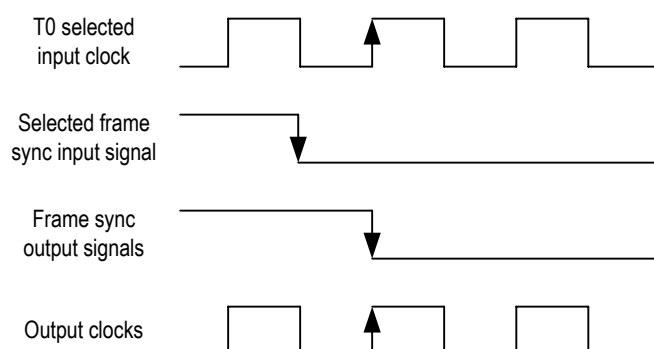


Figure 9. 0.5 UI Early Frame Sync Input Signal Timing

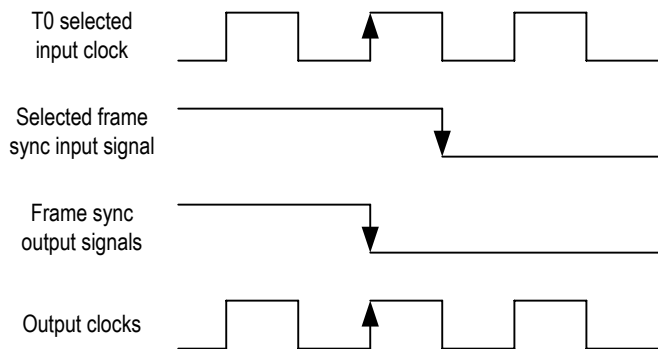


Figure 10. 0.5 UI Late Frame Sync Input Signal Timing

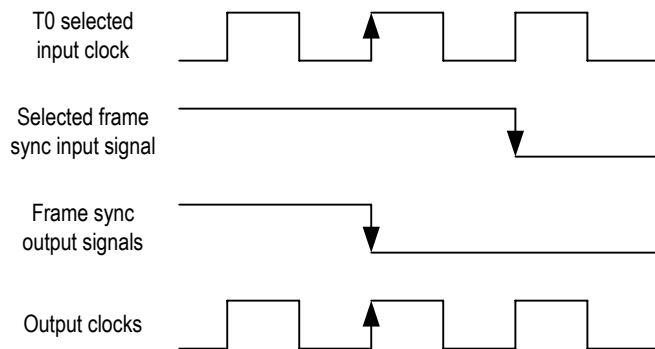


Figure 11. 1 UI Late Frame Sync Input Signal Timing

Table 26: Related Bit / Register in Chapter 3.13

Bit	Register	Address (Hex)
OUT1_PECI_LVDS	DIFFERENTIAL_IN_OUT_OSCI_CNFG	0A
OUTn_PATH_SEL[3:0] (n = 1 or 2)	OUT1_FREQ_CNFG, OUT2_FREQ_CNFG	71, 6D
OUTn_DIVIDER[3:0] (n = 1 or 2)		
IN_SONET_SDH	INPUT_MODE_CNFG	09
AUTO_EXT_SYNC_EN		
EXT_SYNC_EN		
OUTn_INV (n = 1 or 2)	OUT1_INV_CNFG, OUT2_INV_CNFG	73, 72
8K_EN	FR_SYNC_CNFG	74
8K_INV		
8K_PUL		
8K_PUL_POSITION		
SYNC_BYPASS	SYNC_MONITOR_CNFG	7C
SYNC_MON_LIMT[2:0]		
SYNC_PHn[1:0] (n = 1 or 2)	SYNC_PHASE_CNFG	7D
EX_SYNC_ALARM_MON	OPERATING_STS	52
EX_SYNC_ALARM ¹	INTERRUPTS3_STS	0F
EX_SYNC_ALARM ²	INTERRUPTS3_ENABLE_CNFG	12

3.14 INTERRUPT SUMMARY

The interrupt sources of the device are as follows:

- T0 Input clocks validity change
- T0 selected input clock fail
- T0 DPLL operating mode switch
- External sync alarm

All of the above interrupt events are indicated by the corresponding interrupt status bit. If the corresponding interrupt enable bit is set, any of the interrupts can be reported by the INT_REQ pin. The output characteristics on the INT_REQ pin are determined by the HZ_EN bit and the INT_POL bit.

Interrupt events are cleared by writing a '1' to the corresponding interrupt status bit. The INT_REQ pin will be inactive only when all the pending enabled interrupts are cleared.

In addition, the interrupt of T0 selected input clock fail can be reported by the TDO pin, as determined by the LOS_FLAG_TO_TDO bit.

Table 27: Related Bit / Register in Chapter 3.14

Bit	Register	Address (Hex)
HZ_EN	INTERRUPT_CNFG	0C
INT_POL		
LOS_FLAG_TO_TDO	MON_SW_PBO_CNFG	0B

3.15 T0 SUMMARY

The main features supported by the T0 path are as follows:

- Phase lock alarm;
- Forced or Automatic input clock selection/switch;
- 3 primary and 3 secondary, temporary DPLL operating modes, switched automatically or under external control;
- Automatic switch between starting, acquisition and locked bandwidths/damping factors;
- Programmable DPLL bandwidths from 0.1 Hz to 560 Hz in 11 steps;
- Programmable damping factors: 1.2, 2.5, 5, 10 and 20;
- Fast loss, coarse phase loss, fine phase loss and hard limit exceeding monitoring;
- Output phase and frequency offset limited;
- Automatic Instantaneous, Automatic Slow Averaged, Automatic Fast Averaged or Manual holdover frequency offset acquiring;
- PBO to minimize output phase transients;
- Programmable output phase offset;
- Low jitter multiple clock outputs with programmable polarity;
- Low jitter 8 kHz frame sync signal output with programmable pulse width and polarity;

3.16 LINE CARD APPLICATION

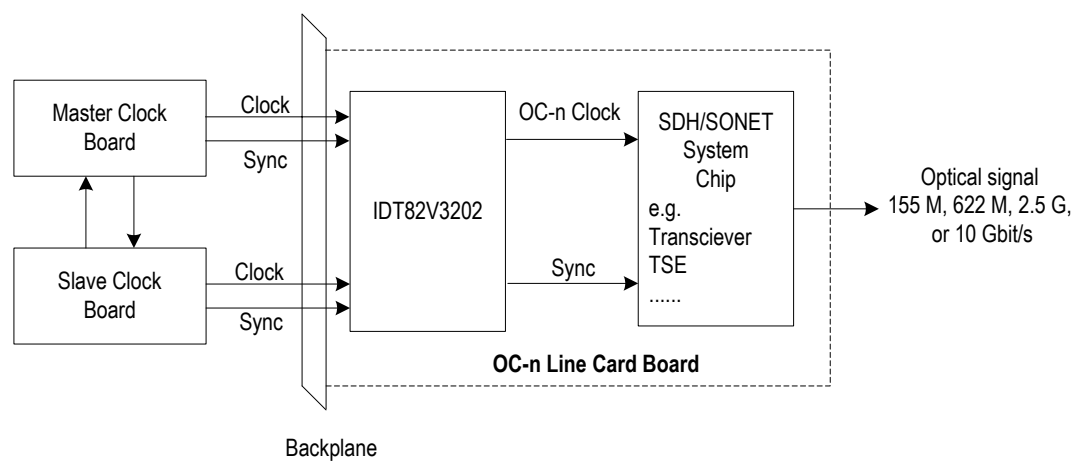


Figure 12. Line Card Application

4 I²C PROGRAMMING INTERFACE

The I²C bus interface provides access to read and write the registers in the IDT82V3202.

4.1 FUNCTION DESCRIPTION

The timing of a complete data transfer is shown in Figure 13.

The transfer process can be divided into three phases:

- START (S) or repeated START (Sr) condition;
- Byte data transfer condition;
- STOP (P) condition.

The definitions of S/Sr and P conditions are shown in Table 28:

Table 28: Definition of S/Sr and P Conditions

Condition	Definition
S/Sr	A high to low transition on the SDA pin while the SCL pin is high.
P	A low to high transition on the SDA pin while the SCL pin is high.

Every byte put on the SDA line must be 8-bit long. The number of bytes that can be transmitted per transfer is unrestricted in theory. Each byte has to be followed by an acknowledge bit (ACK). So the whole data transfer needs a period of 9 clock cycles. The data is transferred with the most significant bit (MSB) first.

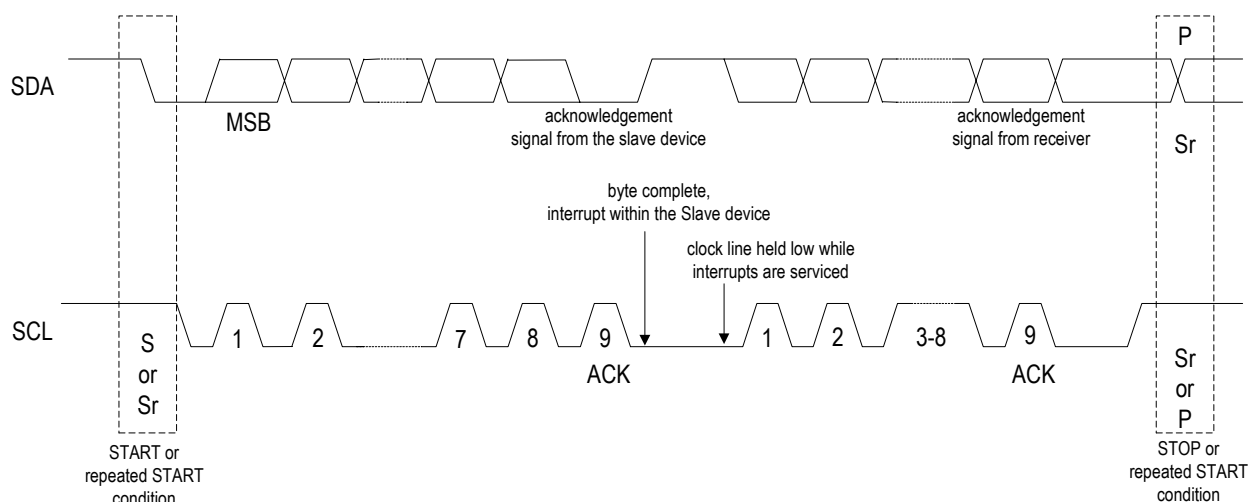


Figure 13. Data Transfer on the I²C-bus

4.1.1 DATA TRANSFER FORMAT

Two kinds of data transfer formats are supported by the IDT82V3202:

- Slave-receiver mode (Write);
- Slave-transmitter mode (Read);

4.1.1.1 Slave-receiver Mode (Write)

The Slave-receiver mode is as shown in Figure 14.

The Master device asserts the slave address followed by the Write bit. The Slave device acknowledges and the Master device delivers the address byte. The Slave device again acknowledges before the Master device sends the data byte. The Slave device acknowledges each byte, and the entire transaction is finished with a STOP condition.

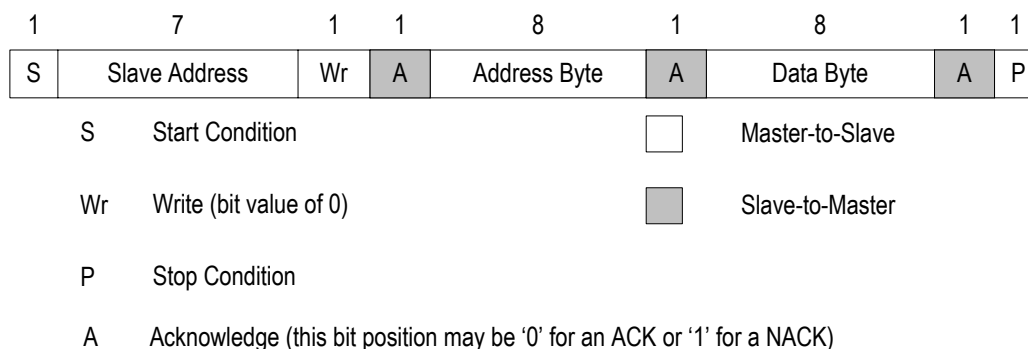


Figure 14. Slave-receiver Mode

4.1.1.2 Slave-transmitter Mode (Read)

The Slave-transmitter mode is as shown in Figure 15.

First the Master device must write an address byte to the slave device. Then it must follow that address byte with a repeated START condition to denote a read from that device's address. The Slave device then returns one byte data corresponding the address. Note that there is no STOP condition before the repeated STRAT condition, and that a no-acknowledge (NACK) signifies the end of the read transfer.

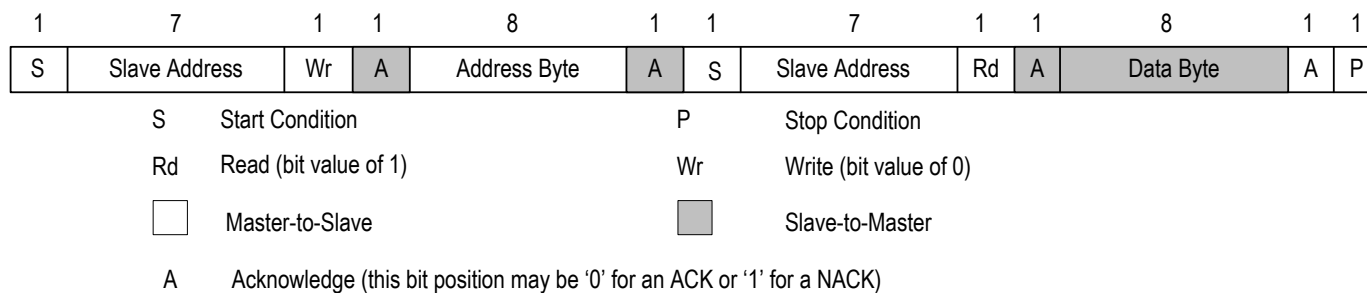


Figure 15. Slave-transmitter Mode

4.1.2 ADDRESS ASSIGNMENT

A6	A5	A4	A3	A2	A1	A0	R/ $\overline{W}$
1	0	1	0	AD2	AD1	AD0	1/0

Figure 16. Address Assignment

Each device is recognized by a unique slave address. The slave addressing procedure for the I²C-bus is such that the first byte after the START condition usually determines which slave device will be selected by the Master device. In this specification, the 4 MSB bits of the address byte are fixed and the 3 LSB bits are decided by address input pins AD[2:0], as shown in Figure 16.

The R/ $\overline{W}$ bit is used as a data transfer direction bit which is determined by the Master device. A '0' on this bit indicates a transmission (Write) to registers and a '1' indicates a request for data (Read) from the registers.

4.2 TIMING DEFINITION

The timing of I²C-bus is as shown in Figure 17.

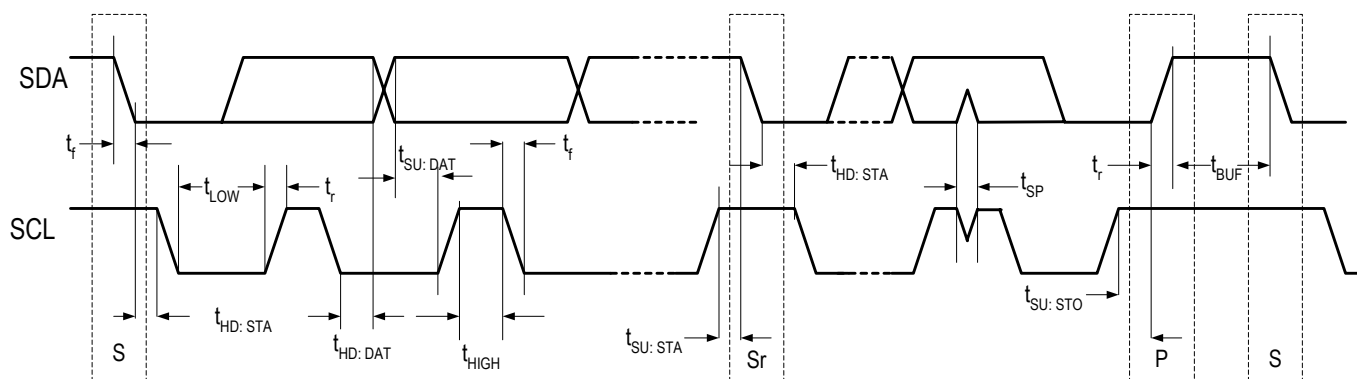


Figure 17. Timing Definition of I²C-bus

Table 29: Timing Definition for Standard Mode and Fast Mode⁽¹⁾

Symbol	Parameter	Standard Mode		Fast Mode		Unit
		Min	Max	Min	Max	
SCL	Serial clock frequency	0	100	0	400	KHz
$t_{HD; STA}$	Hold time (repeated) START condition. After this period, the first clock pulse is generated	4.0	-	0.5	-	μs
t_{LOW}	LOW period of the SCL clock	4.7	-	1.3	-	μs
t_{HIGH}	HIGH period of the SCL clock	4.0	-	0.6	-	μs
$t_{SU; STA}$	Set-up time for a repeated START condition	4.7	-	0.6	-	μs
$t_{HD; DAT}$	Data hold time: for CBUS compatible masters for I ² C-bus devices	5.0 0 ⁽²⁾	- 3.45 ⁽³⁾	- 0 ⁽²⁾	- 0.9 ⁽³⁾	μs
$t_{SU; DAT}$	Data set-up time	250	-	100 ⁽⁴⁾	-	ns
t_r	Rise time of both SDA and SCL signals	-	1000	20 + 0.1Cb ⁽⁵⁾	300	ns
t_f	Fall time of both SDA and SCL signals	-	300	20 + 0.1Cb ⁽⁵⁾	300	ns
$t_{SU; STO}$	Set-up time for STOP condition	4.0	-	0.6	-	μs
t_{BUF}	Bus free time between a STOP and START condition	4.7	-	1.3	-	μs
C_b	Capacitive load for each bus line	-	400	-	400	pF
V_{nL}	Noise margin at the LOW level for each connected device (Including hysteresis)	0.1VDD	-	0.1VDD	-	V
V_{nH}	Noise margin at the HIGH level for each connected device (Including hysteresis)	0.2VDD	-	0.2VDD	-	V
t_{sp}	Pulse width of spikes which must be suppressed by the input filter	0	50	0	50	ns

Note:

1. All values referred to V_{IHmin} and V_{ILmax} levels (see Table 37)
 2. A device must internally provide a hold time of at least 300 ns for the SDA signal (referred to the V_{IHmin} of the SCL signal) to bridge the undefined region of the falling edge of SCL.
 3. The maximum $t_{HD; DAT}$ has only to be met if the device does not stretch the LOW period (t_{LOW}) of the SCL signal.
 4. A Fast-mode I²C-bus device can be used in a Standard-mode I²C-bus system, but the requirement $t_{SU; DAT} \geq 250$ ns must then be met. This will automatically be the case if the device does not stretch the LOW period of the SCL signal. If such a device does stretch the LOW period of the SCL signal, it must output the next data bit to the SDA line $t_{rmax} + t_{SU; DAT} = 1000 + 250 = 1250$ ns (according to the Standard-mode I²C-bus specification) before the SCL line is released.
 5. C_b = total capacitance of one bus line in pF. If mixed with Hs-mode device, faster fall-times according to Table 39 allowed.
- n/a = not applicable

5 JTAG

This device is compliant with the IEEE 1149.1 Boundary Scan standard except the following:

- The output boundary scan cells do not capture data from the core and the device does not support EXTEST instruction;
- The $\overline{\text{TRST}}$ pin is set low by default and JTAG is disabled in order to be consistent with other manufacturers.

The JTAG interface timing diagram is shown in Figure 18.

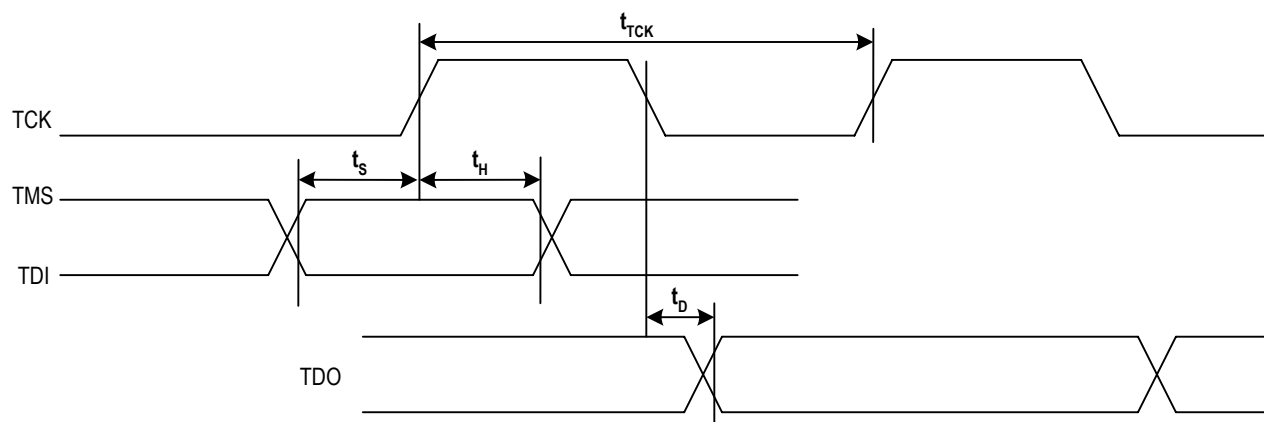


Figure 18. JTAG Interface Timing Diagram

Table 30: JTAG Timing Characteristics

Symbol	Parameter	Min	Typ	Max	Unit
t_{TCK}	TCK period	100			ns
t_s	TMS / TDI to TCK setup time	25			ns
t_H	TCK to TMS / TDI Hold Time	25			ns
t_D	TCK to TDO delay time			50	ns

6 PROGRAMMING INFORMATION

After reset, all the registers are set to their default values. The registers are read or written via the microprocessor interface.

Before any write operation, the value in register PROTECTION_CNFG is recommended to be confirmed to make sure whether the write operation is enabled. The device provides 3 register protection modes:

- Protected mode: no other registers can be written except register PROTECTION_CNFG itself;
- Fully Unprotected mode: all the writable registers can be written;
- Single Unprotected mode: one more register can be written besides register PROTECTION_CNFG. After write operation (not including writing a '1' to clear a bit to '0'), the device automatically switches to Protected mode.

Writing '0' to the registers will take no effect if the registers are cleared by writing '1'.

The access of the Multi-word Registers is different from that of the Single-word Registers. Take the registers (04H, 05H and 06H) for an

example, the write operation for the Multi-word Registers follows a fixed sequence. The register (04H) is configured first and the register (06H) is configured last. The three registers are configured continuously and should not be interrupted by any operation. The crystal calibration configuration will take effect after all the three registers are configured. During read operation, the register (04H) is read first and the register (06H) is read last. The crystal calibration reading should be continuous and not be interrupted by any operation.

Certain bit locations within the device register map are designated as Reserved. To ensure proper and predictable operation, bits designated as Reserved should not be written by the users. In addition, their value should be masked out from any testing or error detection methods that are implemented.

6.1 REGISTER MAP

Table 31 is the map of all the registers, sorted in an ascending order of their addresses.

Table 31: Register List and Map

Address (Hex)	Register Name	Bit 7	Bit 6	Bit 5	Bit 4	Bit 3	Bit 2	Bit 1	Bit 0	Reference Page
Global Control Registers										
00	ID[7:0] - Device ID 1	ID[7:0]								P 51
01	ID[15:8] - Device ID 2	ID[15:8]								P 52
04	NOMINAL_FREQ[7:0]_CNFG - Crystal Oscillator Frequency Offset Calibration Configuration 1	NOMINAL_FREQ_VALUE[7:0]								P 52
05	NOMINAL_FREQ[15:8]_CNFG - Crystal Oscillator Frequency Offset Calibration Configuration 2	NOMINAL_FREQ_VALUE[15:8]								P 52
06	NOMINAL_FREQ[23:16]_CNFG - Crystal Oscillator Frequency Offset Calibration Configuration 3	NOMINAL_FREQ_VALUE[23:16]								P 53
08	PHASE_ALARM_TIME_OUT_CNFG - Phase Lock Alarm Time-Out Configuration	MULTI_FACTOR[1:0]		TIME_OUT_VALUE[5:0]						P 53
09	INPUT_MODE_CNFG - Input Mode Configuration	AUTO_EX T_SYNC_ EN	EXT_SYN C_EN	PH_ALAR M_TIMEO UT	SYNC_FREQ[1:0]		IN_SONET _SDH	-	REVERTIV E_MODE	P 54
0A	DIFFERENTIAL_IN_OUT_OSCI_CNFG - Differential Input / Output Port & Master Clock Configuration	-	-	-	-	-	OSC_EDG E	OUT1_PE CL_LVDS	-	P 55
0B	MON_SW_PBO_CNFG - Frequency Monitor, Input Clock Selection & PBO Control	FREQ_MO N_CLK	LOS_FLA G_TO_TD O	ULTR_FAS T_SW	EXT_SW	PBO_FRE Z	PBO_EN	-	FREQ_MO N_HARD_ EN	P 56
7E	PROTECTION_CNFG - Register Protection Mode Configuration	PROTECTION_DATA[7:0]								P 57
Interrupt Registers										
0C	INTERRUPT_CNFG - Interrupt Configuration	-	-	-	-	-	-	HZ_EN	INT_POL	P 58

Table 31: Register List and Map (Continued)

Address (Hex)	Register Name	Bit 7	Bit 6	Bit 5	Bit 4	Bit 3	Bit 2	Bit 1	Bit 0	Reference Page	
0D	INTERRUPTS1_STS - Interrupt Status 1	-	-	-	-	IN2_CMOS	IN1_CMOS	-	-	P 58	
0E	INTERRUPTS2_STS - Interrupt Status 2	T0_OPERATING_MODE	T0_MAIN_REF_FAILED	-	-	-	-	-	-	P 59	
0F	INTERRUPTS3_STS - Interrupt Status 3	EX_SYNC_ALARM	-	-	-	-	-	-	-	P 59	
10	INTERRUPTS1_ENABLE_CNFG - Interrupt Control 1	-	-	-	-	IN2_CMOS	IN1_CMOS	-	-	P 60	
11	INTERRUPTS2_ENABLE_CNFG - Interrupt Control 2	T0_OPERATING_MODE	T0_MAIN_REF_FAILED	-	-	-	-	-	-	P 60	
12	INTERRUPTS3_ENABLE_CNFG - Interrupt Control 3	EX_SYNC_ALARM	-	-	-	-	-	-	-	P 61	
Input Clock Frequency & Priority Configuration Registers											
16	IN1_CMOS_CNFG - CMOS Input Clock 1 Configuration	DIRECT_DIV	LOCK_8K	BUCKET_SEL[1:0]		IN_FREQ[3:0]				P 62	
17	IN2_CMOS_CNFG - CMOS Input Clock 2 Configuration	DIRECT_DIV	LOCK_8K	BUCKET_SEL[1:0]		IN_FREQ[3:0]				P 63	
23	PRE_DIV_CH_CNFG - DivN Divider Channel Selection	-	-	-	-	PRE_DIV_CH_VALUE[3:0]				P 64	
24	PRE_DIVN[7:0]_CNFG - DivN Divider Division Factor Configuration 1	PRE_DIVN_VALUE[7:0]									P 64
25	PRE_DIVN[14:8]_CNFG - DivN Divider Division Factor Configuration 2	-	PRE_DIVN_VALUE[14:8]								P 65
27	IN1_IN2_CMOS_SEL_PRIORITY_CNFG - CMOS Input Clock 1 & 2 Priority Configuration	IN2_CMOS_SEL_PRIORITY[3:0]				IN1_CMOS_SEL_PRIORITY[3:0]				P 66	
Input Clock Quality Monitoring Configuration & Status Registers											
2E	FREQ_MON_FACTOR_CNFG - Factor of Frequency Monitor Configuration	-	-	-	-	FREQ_MON_FACTOR[3:0]				P 67	
2F	ALL_FREQ_MON_THRESHOLD_CNFG - Frequency Monitor Threshold for All Input Clocks Configuration	-	-	-	-	ALL_FREQ_HARD_THRESHOLD[3:0]				P 67	
31	UPPER_THRESHOLD_0_CNFG - Upper Threshold for Leaky Bucket Configuration 0	UPPER_THRESHOLD_0_DATA[7:0]									P 68
32	LOWER_THRESHOLD_0_CNFG - Lower Threshold for Leaky Bucket Configuration 0	LOWER_THRESHOLD_0_DATA[7:0]									P 68
33	BUCKET_SIZE_0_CNFG - Bucket Size for Leaky Bucket Configuration 0	BUCKET_SIZE_0_DATA[7:0]									P 68
34	DECAY_RATE_0_CNFG - Decay Rate for Leaky Bucket Configuration 0	-	-	-	-	-	-	DECAY_RATE_0_DATA[1:0]		P 69	
35	UPPER_THRESHOLD_1_CNFG - Upper Threshold for Leaky Bucket Configuration 1	UPPER_THRESHOLD_1_DATA[7:0]									P 69
36	LOWER_THRESHOLD_1_CNFG - Lower Threshold for Leaky Bucket Configuration 1	LOWER_THRESHOLD_1_DATA[7:0]									P 69

Table 31: Register List and Map (Continued)

Address (Hex)	Register Name	Bit 7	Bit 6	Bit 5	Bit 4	Bit 3	Bit 2	Bit 1	Bit 0	Reference Page
37	BUCKET_SIZE_1_CNFG - Bucket Size for Leaky Bucket Configuration 1	BUCKET_SIZE_1_DATA[7:0]								P 70
38	DECAY_RATE_1_CNFG - Decay Rate for Leaky Bucket Configuration 1	-	-	-	-	-	-	DECAY_RATE_1_DATA [1:0]		P 70
39	UPPER_THRESHOLD_2_CNFG - Upper Threshold for Leaky Bucket Configuration 2	UPPER_THRESHOLD_2_DATA[7:0]								P 70
3A	LOWER_THRESHOLD_2_CNFG - Lower Threshold for Leaky Bucket Configuration 2	LOWER_THRESHOLD_2_DATA[7:0]								P 71
3B	BUCKET_SIZE_2_CNFG - Bucket Size for Leaky Bucket Configuration 2	BUCKET_SIZE_2_DATA[7:0]								P 71
3C	DECAY_RATE_2_CNFG - Decay Rate for Leaky Bucket Configuration 2	-	-	-	-	-	-	DECAY_RATE_2_DATA [1:0]		P 71
3D	UPPER_THRESHOLD_3_CNFG - Upper Threshold for Leaky Bucket Configuration 3	UPPER_THRESHOLD_3_DATA[7:0]								P 72
3E	LOWER_THRESHOLD_3_CNFG - Lower Threshold for Leaky Bucket Configuration 3	LOWER_THRESHOLD_3_DATA[7:0]								P 72
3F	BUCKET_SIZE_3_CNFG - Bucket Size for Leaky Bucket Configuration 3	BUCKET_SIZE_3_DATA[7:0]								P 72
40	DECAY_RATE_3_CNFG - Decay Rate for Leaky Bucket Configuration 3	-	-	-	-	-	-	DECAY_RATE_3_DATA [1:0]		P 73
41	IN_FREQ_READ_CH_CNFG - Input Clock Frequency Read Channel Selection	-	-	-	-	IN_FREQ_READ_CH[3:0]				P 73
42	IN_FREQ_READ_STS - Input Clock Frequency Read Value	IN_FREQ_VALUE[7:0]								P 73
44	IN1_IN2_CMOS_STS - CMOS Input Clock 1 & 2 Status	-	IN2_CMOS_FREQ_HARD_ALARM	IN2_CMOS_NO_ACTIVITY_ALARM	IN2_CMOS_PH_LOCK_ALARM	-	IN1_CMOS_FREQ_HARD_ALARM	IN1_CMOS_NO_ACTIVITY_ALARM	IN1_CMOS_PH_LOCK_ALARM	P 74
T0 DPLL Input Clock Selection Registers										
4A	INPUT_VALID1_STS - Input Clocks Validity 1	-	-	-	-	IN2_CMOS	IN1_CMOS	-	-	P 75
4E	PRIORITY_TABLE1_STS - Priority Status 1	HIGHEST_PRIORITY_VALIDATED[3:0]				CURRENTLY_SELECTED_INPUT[3:0]				P 75
4F	PRIORITY_TABLE2_STS - Priority Status 2	-	-	-	-	SECOND_HIGHEST_PRIORITY_VALIDATED[3:0]				P 76
50	T0_INPUT_SEL_CNFG - T0 Selected Input Clock Configuration	-	-	-	-	T0_INPUT_SEL[3:0]				P 76
T0 DPLL State Machine Control Registers										
52	OPERATING_STS - DPLL Operating Status	EX_SYNC_ALARM_MON	-	T0_DPLL_SOFT_FREQ_ALARM	-	T0_DPLL_LOCK	T0_DPLL_OPERATING_MODE[2:0]			P 77
53	T0_OPERATING_MODE_CNFG - T0 DPLL Operating Mode Configuration	-	-	-	-	-	T0_OPERATING_MODE[2:0]			P 78

Table 31: Register List and Map (Continued)

Address (Hex)	Register Name	Bit 7	Bit 6	Bit 5	Bit 4	Bit 3	Bit 2	Bit 1	Bit 0	Reference Page
T0 DPLL & T0/T4 APLL Configuration Registers										
55	T0_DPLL_APLL_PATH_CNFG - T0 DPLL & APLL Path Configuration	T0_APLL_PATH[3:0]				T0_GSM_OBSAI_16E1_16T1_SEL[1:0]		T0_12E1_24T1_E3_T3_SEL[1:0]		P 79
56	T0_DPLL_START_BW_DAMPING_CNFG - T0 DPLL Start Bandwidth & Damping Factor Configuration	T0_DPLL_START_DAMPING[2:0]			T0_DPLL_START_BW[4:0]					P 80
57	T0_DPLL_ACQ_BW_DAMPING_CNFG - T0 DPLL Acquisition Bandwidth & Damping Factor Configuration	T0_DPLL_ACQ_DAMPING[2:0]			T0_DPLL_ACQ_BW[4:0]					P 81
58	T0_DPLL_LOCKED_BW_DAMPING_CNFG - T0 DPLL Locked Bandwidth & Damping Factor Configuration	T0_DPLL_LOCKED_DAMPING[2:0]			T0_DPLL_LOCKED_BW[4:0]					P 82
59	T0_BW_OVERSHOOT_CNFG - T0 DPLL Bandwidth Overshoot Configuration	AUTO_BW_SEL	-	-	-	T0_LIMT	-	-	-	P 82
5A	PHASE_LOSS_COARSE_LIMIT_CNFG - Phase Loss Coarse Detector Limit Configuration	COARSE_PH_LOS_LIMT_EN	WIDE_EN	MULTI_PH_APP	MULTI_PH_8K_4K_2K_EN	PH_LOS_COARSE_LIMT[3:0]				P 83
5B	PHASE_LOSS_FINE_LIMIT_CNFG - Phase Loss Fine Detector Limit Configuration	FINE_PH_LOS_LIMT_EN	FAST_LOS_SW	-	-	-	PH_LOS_FINE_LIMT[2:0]			P 84
5C	T0_HOLDOVER_MODE_CNFG - T0 DPLL Holdover Mode Configuration	MAN_HOLDOVER	AUTO_AVG	FAST_AVG	READ_AVG	TEMP_HOLDOVER_MODE[1:0]		-	-	P 85
5D	T0_HOLDOVER_FREQ[7:0]_CNFG - T0 DPLL Holdover Frequency Configuration 1	T0_HOLDOVER_FREQ[7:0]								P 85
5E	T0_HOLDOVER_FREQ[15:8]_CNFG - T0 DPLL Holdover Frequency Configuration 2	T0_HOLDOVER_FREQ[15:8]								P 86
5F	T0_HOLDOVER_FREQ[23:16]_CNFG - T0 DPLL Holdover Frequency Configuration 3	T0_HOLDOVER_FREQ[23:16]								P 86
60	T4_APLL_PATH_CNFG - T4 APLL Path Configuration	T4_APLL_PATH[3:0]				-		-		P 86
62	CURRENT_DPLL_FREQ[7:0]_STS - DPLL Current Frequency Status 1	CURRENT_DPLL_FREQ[7:0]								P 87
63	CURRENT_DPLL_FREQ[15:8]_STS - DPLL Current Frequency Status 2	CURRENT_DPLL_FREQ[15:8]								P 87
64	CURRENT_DPLL_FREQ[23:16]_STS - DPLL Current Frequency Status 3	CURRENT_DPLL_FREQ[23:16]								P 87
65	DPLL_FREQ_SOFT_LIMIT_CNFG - DPLL Soft Limit Configuration	FREQ_LIMT_PH_LOS	DPLL_FREQ_SOFT_LIMT[6:0]							P 88
66	DPLL_FREQ_HARD_LIMIT[7:0]_CNFG - DPLL Hard Limit Configuration 1	DPLL_FREQ_HARD_LIMT[7:0]								P 88
67	DPLL_FREQ_HARD_LIMIT[15:8]_CNFG - DPLL Hard Limit Configuration 2	DPLL_FREQ_HARD_LIMT[15:8]								P 88
68	CURRENT_DPLL_PHASE[7:0]_STS - DPLL Current Phase Status 1	CURRENT_PH_DATA[7:0]								P 89
69	CURRENT_DPLL_PHASE[15:8]_STS - DPLL Current Phase Status 2	CURRENT_PH_DATA[15:8]								P 89

Table 31: Register List and Map (Continued)

Address (Hex)	Register Name	Bit 7	Bit 6	Bit 5	Bit 4	Bit 3	Bit 2	Bit 1	Bit 0	Reference Page
6A	T0_T4_APLL_BW_CNFG - T0 / T4 APLL Bandwidth Configuration	-	-	T0_APLL_BW[1:0]		-	-	T4_APLL_BW[1:0]		P 89
Output Configuration Registers										
6D	OUT2_FREQ_CNFG - Output Clock 2 Frequency Configuration	OUT2_PATH_SEL[3:0]				OUT2_DIVIDER[3:0]				P 90
71	OUT1_FREQ_CNFG - Output Clock 1 Frequency Configuration	OUT1_PATH_SEL[3:0]				OUT1_DIVIDER[3:0]				P 90
72	OUT1_INV_CNFG - Output Clock 1 Invert Configuration	-	-	-	-	-	-	OUT1_INV	-	P 91
73	OUT2_INV_CNFG - Output Clock 2 Invert Configuration	-	-	-	-	-	OUT2_INV	-	-	P 91
74	FR_SYNC_CNFG - Frame Sync Output Configuration	IN_2K_4K_8K_INV	8K_EN	-	8K_PUL_POSITION	8K_INV	8K_PUL	-	-	P 92
PBO & Phase Offset Control Registers										
78	PHASE_MON_PBO_CNFG - Phase Transient Monitor & PBO Configuration	IN_NOISE_WINDOW	-	PH_MON_EN	PH_MON_PBO_EN	PH_TR_MON_LIMT[3:0]				P 93
Synchronization Configuration Registers										
7C	SYNC_MONITOR_CNFG - Sync Monitor Configuration	SYNC_BY_PASS	SYNC_MON_LIMT[2:0]			-	-	-	-	P 94
7D	SYNC_PHASE_CNFG - Sync Phase Configuration	-	-	-		SYNC_PH2[1:0]		SYNC_PH1[1:0]		P 94

6.2 REGISTER DESCRIPTION

6.2.1 GLOBAL CONTROL REGISTERS

ID[7:0] - Device ID 1

Address: 00H Type: Read Default Value: 10001000							
7	6	5	4	3	2	1	0
ID7	ID6	ID5	ID4	ID3	ID2	ID1	ID0
Bit	Name	Description					
7 - 0	ID[7:0]	Refer to the description of the ID[15:8] bits (b7~0, 01H).					

ID[15:8] - Device ID 2

Address: 01H

Type: Read

Default Value: 00010001

7	6	5	4	3	2	1	0
ID15	ID14	ID13	ID12	ID11	ID10	ID9	ID8

Bit	Name	Description
7 - 0	ID[15:8]	The value in the ID[15:0] bits are pre-set, representing the identification number for the IDT82V3202.

NOMINAL_FREQ[7:0]_CNFG - Crystal Oscillator Frequency Offset Calibration Configuration 1

Address: 04H

Type: Read / Write

Default Value: 00000000

7	6	5	4	3	2	1	0
NOMINAL_FREQ_VALUE7	NOMINAL_FREQ_VALUE6	NOMINAL_FREQ_VALUE5	NOMINAL_FREQ_VALUE4	NOMINAL_FREQ_VALUE3	NOMINAL_FREQ_VALUE2	NOMINAL_FREQ_VALUE1	NOMINAL_FREQ_VALUE0

Bit	Name	Description
7 - 0	NOMINAL_FREQ_VALUE[7:0]	Refer to the description of the NOMINAL_FREQ_VALUE[23:16] bits (b7~0, 06H).

NOMINAL_FREQ[15:8]_CNFG - Crystal Oscillator Frequency Offset Calibration Configuration 2

Address: 05H

Type: Read / Write

Default Value: 00000000

7	6	5	4	3	2	1	0
NOMINAL_FREQ_VALUE15	NOMINAL_FREQ_VALUE14	NOMINAL_FREQ_VALUE13	NOMINAL_FREQ_VALUE12	NOMINAL_FREQ_VALUE11	NOMINAL_FREQ_VALUE10	NOMINAL_FREQ_VALUE9	NOMINAL_FREQ_VALUE8

Bit	Name	Description
7 - 0	NOMINAL_FREQ_VALUE[15:8]	Refer to the description of the NOMINAL_FREQ_VALUE[23:16] bits (b7~0, 06H).

NOMINAL_FREQ[23:16]_CNFG - Crystal Oscillator Frequency Offset Calibration Configuration 3

Address: 06H

Type: Read / Write

Default Value: 00000000

7	6	5	4	3	2	1	0
NOMINAL_FREQ_VALUE23	NOMINAL_FREQ_VALUE22	NOMINAL_FREQ_VALUE21	NOMINAL_FREQ_VALUE20	NOMINAL_FREQ_VALUE19	NOMINAL_FREQ_VALUE18	NOMINAL_FREQ_VALUE17	NOMINAL_FREQ_VALUE16

Bit	Name	Description
7 - 0	NOMINAL_FREQ_VALUE[23:16]	The NOMINAL_FREQ_VALUE[23:0] bits represent a 2's complement signed integer. If the value is multiplied by 0.0000884, the calibration value for the master clock in ppm will be gotten. For example, the frequency offset on OSCI is +3 ppm. Though -3 ppm should be compensated, the calibration value is calculated as +3 ppm: $3 \div 0.0000884 = 33937 \text{ (Dec.)} = 8490 \text{ (Hex);}$ So '008490' should be written into these bits. The calibration range is within ± 741 ppm.

PHASE_ALARM_TIME_OUT_CNFG - Phase Lock Alarm Time-Out Configuration

Address: 08H

Type: Read / Write

Default Value: 00110010

7	6	5	4	3	2	1	0
MULTI_FACTOR1	MULTI_FACTOR0	TIME_OUT_VALUE5	TIME_OUT_VALUE4	TIME_OUT_VALUE3	TIME_OUT_VALUE2	TIME_OUT_VALUE1	TIME_OUT_VALUE0

Bit	Name	Description
7 - 6	MULTI_FACTOR[1:0]	These bits determine a factor which has a relationship with a period in seconds. A phase lock alarm will be raised if the T0 selected input clock is not locked in T0 DPLL within this period. If the PH_ALARM_TIMEOUT bit (b5, 09H) is '1', the phase lock alarm will be cleared after this period (starting from when the alarm is raised). Refer to the description of the TIME_OUT_VALUE[5:0] bits (b5~0, 08H). 00: 2 (default) 01: 4 10: 8 11: 16
5 - 0	TIME_OUT_VALUE[5:0]	These bits represent an unsigned integer. If the value in these bits is multiplied by the value in the MULTI_FACTOR[1:0] bits (b7~6, 08H), a period in seconds will be gotten. A phase lock alarm will be raised if the T0 selected input clock is not locked in T0 DPLL within this period. If the PH_ALARM_TIMEOUT bit (b5, 09H) is '1', the phase lock alarm will be cleared after this period (starting from when the alarm is raised).

INPUT_MODE_CNFG - Input Mode Configuration

Address: 09H
 Type: Read / Write
 Default Value: 10100X10

7	6	5	4	3	2	1	0
AUTO_EXT_SYNC_EN	EXT_SYNC_EN	PH_ALARM_TIMEOUT	SYNC_FREQ1	SYNC_FREQ0	IN_SONET_SDH	-	REVERTIVE_MODE

Bit	Name	Description												
7	AUTO_EXT_SYNC_EN	This bit is valid only when the SYNC_BYPASS bit (b7, 7CH) is '0'. Refer to the description of the EXT_SYNC_EN bit (b6, 09H).												
6	EXT_SYNC_EN	This bit is valid only when the SYNC_BYPASS bit (b7, 7CH) is '0'. This bit, together with the AUTO_EXT_SYNC_EN bit (b7, 09H), determines whether the selected frame sync input signal is enabled to synchronize the frame sync output signals. <table> <tr> <th>AUTO_EXT_SYNC_EN</th><th>EXT_SYNC_EN</th><th>Synchronization</th></tr> <tr> <td>don't-care</td><td>0</td><td>Disabled (default)</td></tr> <tr> <td>0</td><td>1</td><td>Enabled</td></tr> <tr> <td>1</td><td>1</td><td>Disabled</td></tr> </table>	AUTO_EXT_SYNC_EN	EXT_SYNC_EN	Synchronization	don't-care	0	Disabled (default)	0	1	Enabled	1	1	Disabled
AUTO_EXT_SYNC_EN	EXT_SYNC_EN	Synchronization												
don't-care	0	Disabled (default)												
0	1	Enabled												
1	1	Disabled												
5	PH_ALARM_TIMEOUT	This bit determines how to clear the phase lock alarm. 0: The phase lock alarm will be cleared when a '1' is written to the corresponding INn_CMOS_PH_LOCK_ALARM bit (n = 1 or 2) (b4/0, 44H). 1: The phase lock alarm will be cleared after a period (= $TIME_OUT_VALUE[5:0]$ (b5~0, 08H) X $MULTI_FACTOR[1:0]$ (b7~6, 08H) in second) which starts from when the alarm is raised. (default)												
4 - 3	SYNC_FREQ[1:0]	These bits set the frequency of the frame sync signals input on the EX_SYNC1 ~ EX_SYNC2 pins. 00: 8 kHz (default) 01: 8 kHz. 10: 4 kHz. 11: 2 kHz.												
2	IN_SONET_SDH	This bit selects the SDH or SONET network type. 0: SDH. The DPLL required clock is 2.048 MHz when the IN_FREQ[3:0] bits (b3~0, 16H, 17H) are '0001' and the T0 DPLL output from the 16E1/16T1 path is 16E1. 1: SONET. The DPLL required clock is 1.544 MHz when the IN_FREQ[3:0] bits (b3~0, 16H, 17H) are '0001' and the T0 DPLL output from the 16E1/16T1 path is 16T1. The default value of this bit is determined by the SONET/SDH pin during reset.												
1	-	Reserved.												
0	REVERTIVE_MODE	This bit selects Revertive or Non-Revertive switch. 0: Non-Revertive switch. (default) 1: Revertive switch.												

DIFFERENTIAL_IN_OUT_OSCI_CNFG - Differential Input / Output Port & Master Clock Configuration

Address: 0AH

Type: Read / Write

Default Value: XXXXX00X

7	6	5	4	3	2	1	0
-	-	-	-	-	OSC_EDGE	OUT1_PECL_LVDS	-

Bit	Name	Description
7 - 3	-	Reserved.
2	OSC_EDGE	This bit selects a better active edge of the master clock. 0: The rising edge. (default) 1: The falling edge.
1	OUT1_PECL_LVDS	This bit selects a port technology for OUT1. 0: LVDS. (default) 1: PECL.
0	-	Reserved

MON_SW_PBO_CNFG - Frequency Monitor, Input Clock Selection & PBO Control

Address: 0BH

Type: Read / Write

Default Value: 100X01X1

7	6	5	4	3	2	1	0
FREQ_MON_CLK	LOS_FLAG_TO_TDO	ULTR_FAST_SW	EXT_SW	PBO_FREZ	PBO_EN	-	FREQ_MON_HARD_EN

Bit	Name	Description
7	FREQ_MON_CLK	The bit selects a reference clock for input clock frequency monitoring. 0: The output of T0 DPLL. 1: The master clock. (default)
6	LOS_FLAG_TO_TDO	The bit determines whether the interrupt of T0 selected input clock fail - is reported by the TDO pin. 0: Not reported. TDO pin is used as JTAG test data output which complies with IEEE 1149.1. (default) 1: Reported. TDO pin mimics the state of the T0_MAIN_REF_FAILED bit (b6, 0EH) and does not strictly comply with IEEE 1149.1.
5	ULTR_FAST_SW	This bit determines whether the T0 selected input clock is valid when missing 2 consecutive clock cycles or more. 0: Valid. (default) 1: Invalid.
4	EXT_SW	This bit determines the T0 input clock selection. 0: Forced selection or Automatic selection, as controlled by the T0_INPUT_SEL[3:0] bits (b3~0, 50H). 1: External Fast selection. The default value of this bit is determined by the FF_SRCSW pin during reset.
3	PBO_FREZ	This bit is valid only when the PBO is enabled by the PBO_EN bit (b2, 0BH). It determines whether PBO is frozen at the current phase offset when a PBO event is triggered. 0: Not frozen. (default) 1: Frozen. Further PBO events are ignored and the current phase offset is maintained.
2	PBO_EN	This bit determines whether PBO is enabled when the T0 selected input clock switch or the T0 DPLL exiting from Holdover mode or Free-Run mode occurs. 0: Disabled. 1: Enabled. (default)
1	-	Reserved.
0	FREQ_MON_HARD_EN	This bit determines whether the frequency hard alarm is enabled when the frequency of the input clock with respect to the reference clock is above the frequency hard alarm threshold. The reference clock can be the output of T0 DPLL or the master clock, as determined by the FREQ_MON_CLK bit (b7, 0BH). 0: Disabled. 1: Enabled. (default)

PROTECTION_CNFG - Register Protection Mode Configuration

Address: 7EH
 Type: Read / Write
 Default Value: 10000101

7		6		5		4		3		2		1		0	
PROTECTION_ DATA7		PROTECTION_ DATA6		PROTECTION_ DATA5		PROTECTION_ DATA4		PROTECTION_ DATA3		PROTECTION_ DATA2		PROTECTION_ DATA1		PROTECTION_ DATA0	
Bit	Name		Description												
7 - 0	PROTECTION_DATA[7:0]		These bits select a register write protection mode. 00000000 - 10000100, 10000111 - 11111111: Protected mode. No other registers can be written except this register. 10000101: Fully Unprotected mode. All the writable registers can be written. (default) 10000110: Single Unprotected mode. One more register can be written besides this register. After write operation (not including writing a '1' to clear the bit to '0'), the device automatically switches to Protected mode.												

6.2.2 INTERRUPT REGISTERS

INTERRUPT_CNFG - Interrupt Configuration

Address: 0CH							
Type: Read / Write							
Default Value: XXXXXX10							
7	6	5	4	3	2	1	0
-	-	-	-	-	-	HZ_EN	INT_POL
Bit	Name	Description					
7 - 2	-	Reserved.					
1	HZ_EN	This bit determines the output characteristics of the INT_REQ pin. 0: The output on the INT_REQ pin is high/low when the interrupt is active; the output is the opposite when the interrupt is inactive. 1: The output on the INT_REQ pin is high/low when the interrupt is active; the output is in high impedance state when the interrupt is inactive. (default)					
0	INT_POL	This bit determines the active level on the INT_REQ pin for an active interrupt indication. 0: Active low. (default) 1: Active high.					

INTERRUPTS1_STS - Interrupt Status 1

Address: 0DH							
Type: Read / Write							
Default Value: XXXX11XX							
7	6	5	4	3	2	1	0
-	-	-	-	IN2_CMOS	IN1_CMOS	-	-
Bit	Name	Description					
7 - 4	-	Reserved.					
3 - 2	INn_CMOS	This bit indicates the validity changes (from 'valid' to 'invalid' or from 'invalid' to 'valid') for the corresponding INn_CMOS; i.e., whether there is a transition (from '0' to '1' or from '1' to '0') on the corresponding INn_CMOS bit (b3/2, 4AH). Here n is 2 or 1. 0: Has not changed. 1: Has changed. (default) This bit is cleared by writing a '1'.					
1 - 0	-	Reserved.					

INTERRUPTS2_STS - Interrupt Status 2

Address: 0EH

Type: Read / Write

Default Value: 00XXXXXX

7	6	5	4	3	2	1	0
T0_OPERATING_MODE	T0_MAIN_REF_FAILED	-	-	-	-	-	-

Bit	Name	Description
7	T0_OPERATING_MODE	This bit indicates the operating mode switch for T0 DPLL; i.e., whether the value in the T0_DPLL_OPERATING_MODE[2:0] bits (b2~0, 52H) changes. 0: Has not switched. (default) 1: Has switched. This bit is cleared by writing a '1'.
6	T0_MAIN_REF_FAILED	This bit indicates whether the T0 selected input clock has failed. The T0 selected input clock fails when its validity changes from 'valid' to 'invalid'; i.e., when there is a transition from '1' to '0' on the corresponding INN_CMOS bit (4AH). 0: Has not failed. (default) 1: Has failed. This bit is cleared by writing a '1'.
5 - 0	-	Reserved.

INTERRUPTS3_STS - Interrupt Status 3

Address: 0FH

Type: Read / Write

Default Value: 1XXXXXXX

7	6	5	4	3	2	1	0
EX_SYNC_ALARM	-	-	-	-	-	-	-

Bit	Name	Description
7	EX_SYNC_ALARM	This bit indicates whether an external sync alarm is raised; i.e., whether there is a transition from '0' to '1' on the EX_SYNC_ALARM_MON bit (b7, 52H). 0: Has not occurred. 1: Has occurred. (default) This bit is cleared by writing a '1'.
6 - 0	-	Reserved.

INTERRUPTS1_ENABLE_CNFG - Interrupt Control 1

Address: 10H

Type: Read / Write

Default Value: XXXX00XX

7	6	5	4	3	2	1	0
-	-	-	-	IN2_CMOS	IN1_CMOS	-	-

Bit	Name	Description
7 - 4	-	Reserved.
3 - 2	INn_CMOS	This bit controls whether the interrupt is enabled to be reported on the INT_REQ pin when the input clock validity changes (from 'valid' to 'invalid' or from 'invalid' to 'valid'), i.e., when the corresponding INn_CMOS bit (b3/2, 0DH) is '1'. Here n is 2 or 1. 0: Disabled. (default) 1: Enabled.
1 - 0	-	Reserved.

INTERRUPTS2_ENABLE_CNFG - Interrupt Control 2

Address: 11H

Type: Read / Write

Default Value: 00XXXXXX

7	6	5	4	3	2	1	0
T0_OPERATING_MODE	T0_MAIN_REF_FAILED	-	-	-	-	-	-

Bit	Name	Description
7	T0_OPERATING_MODE	This bit controls whether the interrupt is enabled to be reported on the INT_REQ pin when the T0 DPLL operating mode switches, i.e., when the T0_OPERATING_MODE bit (b7, 0EH) is '1'. 0: Disabled. (default) 1: Enabled.
6	T0_MAIN_REF_FAILED	This bit controls whether the interrupt is enabled to be reported on the INT_REQ pin when the T0 selected input clock has failed; i.e., when the T0_MAIN_REF_FAILED bit (b6, 0EH) is '1'. 0: Disabled. (default) 1: Enabled.
5 - 0	-	Reserved.

INTERRUPTS3_ENABLE_CNFG - Interrupt Control 3

Address: 12H

Type: Read / Write

Default Value: 0XXXXXXX

7	6	5	4	3	2	1	0
EX_SYNC_ALARM	-	-	-	-	-	-	-

Bit	Name	Description
7	EX_SYNC_ALARM	This bit controls whether the interrupt is enabled to be reported on the INT_REQ pin when an external sync alarm has occurred, i.e., when the EX_SYNC_ALARM bit (b7, 0FH) is '1'. 0: Disabled. (default) 1: Enabled.
6 - 0	-	Reserved.

6.2.3 INPUT CLOCK FREQUENCY & PRIORITY CONFIGURATION REGISTERS

IN1_CMOS_CNFG - CMOS Input Clock 1 Configuration

Address: 16H Type: Read / Write Default Value: 00000000																						
7	6	5	4	3	2	1	0															
DIRECT_DIV	LOCK_8K	BUCKET_SEL1	BUCKET_SEL0	IN_FREQ3	IN_FREQ2	IN_FREQ1	IN_FREQ0															
Bit	Name	Description																				
7	DIRECT_DIV	Refer to the description of the LOCK_8K bit (b6, 16H).																				
6	LOCK_8K	This bit, together with the DIRECT_DIV bit (b7, 16H), determines whether the DivN Divider or the Lock 8k Divider is used for IN1_CMOS: <table><tr><th>DIRECT_DIV bit</th><th>LOCK_8K bit</th><th>Used Divider</th></tr><tr><td>0</td><td>0</td><td>Both bypassed (default)</td></tr><tr><td>0</td><td>1</td><td>Lock 8k Divider</td></tr><tr><td>1</td><td>0</td><td>DivN Divider</td></tr><tr><td>1</td><td>1</td><td>Reserved</td></tr></table>						DIRECT_DIV bit	LOCK_8K bit	Used Divider	0	0	Both bypassed (default)	0	1	Lock 8k Divider	1	0	DivN Divider	1	1	Reserved
DIRECT_DIV bit	LOCK_8K bit	Used Divider																				
0	0	Both bypassed (default)																				
0	1	Lock 8k Divider																				
1	0	DivN Divider																				
1	1	Reserved																				
5 - 4	BUCKET_SEL[1:0]	These bits select one of the four groups of leaky bucket configuration registers for IN1_CMOS: 00: Group 0; the addresses of the configuration registers are 31H ~ 34H. (default) 01: Group 1; the addresses of the configuration registers are 35H ~ 38H. 10: Group 2; the addresses of the configuration registers are 39H ~ 3CH. 11: Group 3; the addresses of the configuration registers are 3DH ~ 40H.																				
3 - 0	IN_FREQ[3:0]	These bits set the DPLL required frequency for IN1_CMOS: 0000: 8 kHz. (default) 0001: 1.544 MHz (when the IN_SONET_SDH bit (b2, 09H) is '1') / 2.048 MHz (when the IN_SONET_SDH bit (b2, 09H) is '0'). 0010: 6.48 MHz. 0011: 19.44 MHz. 0100: 25.92 MHz. 0101: 38.88 MHz. 0110 ~ 1000: Reserved. 1001: 2 kHz. 1010: 4 kHz. 1011 ~ 1111: Reserved. For IN1_CMOS, the required frequency should not be set higher than that of the input clock.																				

IN2_CMOS_CNFG - CMOS Input Clock 2 Configuration

Address: 17H
 Type: Read / Write
 Default Value: 00000000

7	6	5	4	3	2	1	0
DIRECT_DIV	LOCK_8K	BUCKET_SEL1	BUCKET_SEL0	IN_FREQ3	IN_FREQ2	IN_FREQ1	IN_FREQ0

Bit	Name	Description															
7	DIRECT_DIV	Refer to the description of the LOCK_8K bit (b6, 17H).															
6	LOCK_8K	This bit, together with the DIRECT_DIV bit (b7, 17H), determines whether the DivN Divider or the Lock 8k Divider is used for IN2_CMOS: <table> <tr> <th>DIRECT_DIV bit</th><th>LOCK_8K bit</th><th>Used Divider</th></tr> <tr> <td>0</td><td>0</td><td>Both bypassed (default)</td></tr> <tr> <td>0</td><td>1</td><td>Lock 8k Divider</td></tr> <tr> <td>1</td><td>0</td><td>DivN Divider</td></tr> <tr> <td>1</td><td>1</td><td>Reserved</td></tr> </table>	DIRECT_DIV bit	LOCK_8K bit	Used Divider	0	0	Both bypassed (default)	0	1	Lock 8k Divider	1	0	DivN Divider	1	1	Reserved
DIRECT_DIV bit	LOCK_8K bit	Used Divider															
0	0	Both bypassed (default)															
0	1	Lock 8k Divider															
1	0	DivN Divider															
1	1	Reserved															
5 - 4	BUCKET_SEL[1:0]	These bits select one of the four groups of leaky bucket configuration registers for IN2_CMOS: 00: Group 0; the addresses of the configuration registers are 31H ~ 34H. (default) 01: Group 1; the addresses of the configuration registers are 35H ~ 38H. 10: Group 2; the addresses of the configuration registers are 39H ~ 3CH. 11: Group 3; the addresses of the configuration registers are 3DH ~ 40H.															
3 - 0	IN_FREQ[3:0]	These bits set the DPLL required frequency for IN2_CMOS: 0000: 8 kHz. (default) 0001: 1.544 MHz (when the IN_SONET_SDH bit (b2, 09H) is '1') / 2.048 MHz (when the IN_SONET_SDH bit (b2, 09H) is '0'). 0010: 6.48 MHz. 0011: 19.44 MHz. 0100: 25.92 MHz. 0101: 38.88 MHz. 0110 ~ 1000: Reserved. 1001: 2 kHz. 1010: 4 kHz. 1011 ~ 1111: Reserved. For the IN2_CMOS, the required frequency should not be set higher than that of the input clock.															

PRE_DIV_CH_CNFG - DivN Divider Channel Selection

Address: 23H

Type: Read / Write

Default Value: XXXX0000

7	6	5	4	3	2	1	0
-	-	-	-	PRE_DIV_CH_VALUE3	PRE_DIV_CH_VALUE2	PRE_DIV_CH_VALUE1	PRE_DIV_CH_VALUE0

Bit	Name	Description
7 - 4	-	Reserved.
3 - 0	PRE_DIV_CH_VALUE[3:0]	This register is an indirect address register for Register 24H and 25H. These bits select an input clock. The value set in the PRE_DIVN_VALUE[14:0] bits (25H, 24H) is available for the selected input clock. 0000: Reserved. (default) 0001, 0010: Reserved. 0011: IN1_CMOS. 0100: IN2_CMOS. 0101 ~ 1111: Reserved.

PRE_DIVN[7:0]_CNFG - DivN Divider Division Factor Configuration 1

Address: 24H

Type: Read / Write

Default Value: 00000000

7	6	5	4	3	2	1	0
PRE_DIVN_VA LUE7	PRE_DIVN_VA LUE6	PRE_DIVN_VA LUE5	PRE_DIVN_VA LUE4	PRE_DIVN_VA LUE3	PRE_DIVN_VA LUE2	PRE_DIVN_VA LUE1	PRE_DIVN_VA LUE0

Bit	Name	Description
7 - 0	PRE_DIVN_VALUE[7:0]	Refer to the description of the PRE_DIVN_VALUE[14:8] bits (b6~0, 25H).

PRE_DIVN[14:8]_CNFG - DivN Divider Division Factor Configuration 2

Address: 25H

Type: Read / Write

Default Value: X0000000

7	6	5	4	3	2	1	0
-	PRE_DIVN_VAL UE14	PRE_DIVN_VAL UE13	PRE_DIVN_VAL UE12	PRE_DIVN_VAL UE11	PRE_DIVN_VAL UE10	PRE_DIVN_VAL UE9	PRE_DIVN_VAL UE8

Bit	Name	Description
7	-	Reserved.
6 - 0	PRE_DIVN_VALUE[14:8]	If the value in the PRE_DIVN_VALUE[14:0] bits is plus 1, the division factor for an input clock will be gotten. The input clock is selected by the PRE_DIV_CH_VALUE[3:0] bits (b3~0, 23H). A value from '0' to '4BEF' (Hex) can be written into, corresponding to a division factor from 1 to 19440. The others are reserved. So the DivN Divider only supports an input clock whose frequency is lower than (<) 155.52 MHz. The division factor setting should observe the following order: 1. Write the lower eight bits of the division factor to the PRE_DIVN_VALUE[7:0] bits; 2. Write the higher eight bits of the division factor to the PRE_DIVN_VALUE[14:8] bits.

IN1_IN2_CMOS_SEL_PRIORITY_CNFG - CMOS Input Clock 1 & 2 Priority Configuration

Address: 27H

Type: Read / Write

Default Value: 00110010

7	6	5	4	3	2	1	0
IN2_CMOS_SE L_PRIORITY3	IN2_CMOS_SE L_PRIORITY2	IN2_CMOS_SE L_PRIORITY1	IN2_CMOS_SE L_PRIORITY0	IN1_CMOS_SE L_PRIORITY3	IN1_CMOS_SE L_PRIORITY2	IN1_CMOS_SE L_PRIORITY1	IN1_CMOS_SE L_PRIORITY0
Bit	Name	Description					
7 - 4	IN2_CMOS_SEL_PRIORITY[3:0]	These bits set the priority of the corresponding IN2_CMOS. 0000: Disable IN2_CMOS for automatic selection. 0001: Priority 1. 0010: Priority 2. 0011: Priority 3. (default) 0100: Priority 4. 0101: Priority 5. 0110: Priority 6. 0111: Priority 7. 1000: Priority 8. 1001: Priority 9. 1010: Priority 10. 1011: Priority 11. 1100: Priority 12. 1101: Priority 13. 1110: Priority 14. 1111: Priority 15.					
3 - 0	IN1_CMOS_SEL_PRIORITY[3:0]	These bits set the priority of the corresponding IN1_CMOS. 0000: Disable IN1_CMOS for automatic selection. 0001: Priority 1. 0010: Priority 2. (default) 0011: Priority 3. 0100: Priority 4. 0101: Priority 5. 0110: Priority 6. 0111: Priority 7. 1000: Priority 8. 1001: Priority 9. 1010: Priority 10. 1011: Priority 11. 1100: Priority 12. 1101: Priority 13. 1110: Priority 14. 1111: Priority 15.					

6.2.4 INPUT CLOCK QUALITY MONITORING CONFIGURATION & STATUS REGISTERS

FREQ_MON_FACTOR_CNFG - Factor of Frequency Monitor Configuration

Address: 2EH

Type: Read / Write

Default Value: XXXX1011

7	6	5	4	3	2	1	0
-	-	-	-	FREQ_MON_F ACTOR3	FREQ_MON_F ACTOR2	FREQ_MON_F ACTOR1	FREQ_MON_F ACTOR0

Bit	Name	Description
7 - 4	-	Reserved.
3 - 0	FREQ_MON_FACTOR[3:0]	These bits determine a factor. The factor has a relationship with the frequency hard alarm threshold in ppm (refer to the description of the ALL_FREQ_HARD_THRESHOLD[3:0] bits (b3~0, 2FH)) and with the frequency of the input clock with respect to the master clock in ppm (refer to the description of the IN_FREQ_VALUE[7:0] bits (b7~0, 42H)). The factor represents the accuracy of the frequency monitor and should be set according to the requirements of different applications. 0000: 0.0032. 0001: 0.0064. 0010: 0.0127. 0011: 0.0257. 0100: 0.0514. 0101: 0.103. 0110: 0.206. 0111: 0.412. 1000: 0.823. 1001: 1.646. 1010: 3.292. 1011: 3.81. (default) 1100 - 1111: 4.6.

ALL_FREQ_MON_THRESHOLD_CNFG - Frequency Monitor Threshold for All Input Clocks Configuration

Address: 2FH

Type: Read / Write

Default Value: XXXX0011

7	6	5	4	3	2	1	0
-	-	-	-	ALL_FREQ_HARD_THRESHOLD3	ALL_FREQ_HARD_THRESHOLD2	ALL_FREQ_HARD_THRESHOLD1	ALL_FREQ_HARD_THRESHOLD0

Bit	Name	Description
7 - 4	-	Reserved.
3 - 0	ALL_FREQ_HARD_THRESHOLD[3:0]	These bits represent an unsigned integer. The frequency hard alarm threshold in ppm can be calculated as follows: <i>Frequency Hard Alarm Threshold (ppm) = (ALL_FREQ_HARD_THRESHOLD[3:0] + 1) X FREQ_MON_FACTOR[3:0] (b3~0, 2EH)</i> This threshold is symmetrical about zero.

UPPER_THRESHOLD_0_CNFG - Upper Threshold for Leaky Bucket Configuration 0

Address: 31H Type: Read / Write Default Value: 00000110							
7	6	5	4	3	2	1	0
UPPER_THRE SHOLD_0_DAT A7	UPPER_THRE SHOLD_0_DAT A6	UPPER_THRE SHOLD_0_DAT A5	UPPER_THRE SHOLD_0_DAT A4	UPPER_THRE SHOLD_0_DAT A3	UPPER_THRE SHOLD_0_DAT A2	UPPER_THRE SHOLD_0_DAT A1	UPPER_THRE SHOLD_0_DAT A0
Bit	Name	Description					
7 - 0	UPPER_THRESHOLD_0_DATA[7:0]	These bits set an upper threshold for the internal leaky bucket accumulator. When the number of the accumulated events is above this threshold, a no-activity alarm is raised.					

LOWER_THRESHOLD_0_CNFG - Lower Threshold for Leaky Bucket Configuration 0

Address: 32H Type: Read / Write Default Value: 00000100							
7	6	5	4	3	2	1	0
LOWER_THRE SHOLD_0_DAT A7	LOWER_THRE SHOLD_0_DAT A6	LOWER_THRE SHOLD_0_DAT A5	LOWER_THRE SHOLD_0_DAT A4	LOWER_THRE SHOLD_0_DAT A3	LOWER_THRE SHOLD_0_DAT A2	LOWER_THRE SHOLD_0_DAT A1	LOWER_THRE SHOLD_0_DAT A0
Bit	Name	Description					
7 - 0	LOWER_THRESHOLD_0_DATA[7:0]	These bits set a lower threshold for the internal leaky bucket accumulator. When the number of the accumulated events is below this threshold, the no-activity alarm is cleared.					

BUCKET_SIZE_0_CNFG - Bucket Size for Leaky Bucket Configuration 0

Address: 33H Type: Read / Write Default Value: 00001000							
7	6	5	4	3	2	1	0
BUCKET_SIZE _0_DATA7	BUCKET_SIZE _0_DATA6	BUCKET_SIZE _0_DATA5	BUCKET_SIZE _0_DATA4	BUCKET_SIZE _0_DATA3	BUCKET_SIZE _0_DATA2	BUCKET_SIZE _0_DATA1	BUCKET_SIZE _0_DATA0
Bit	Name	Description					
7 - 0	BUCKET_SIZE_0_DATA[7:0]	These bits set a bucket size for the internal leaky bucket accumulator. If the number of the accumulated events reach the bucket size, the accumulator will stop increasing even if further events are detected.					

DECAY_RATE_0_CNFG - Decay Rate for Leaky Bucket Configuration 0

Address: 34H Type: Read / Write Default Value: XXXXXX01							
7	6	5	4	3	2	1	0
-	-	-	-	-	-	DECAY_RATE_0_DATA1	DECAY_RATE_0_DATA0
Bit	Name	Description					
7 - 2	-	Reserved.					
1 - 0	DECAY_RATE_0_DATA[1:0]	These bits set a decay rate for the internal leaky bucket accumulator: 00: The accumulator decreases by 1 in every 128 ms with no event detected. 01: The accumulator decreases by 1 in every 256 ms with no event detected. (default) 10: The accumulator decreases by 1 in every 512 ms with no event detected. 11: The accumulator decreases by 1 in every 1024 ms with no event detected.					

UPPER_THRESHOLD_1_CNFG - Upper Threshold for Leaky Bucket Configuration 1

Address: 35H Type: Read / Write Default Value: 00000110							
7	6	5	4	3	2	1	0
UPPER_THRE SHOLD_1_DAT A7	UPPER_THRE SHOLD_1_DAT A6	UPPER_THRE SHOLD_1_DAT A5	UPPER_THRE SHOLD_1_DAT A4	UPPER_THRE SHOLD_1_DAT A3	UPPER_THRE SHOLD_1_DAT A2	UPPER_THRE SHOLD_1_DAT A1	UPPER_THRE SHOLD_1_DAT A0
Bit	Name	Description					
7 - 0	UPPER_THRESHOLD_1_DATA[7:0]	These bits set an upper threshold for the internal leaky bucket accumulator. When the number of the accumulated events is above this threshold, a no-activity alarm is raised.					

LOWER_THRESHOLD_1_CNFG - Lower Threshold for Leaky Bucket Configuration 1

Address: 36H Type: Read / Write Default Value: 00000100							
7	6	5	4	3	2	1	0
LOWER_THRE SHOLD_1_DAT A7	LOWER_THRE SHOLD_1_DAT A6	LOWER_THRE SHOLD_1_DAT A5	LOWER_THRE SHOLD_1_DAT A4	LOWER_THRE SHOLD_1_DAT A3	LOWER_THRE SHOLD_1_DAT A2	LOWER_THRE SHOLD_1_DAT A1	LOWER_THRE SHOLD_1_DAT A0
Bit	Name	Description					
7 - 0	LOWER_THRESHOLD_1_DATA[7:0]	These bits set a lower threshold for the internal leaky bucket accumulator. When the number of the accumulated events is below this threshold, the no-activity alarm is cleared.					

BUCKET_SIZE_1_CNFG - Bucket Size for Leaky Bucket Configuration 1

Address: 37H Type: Read / Write Default Value: 00001000							
7	6	5	4	3	2	1	0
BUCKET_SIZE_1_DATA7	BUCKET_SIZE_1_DATA6	BUCKET_SIZE_1_DATA5	BUCKET_SIZE_1_DATA4	BUCKET_SIZE_1_DATA3	BUCKET_SIZE_1_DATA2	BUCKET_SIZE_1_DATA1	BUCKET_SIZE_1_DATA0
Bit	Name	Description					
7 - 0	BUCKET_SIZE_1_DATA[7:0]	These bits set a bucket size for the internal leaky bucket accumulator. If the number of the accumulated events reach the bucket size, the accumulator will stop increasing even if further events are detected.					

DECAY_RATE_1_CNFG - Decay Rate for Leaky Bucket Configuration 1

Address: 38H Type: Read / Write Default Value: XXXXXX01							
7	6	5	4	3	2	1	0
-	-	-	-	-	-	DECAY_RATE_1_DATA1	DECAY_RATE_1_DATA0
Bit	Name	Description					
7 - 2	-	Reserved.					
1 - 0	DECAY_RATE_1_DATA[1:0]	These bits set a decay rate for the internal leaky bucket accumulator: 00: The accumulator decreases by 1 in every 128 ms with no event detected. 01: The accumulator decreases by 1 in every 256 ms with no event detected. (default) 10: The accumulator decreases by 1 in every 512 ms with no event detected. 11: The accumulator decreases by 1 in every 1024 ms with no event detected.					

UPPER_THRESHOLD_2_CNFG - Upper Threshold for Leaky Bucket Configuration 2

Address: 39H Type: Read / Write Default Value: 00000110							
7	6	5	4	3	2	1	0
UPPER_THRE_SHOLD_2_DATA7	UPPER_THRE_SHOLD_2_DATA6	UPPER_THRE_SHOLD_2_DATA5	UPPER_THRE_SHOLD_2_DATA4	UPPER_THRE_SHOLD_2_DATA3	UPPER_THRE_SHOLD_2_DATA2	UPPER_THRE_SHOLD_2_DATA1	UPPER_THRE_SHOLD_2_DATA0
Bit	Name	Description					
7 - 0	UPPER_THRESHOLD_2_DATA[7:0]	These bits set an upper threshold for the internal leaky bucket accumulator. When the number of the accumulated events is above this threshold, a no-activity alarm is raised.					

LOWER_THRESHOLD_2_CNFG - Lower Threshold for Leaky Bucket Configuration 2

Address: 3AH Type: Read / Write Default Value: 00000100							
7	6	5	4	3	2	1	0
LOWER_THRE SHOLD_2_DAT A7	LOWER_THRE SHOLD_2_DAT A6	LOWER_THRE SHOLD_2_DAT A5	LOWER_THRE SHOLD_2_DAT A4	LOWER_THRE SHOLD_2_DAT A3	LOWER_THRE SHOLD_2_DAT A2	LOWER_THRE SHOLD_2_DAT A1	LOWER_THRE SHOLD_2_DAT A0
Bit	Name	Description					
7 - 0	LOWER_THRESHOLD_2_DATA[7:0]	These bits set a lower threshold for the internal leaky bucket accumulator. When the number of the accumulated events is below this threshold, the no-activity alarm is cleared.					

BUCKET_SIZE_2_CNFG - Bucket Size for Leaky Bucket Configuration 2

Address: 3BH Type: Read / Write Default Value: 00001000							
7	6	5	4	3	2	1	0
BUCKET_SIZE _2_DATA7	BUCKET_SIZE _2_DATA6	BUCKET_SIZE _2_DATA5	BUCKET_SIZE _2_DATA4	BUCKET_SIZE _2_DATA3	BUCKET_SIZE _2_DATA2	BUCKET_SIZE _2_DATA1	BUCKET_SIZE _2_DATA0
Bit	Name	Description					
7 - 0	BUCKET_SIZE_2_DATA[7:0]	These bits set a bucket size for the internal leaky bucket accumulator. If the number of the accumulated events reach the bucket size, the accumulator will stop increasing even if further events are detected.					

DECAY_RATE_2_CNFG - Decay Rate for Leaky Bucket Configuration 2

Address: 3CH Type: Read / Write Default Value: XXXXXX01							
7	6	5	4	3	2	1	0
-	-	-	-	-	-	DECAY_RATE_ 2_DATA1	DECAY_RATE_ 2_DATA0
Bit	Name	Description					
7 - 2	-	Reserved.					
1 - 0	DECAY_RATE_2_DATA[1:0]	These bits set a decay rate for the internal leaky bucket accumulator: 00: The accumulator decreases by 1 in every 128 ms with no event detected. 01: The accumulator decreases by 1 in every 256 ms with no event detected. (default) 10: The accumulator decreases by 1 in every 512 ms with no event detected. 11: The accumulator decreases by 1 in every 1024 ms with no event detected.					

UPPER_THRESHOLD_3_CNFG - Upper Threshold for Leaky Bucket Configuration 3

Address: 3DH Type: Read / Write Default Value: 00000110							
7	6	5	4	3	2	1	0
UPPER_THRE SHOLD_3_DAT A7	UPPER_THRE SHOLD_3_DAT A6	UPPER_THRE SHOLD_3_DAT A5	UPPER_THRE SHOLD_3_DAT A4	UPPER_THRE SHOLD_3_DAT A3	UPPER_THRE SHOLD_3_DAT A2	UPPER_THRE SHOLD_3_DAT A1	UPPER_THRE SHOLD_3_DAT A0
Bit	Name	Description					
7 - 0	UPPER_THRESHOLD_3_DATA[7:0]	These bits set an upper threshold for the internal leaky bucket accumulator. When the number of the accumulated events is above this threshold, a no-activity alarm is raised.					

LOWER_THRESHOLD_3_CNFG - Lower Threshold for Leaky Bucket Configuration 3

Address: 3EH Type: Read / Write Default Value: 00000100							
7	6	5	4	3	2	1	0
LOWER_THRE SHOLD_3_DAT A7	LOWER_THRE SHOLD_3_DAT A6	LOWER_THRE SHOLD_3_DAT A5	LOWER_THRE SHOLD_3_DAT A4	LOWER_THRE SHOLD_3_DAT A3	LOWER_THRE SHOLD_3_DAT A2	LOWER_THRE SHOLD_3_DAT A1	LOWER_THRE SHOLD_3_DAT A0
Bit	Name	Description					
7 - 0	LOWER_THRESHOLD_3_DATA[7:0]	These bits set a lower threshold for the internal leaky bucket accumulator. When the number of the accumulated events is below this threshold, the no-activity alarm is cleared.					

BUCKET_SIZE_3_CNFG - Bucket Size for Leaky Bucket Configuration 3

Address: 3FH Type: Read / Write Default Value: 00001000							
7	6	5	4	3	2	1	0
BUCKET_SIZE _3_DATA7	BUCKET_SIZE _3_DATA6	BUCKET_SIZE _3_DATA5	BUCKET_SIZE _3_DATA4	BUCKET_SIZE _3_DATA3	BUCKET_SIZE _3_DATA2	BUCKET_SIZE _3_DATA1	BUCKET_SIZE _3_DATA0
Bit	Name	Description					
7 - 0	BUCKET_SIZE_3_DATA[7:0]	These bits set a bucket size for the internal leaky bucket accumulator. If the number of the accumulated events reach the bucket size, the accumulator will stop increasing even if further events are detected.					

DECAY_RATE_3_CNFG - Decay Rate for Leaky Bucket Configuration 3

Address: 40H
Type: Read / Write
Default Value: XXXXXX01

7	6	5	4	3	2	1	0
-	-	-	-	-	-	DECAY_RATE_3_DATA1	DECAY_RATE_3_DATA0

Bit	Name	Description
7 - 2	-	Reserved.
1 - 0	DECAY_RATE_3_DATA[1:0]	These bits set a decay rate for the internal leaky bucket accumulator: 00: The accumulator decreases by 1 in every 128 ms with no event detected. 01: The accumulator decreases by 1 in every 256 ms with no event detected. (default) 10: The accumulator decreases by 1 in every 512 ms with no event detected. 11: The accumulator decreases by 1 in every 1024 ms with no event detected.

IN_FREQ_READ_CH_CNFG - Input Clock Frequency Read Channel Selection

Address: 41H Type: Read / Write Default Value: XXXX0000							
7	6	5	4	3	2	1	0
-	-	-	-	IN_FREQ_READ_CH3	IN_FREQ_READ_CH2	IN_FREQ_READ_CH1	IN_FREQ_READ_CH0
Bit	Name	Description					
7 - 4	-	Reserved.					
3 - 0	IN_FREQ_READ_CH[3:0]	These bits select an input clock, the frequency of which with respect to the reference clock can be read. 0000: Reserved. (default) 0001, 0010: Reserved. 0011: IN1_CMOS. 0100: IN2_CMOS. 0101 ~ 1111: Reserved.					

IN_FREQ_READ_STS - Input Clock Frequency Read Value

Address: 42H Type: Read Default Value: 00000000							
7	6	5	4	3	2	1	0
IN_FREQ_VAL UE7	IN_FREQ_VAL UE6	IN_FREQ_VAL UE5	IN_FREQ_VAL UE4	IN_FREQ_VAL UE3	IN_FREQ_VAL UE2	IN_FREQ_VAL UE1	IN_FREQ_VAL UE0
Bit	Name	Description					
7 - 0	IN_FREQ_VALUE[7:0]	These bits represent a 2's complement signed integer. If the value is multiplied by the value in the FREQ_MON_FACTOR[3:0] bits (b3~0, 2EH), the frequency of an input clock with respect to the reference clock in ppm will be gotten. The input clock is selected by the IN_FREQ_READ_CH[3:0] bits (b3~0, 41H). The value in these bits is updated every 16 seconds, starting when an input clock is selected.					

IN1_IN2_CMOS_STS - CMOS Input Clock 1 & 2 Status

Address: 44H

Type: Read

Default Value: X110X110

7	6	5	4	3	2	1	0
-	IN2_CMOS_FREQ_HARD_ALARM	IN2_CMOS_NO_ACTIVITY_ALARM	IN2_CMOS_PH_LOCK_ALARM	-	IN1_CMOS_FREQ_HARD_ALARM	IN1_CMOS_NO_ACTIVITY_ALARM	IN1_CMOS_PH_LOCK_ALARM
Bit	Name	Description					
7	-	Reserved.					
6	IN2_CMOS_FREQ_HARD_ALARM	This bit indicates whether IN2_CMOS is in frequency hard alarm status. 0: No frequency hard alarm. 1: In frequency hard alarm status. (default)					
5	IN2_CMOS_NO_ACTIVITY_ALARM	This bit indicates whether IN2_CMOS is in no-activity alarm status. 0: No no-activity alarm. 1: In no-activity alarm status. (default)					
4	IN2_CMOS_PH_LOCK_ALARM	This bit indicates whether IN2_CMOS is in phase lock alarm status. 0: No phase lock alarm. (default) 1: In phase lock alarm status. If the PH_ALARM_TIMEOUT bit (b5, 09H) is '0', this bit is cleared by writing '1' to this bit; if the PH_ALARM_TIMEOUT bit (b5, 09H) is '1', this bit is cleared after a period (= TIME_OUT_VALUE[5:0] (b5~0, 08H) X MULTI_FACTOR[1:0] (b7~6, 08H) in second) which starts from when the alarm is raised.					
3	-	Reserved.					
2	IN1_CMOS_FREQ_HARD_ALARM	This bit indicates whether IN1_CMOS is in frequency hard alarm status. 0: No frequency hard alarm. 1: In frequency hard alarm status. (default)					
1	IN1_CMOS_NO_ACTIVITY_ALARM	This bit indicates whether IN1_CMOS is in no-activity alarm status. 0: No no-activity alarm. 1: In no-activity alarm status. (default)					
0	IN1_CMOS_PH_LOCK_ALARM	This bit indicates whether IN1_CMOS is in phase lock alarm status. 0: No phase lock alarm. (default) 1: In phase lock alarm status. If the PH_ALARM_TIMEOUT bit (b5, 09H) is '0', this bit is cleared by writing '1' to this bit; if the PH_ALARM_TIMEOUT bit (b5, 09H) is '1', this bit is cleared after a period (= TIME_OUT_VALUE[5:0] (b5~0, 08H) X MULTI_FACTOR[1:0] (b7~6, 08H) in second) which starts from when the alarm is raised.					

6.2.5 T0 DPLL INPUT CLOCK SELECTION REGISTERS

INPUT_VALID1_STS - Input Clocks Validity 1

Address: 4AH							
Type: Read							
Default Value: XXXX00XX							
7	6	5	4	3	2	1	0
-	-	-	-	IN2_CMOS	IN1_CMOS	-	-
Bit	Name	Description					
7 - 4	-	Reserved.					
3 - 2	INn_CMOS	This bit indicates the validity of the corresponding INn_CMOS. Here n is 2 or 1. 0: Invalid. (default) 1: Valid.					
1 - 0	-	Reserved.					

PRIORITY_TABLE1_STS - Priority Status 1

Address: 4EH							
Type: Read							
Default Value: 00000000							
7	6	5	4	3	2	1	0
HIGHEST_PRIORITY_VALIDATED3	HIGHEST_PRIORITY_VALIDATED2	HIGHEST_PRIORITY_VALIDATED1	HIGHEST_PRIORITY_VALIDATED0	CURRENTLY_SELECTED_INPUT3	CURRENTLY_SELECTED_INPUT2	CURRENTLY_SELECTED_INPUT1	CURRENTLY_SELECTED_INPUT0
Bit	Name	Description					
7 - 4	HIGHEST_PRIORITY_VALIDATED[3:0]	These bits indicate a qualified input clock with the highest priority. 0000: No input clock is qualified. (default) 0001, 0010: Reserved. 0011: IN1_CMOS. 0100: IN2_CMOS. 0101 ~ 1111: Reserved.					
3 - 0	CURRENTLY_SELECTED_INPUT[3:0]	These bits indicate the T0 selected input clock. 0000: No input clock is selected. (default) 0001, 0010: Reserved. 0011: IN1_CMOS. 0100: IN2_CMOS. 0101 ~ 1111: Reserved.					

PRIORITY_TABLE2_STS - Priority Status 2

Address: 4FH

Type: Read

Default Value: XXXX0000

7	6	5	4	3	2	1	0
-	-	-	-	SECOND_HIGHEST_PRIORITY_VALIDATED3	SECOND_HIGHEST_PRIORITY_VALIDATED2	SECOND_HIGHEST_PRIORITY_VALIDATED1	SECOND_HIGHEST_PRIORITY_VALIDATED0

Bit	Name	Description
7 - 4	-	Reserved.
3 - 0	SECOND_HIGHEST_PRIORITY_VALIDATED[3:0]	These bits indicate a qualified input clock with the second highest priority. 0000: No input clock is qualified. (default) 0001, 0010: Reserved. 0011: IN1_CMOS. 0100: IN2_CMOS. 0101 ~ 1111: Reserved.

T0_INPUT_SEL_CNFG - T0 Selected Input Clock Configuration

Address: 50H

Type: Read / Write

Default Value: XXXX0000

7	6	5	4	3	2	1	0
-	-	-	-	T0_INPUT_SEL3	T0_INPUT_SEL2	T0_INPUT_SEL1	T0_INPUT_SEL0

Bit	Name	Description
7 - 4	-	Reserved.
3 - 0	T0_INPUT_SEL[3:0]	This bit determines T0 input clock selection. It is valid only when the EXT_SW bit (b4, 0BH) is '0'. 0000: Automatic selection. (default) 0001, 0010: Reserved. 0011: Forced selection - IN1_CMOS is selected. 0100: Forced selection - IN2_CMOS is selected. 0101 ~ 1111: Reserved.

6.2.6 T0 DPLL STATE MACHINE CONTROL REGISTERS

OPERATING_STS - DPLL Operating Status

Address: 52H Type: Read Default Value: 1X0X0001							
7	6	5	4	3	2	1	0
EX_SYNC_ALARM_MON	-	T0_DPLL_SOFT_FREQ_ALARM	-	T0_DPLL_LOCK	T0_DPLL_OPERATING_MODE2	T0_DPLL_OPERATING_MODE1	T0_DPLL_OPERATING_MODE0
Bit	Name	Description					
7	EX_SYNC_ALARM_MON	This bit indicates whether the selected frame sync input signal is in external sync alarm status. 0: No external sync alarm. 1: In external sync alarm status. (default)					
6	-	Reserved.					
5	T0_DPLL_SOFT_FREQ_ALARM	This bit indicates whether the T0 DPLL is in soft alarm status. 0: No T0 DPLL soft alarm. (default) 1: In T0 DPLL soft alarm status.					
4	-	Reserved.					
3	T0_DPLL_LOCK	This bit indicates the T0 DPLL locking status. 0: Unlocked. (default) 1: Locked.					
2 - 0	T0_DPLL_OPERATING_MODE[2:0]	These bits indicate the current operating mode of T0 DPLL. 000: Reserved. 001: Free-Run. (default) 010: Holdover. 011: Reserved. 100: Locked. 101: Pre-Locked2. 110: Pre-Locked. 111: Lost-Phase.					

T0_OPERATING_MODE_CNFG - T0 DPLL Operating Mode Configuration

Address: 53H

Type: Read / Write

Default Value: XXXXX000

7	6	5	4	3	2	1	0
-	-	-	-	-	T0_OPERATING_MODE2	T0_OPERATING_MODE1	T0_OPERATING_MODE0

Bit	Name	Description
7 - 3	-	Reserved.
2 - 0	T0_OPERATING_MODE[2:0]	These bits control the T0 DPLL operating mode. 000: Automatic. (default) 001: Forced - Free-Run. 010: Forced - Holdover. 011: Reserved. 100: Forced - Locked. 101: Forced - Pre-Locked2. 110: Forced - Pre-Locked. 111: Forced - Lost-Phase.

6.2.7 T0 DPLL & T0/T4 APLL CONFIGURATION REGISTERS

T0_DPLL_APLL_PATH_CNFG - T0 DPLL & APLL Path Configuration

Address: 55H

Type: Read / Write

Default Value: 00000X0X

7	6	5	4	3	2	1	0
T0_APLL_PATH 3	T0_APLL_PA TH2	T0_APLL_PA TH1	T0_APLL_PA TH0	T0_GSM_OBSAI_ 16E1_16T1_SEL1	T0_GSM_OBSAI_ 16E1_16T1_SEL0	T0_12E1_24T1_ E3_T3_SEL1	T0_12E1_24T1_ E3_T3_SEL0

Bit	Name	Description
7 - 4	T0_APLL_PATH[3:0]	These bits select an input to the T0 APLL. 0000: The output of T0 DPLL 77.76 MHz path. (default) 0001: The output of T0 DPLL 12E1/24T1/E3/T3 path. 0010: The output of T0 DPLL 16E1/16T1 path. 0011: The output of T0 DPLL GSM/OBSAI/16E1/16T1 path. 0100 ~ 1111: Reserved.
3 - 2	T0_GSM_OBSAI_16E1_16T1_SEL[1:0]	These bits select an output clock from the T0 DPLL GSM/OBSAI/16E1/16T1 path. 00: 16E1. 01: 16T1. 10: GSM. 11: OBSAI. The default value of the T0_GSM_OBSAI_16E1_16T1_SEL0 bit is determined by the SONET/SDH pin during reset.
1 - 0	T0_12E1_24T1_E3_T3_SEL[1:0]	These bits select an output clock from the T0 DPLL 12E1/24T1/E3/T3 path. 00: 12E1. 01: 24T1. 10: E3. 11: T3. The default value of the T0_12E1_24T1_E3_T3_SEL0 bit is determined by the SONET/SDH pin during reset.

T0_DPLL_START_BW_DAMPING_CNFG - T0 DPLL Start Bandwidth & Damping Factor Configuration

Address: 56H

Type: Read / Write

Default Value: 01101111

7	6	5	4	3	2	1	0
T0_DPLL_STA RT_DAMPING2	T0_DPLL_STA RT_DAMPING1	T0_DPLL_STA RT_DAMPING0	T0_DPLL_STA RT_BW4	T0_DPLL_STA RT_BW3	T0_DPLL_STA RT_BW2	T0_DPLL_STA RT_BW1	T0_DPLL_STA RT_BW0

Bit	Name	Description
7 - 5	T0_DPLL_START_DAMPING[2:0]	These bits set the starting damping factor for T0 DPLL. 000: Reserved. 001: 1.2. 010: 2.5. 011: 5. (default) 100: 10. 101: 20. 110, 111: Reserved.
4 - 0	T0_DPLL_START_BW[4:0]	These bits set the starting bandwidth for T0 DPLL. 00XXX: Reserved. 01000: 0.1 Hz. 01001: 0.3 Hz. 01010: 0.6 Hz. 01011: 1.2 Hz. 01100: 2.5 Hz. 01101: 4 Hz. 01110: 8 Hz. 01111: 18 Hz. (default) 10000: 35 Hz. 10001: 70 Hz. 10010: 560 Hz. 10011 ~ 11111: Reserved.

T0_DPLL_ACQ_BW_DAMPING_CNFG - T0 DPLL Acquisition Bandwidth & Damping Factor Configuration

Address: 57H

Type: Read / Write

Default Value: 01101111

7	6	5	4	3	2	1	0
T0_DPLL_ACQ_DAMPING2	T0_DPLL_ACQ_DAMPING1	T0_DPLL_ACQ_DAMPING0	T0_DPLL_ACQ_BW4	T0_DPLL_ACQ_BW3	T0_DPLL_ACQ_BW2	T0_DPLL_ACQ_BW1	T0_DPLL_ACQ_BW0

Bit	Name	Description
7 - 5	T0_DPLL_ACQ_DAMPING[2:0]	These bits set the acquisition damping factor for T0 DPLL. 000: Reserved. 001: 1.2. 010: 2.5. 011: 5. (default) 100: 10. 101: 20. 110, 111: Reserved.
4 - 0	T0_DPLL_ACQ_BW[4:0]	These bits set the acquisition bandwidth for T0 DPLL. 00XXX: Reserved. 01000: 0.1 Hz. 01001: 0.3 Hz. 01010: 0.6 Hz. 01011: 1.2 Hz. 01100: 2.5 Hz. 01101: 4 Hz. 01110: 8 Hz. 01111: 18 Hz. (default) 10000: 35 Hz. 10001: 70 Hz. 10010: 560 Hz. 10011 ~ 11111: Reserved.

T0_DPLL_LOCKED_BW_DAMPING_CNFG - T0 DPLL Locked Bandwidth & Damping Factor Configuration

Address: 58H
 Type: Read / Write
 Default Value: 01101111

7	6	5	4	3	2	1	0
T0_DPLL_LOCK ED_DAMPING2	T0_DPLL_LOCK ED_DAMPING1	T0_DPLL_LOCK ED_DAMPING0	T0_DPLL_LOC KED_BW4	T0_DPLL_LOC KED_BW3	T0_DPLL_LOC KED_BW2	T0_DPLL_LOC KED_BW1	T0_DPLL_LOC KED_BW0
Bit	Name	Description					
7 - 5	T0_DPLL_LOCKED_DAMPING[2:0]	These bits set the locked damping factor for T0 DPLL. 000: Reserved. 001: 1.2. 010: 2.5. 011: 5. (default) 100: 10. 101: 20. 110, 111: Reserved.					
4 - 0	T0_DPLL_LOCKED_BW[4:0]	These bits set the locked bandwidth for T0 DPLL. 00XXX: Reserved. 01000: 0.1 Hz. 01001: 0.3 Hz. 01010: 0.6 Hz. 01011: 1.2 Hz. (default) 01100: 2.5 Hz. 01101: 4 Hz. 01110: 8 Hz. 01111: 18 Hz. 10000: 35 Hz. 10001: 70 Hz. 10010: 560 Hz. 10011 ~ 11111: Reserved.					

T0_BW_OVERSHOOT_CNFG - T0 DPLL Bandwidth Overshoot Configuration

Address: 59H
 Type: Read / Write
 Default Value: 1XXX1XXX

7	6	5	4	3	2	1	0
AUTO_BW_SEL	-	-	-	T0_LIMIT	-	-	-

Bit	Name	Description
7	AUTO_BW_SEL	This bit determines whether starting or acquisition bandwidth / damping factor is used for T0 DPLL. 0: The starting and acquisition bandwidths / damping factors are not used. Only the locked bandwidth / damping factor is used regardless of the T0 DPLL locking stage. 1: The starting, acquisition or locked bandwidth / damping factor is used automatically depending on different T0 DPLL locking stages. (default)
6 - 4	-	Reserved.
3	T0_LIMIT	This bit determines whether the integral path value is frozen when the T0 DPLL hard limit is reached. 0: Not frozen. 1: Frozen. It will minimize the subsequent overshoot when T0 DPLL is pulling in. (default)
2 - 0	-	Reserved.

PHASE_LOSS_COARSE_LIMIT_CNFG - Phase Loss Coarse Detector Limit Configuration

Address: 5AH
 Type: Read / Write
 Default Value: 10000101

7	6	5	4	3	2	1	0
COARSE_PH_LOS_LIMT_EN	WIDE_EN	MULTI_PH_APP	MULTI_PH_8K_4K_2K_EN	PH_LOS_COARSE_LIMT3	PH_LOS_COARSE_LIMT2	PH_LOS_COARSE_LIMT1	PH_LOS_COARSE_LIMT0

Bit	Name	Description																			
7	COARSE_PH_LOS_LIMT_EN	This bit controls whether the occurrence of the coarse phase loss will result in the T0 DPLL unlocked. 0: Disabled. 1: Enabled. (default)																			
6	WIDE_EN	Refer to the description of the MULTI_PH_8K_4K_2K_EN bit (b4, 5AH).																			
5	MULTI_PH_APP	This bit determines whether the PFD output of T0 DPLL is limited to ± 1 UI or is limited to the coarse phase limit. 0: Limited to ± 1 UI. (default) 1: Limited to the coarse phase limit. When the selected input clock is of 2 kHz, 4 kHz or 8 kHz, the coarse phase limit depends on the MULTI_PH_8K_4K_2K_EN bit, the WIDE_EN bit and the PH_LOS_COARSE_LIMT[3:0] bits; when the selected input clock is of other frequencies but 2 kHz, 4 kHz and 8 kHz, the coarse phase limit depends on the WIDE_EN bit and the PH_LOS_COARSE_LIMT[3:0] bits. Refer to the description of the MULTI_PH_8K_4K_2K_EN bit (b4, 5AH) for details.																			
4	MULTI_PH_8K_4K_2K_EN	This bit, together with the WIDE_EN bit (b6, 5AH) and the PH_LOS_COARSE_LIMT[3:0] bits (b3~0, 5AH), determines the coarse phase limit when the selected input clock is of 2 kHz, 4 kHz or 8 kHz. When the selected input clock is of other frequencies but 2 kHz, 4 kHz and 8 kHz, the coarse phase limit depends on the WIDE_EN bit and the PH_LOS_COARSE_LIMT[3:0] bits. <table><tr><th>Selected Input Clock</th><th>MULTI_PH_8K_4K_2K_EN</th><th>WIDE_EN</th><th>Coarse Phase Limit</th></tr><tr><td rowspan="3">2 kHz, 4 kHz or 8 kHz</td><td>0</td><td>don't-care</td><td>± 1 UI</td></tr><tr><td rowspan="2">1</td><td>0</td><td>± 1 UI</td></tr><tr><td>1</td><td>set by the PH_LOS_COARSE_LIMT[3:0] bits (b3~0, 5AH).</td></tr><tr><td rowspan="2">other than 2 kHz, 4 kHz and 8 kHz</td><td rowspan="2">don't-care</td><td>0</td><td>± 1 UI</td></tr><tr><td>1</td><td>set by the PH_LOS_COARSE_LIMT[3:0] bits (b3~0, 5AH).</td></tr></table>	Selected Input Clock	MULTI_PH_8K_4K_2K_EN	WIDE_EN	Coarse Phase Limit	2 kHz, 4 kHz or 8 kHz	0	don't-care	± 1 UI	1	0	± 1 UI	1	set by the PH_LOS_COARSE_LIMT[3:0] bits (b3~0, 5AH).	other than 2 kHz, 4 kHz and 8 kHz	don't-care	0	± 1 UI	1	set by the PH_LOS_COARSE_LIMT[3:0] bits (b3~0, 5AH).
Selected Input Clock	MULTI_PH_8K_4K_2K_EN	WIDE_EN	Coarse Phase Limit																		
2 kHz, 4 kHz or 8 kHz	0	don't-care	± 1 UI																		
	1	0	± 1 UI																		
		1	set by the PH_LOS_COARSE_LIMT[3:0] bits (b3~0, 5AH).																		
other than 2 kHz, 4 kHz and 8 kHz	don't-care	0	± 1 UI																		
		1	set by the PH_LOS_COARSE_LIMT[3:0] bits (b3~0, 5AH).																		
3 - 0	PH_LOS_COARSE_LIMT[3:0]	These bit set the coarse phase limit. The limit is used only in some cases. Refer to the description of the MULTI_PH_8K_4K_2K_EN bit (b4, 5AH). 0000: ± 1 UI. 0001: ± 3 UI. 0010: ± 7 UI. 0011: ± 15 UI. 0100: ± 31 UI. 0101: ± 63 UI. (default) 0110: ± 127 UI. 0111: ± 255 UI. 1000: ± 511 UI. 1001: ± 1023 UI. 1010-1111: Reserved.																			

PHASE_LOSS_FINE_LIMIT_CNFG - Phase Loss Fine Detector Limit Configuration

Address: 5BH

Type: Read / Write

Default Value: 10XXX010

7	6	5	4	3	2	1	0
FINE_PH_LOS_LIMIT_EN	FAST_LOS_SW	-	-	-	PH_LOS_FINE_LIMIT2	PH_LOS_FINE_LIMIT1	PH_LOS_FINE_LIMIT0

Bit	Name	Description
7	FINE_PH_LOS_LIMIT_EN	This bit controls whether the occurrence of the fine phase loss will result in the T0 DPLL unlocked. 0: Disabled. 1: Enabled. (default)
6	FAST_LOS_SW	This bit controls whether the occurrence of the fast loss will result in the T0 DPLL unlocked. 0: Does not result in the T0 DPLL unlocked. T0 DPLL will enter Temp-Holdover mode automatically. (default) 1: Results in the T0 DPLL unlocked. T0 DPLL will enter Lost-Phase mode if the T0 DPLL operating mode is switched automatically.
5 - 3	-	Reserved.
2 - 0	PH_LOS_FINE_LIMIT[2:0]	These bits set a fine phase limit. 000: 0. 001: $\pm (45^\circ \sim 90^\circ)$. 010: $\pm (90^\circ \sim 180^\circ)$. (default) 011: $\pm (180^\circ \sim 360^\circ)$. 100: $\pm (20 \text{ ns} \sim 25 \text{ ns})$. 101: $\pm (60 \text{ ns} \sim 65 \text{ ns})$. 110: $\pm (120 \text{ ns} \sim 125 \text{ ns})$. 111: $\pm (950 \text{ ns} \sim 955 \text{ ns})$.

T0_HOLDOVER_MODE_CNFG - T0 DPLL Holdover Mode Configuration

Address: 5CH
Type: Read / Write
Default Value: 010001XX

7	6	5	4	3	2	1	0
MAN_HOLD OVER	AUTO_AVG	FAST_AVG	READ_AVG	TEMP_HOLD OVER_MODE1	TEMP_HOLD OVER_MODE0	-	-

Bit	Name	Description																	
7	MAN_HOLDOVER	Refer to the description of the FAST_AVG bit (b5, 5CH).																	
6	AUTO_AVG	Refer to the description of the FAST_AVG bit (b5, 5CH).																	
5	FAST_AVG	This bit, together with the AUTO_AVG bit (b6, 5CH) and the MAN_HOLDOVER bit (b7, 5CH), determines a frequency offset acquiring method in T0 DPLL Holdover Mode. <table><tr><th>MAN_HOLDOVER</th><th>AUTO_AVG</th><th>FAST_AVG</th><th>Frequency Offset Acquiring Method</th></tr><tr><td rowspan="3">0</td><td>0</td><td>don't-care</td><td>Automatic Instantaneous</td></tr><tr><td rowspan="2">1</td><td>0</td><td>Automatic Slow Averaged (default)</td></tr><tr><td>1</td><td>Automatic Fast Averaged</td></tr><tr><td>1</td><td colspan="2">don't-care</td><td>Manual</td></tr></table>	MAN_HOLDOVER	AUTO_AVG	FAST_AVG	Frequency Offset Acquiring Method	0	0	don't-care	Automatic Instantaneous	1	0	Automatic Slow Averaged (default)	1	Automatic Fast Averaged	1	don't-care		Manual
MAN_HOLDOVER	AUTO_AVG	FAST_AVG	Frequency Offset Acquiring Method																
0	0	don't-care	Automatic Instantaneous																
	1	0	Automatic Slow Averaged (default)																
		1	Automatic Fast Averaged																
1	don't-care		Manual																
4	READ_AVG	This bit controls the holdover frequency offset reading, which is read from the T0_HOLDOVER_FREQ[23:0] bits (5FH ~ 5DH). 0: The value read from the T0_HOLDOVER_FREQ[23:0] bits (5FH ~ 5DH) is equal to the one written to them. (default) 1: The value read from the T0_HOLDOVER_FREQ[23:0] bits (5FH ~ 5DH) is not equal to the one written to them. The value is acquired by Automatic Slow Averaged method if the FAST_AVG bit (b5, 5CH) is '0'; or is acquired by Automatic Fast Averaged method if the FAST_AVG bit (b5, 5CH) is '1'.																	
3 - 2	TEMP_HOLDOVER_MODE[1:0]	These bits determine the frequency offset acquiring method in T0 DPLL Temp-Holdover Mode. 00: The method is the same as that used in T0 DPLL Holdover mode. 01: Automatic Instantaneous. (default) 10: Automatic Fast Averaged. 11: Automatic Slow Averaged.																	
1 - 0	-	Reserved.																	

T0_HOLDOVER_FREQ[7:0]_CNFG - T0 DPLL Holdover Frequency Configuration 1

Address: 5DH Type: Read / Write Default Value: 00000000							
7	6	5	4	3	2	1	0
T0_HOLDOVER_FREQ7	T0_HOLDOVER_FREQ6	T0_HOLDOVER_FREQ5	T0_HOLDOVER_FREQ4	T0_HOLDOVER_FREQ3	T0_HOLDOVER_FREQ2	T0_HOLDOVER_FREQ1	T0_HOLDOVER_FREQ0
Bit	Name	Description					
7 - 0	T0_HOLDOVER_FREQ[7:0]	Refer to the description of the T0_HOLDOVER_FREQ[23:16] bits (b7~0, 5FH).					

T0_HOLDOVER_FREQ[15:8]_CNFG - T0 DPLL Holdover Frequency Configuration 2

Address: 5EH

Type: Read / Write

Default Value: 00000000

7	6	5	4	3	2	1	0
T0_HOLDOVER_FREQ15	T0_HOLDOVER_FREQ14	T0_HOLDOVER_FREQ13	T0_HOLDOVER_R_FREQ12	T0_HOLDOVER_R_FREQ11	T0_HOLDOVER_R_FREQ10	T0_HOLDOVER_R_FREQ9	T0_HOLDOVER_R_FREQ8
Bit	Name	Description					
7 - 0	T0_HOLDOVER_FREQ[15:8]	Refer to the description of the T0_HOLDOVER_FREQ[23:16] bits (b7~0, 5FH).					

T0_HOLDOVER_FREQ[23:16]_CNFG - T0 DPLL Holdover Frequency Configuration 3

Address: 5FH

Type: Read / Write

Default Value: 00000000

7	6	5	4	3	2	1	0
T0_HOLDOVER_FREQ23	T0_HOLDOVER_FREQ22	T0_HOLDOVER_FREQ21	T0_HOLDOVER_R_FREQ20	T0_HOLDOVER_R_FREQ19	T0_HOLDOVER_R_FREQ18	T0_HOLDOVER_R_FREQ17	T0_HOLDOVER_R_FREQ16
Bit	Name	Description					
7 - 0	T0_HOLDOVER_FREQ[23:16]	The T0_HOLDOVER_FREQ[23:0] bits represent a 2's complement signed integer. In T0 DPLL Holdover mode, the value written to these bits multiplied by 0.000011 is the frequency offset set manually; the value read from these bits multiplied by 0.000011 is the frequency offset automatically slow or fast averaged or manually set, as determined by the READ_AVG bit (b4, 5CH) and the FAST_AVG bit (b5, 5CH).					

T4_APLL_PATH_CNFG - T4 APLL Path Configuration

Address: 60H

Type: Read / Write

Default Value: 0100XXXX

7	6	5	4	3	2	1	0
T4_APLL_PATH_3	T4_APLL_PATH2	T4_APLL_PATH1	T4_APLL_PATH0	-	-	-	-
Bit	Name	Description					
7 - 4	T4_APLL_PATH[3:0]	These bits select an input to the T4 APLL. 0000: The output of T0 DPLL 77.76 MHz path. 0001: The output of T0 DPLL 12E1/24T1/E3/T3 path. 0010: The output of T0 DPLL 16E1/16T1 path. 0011: The output of T0 DPLL GSM/OBSAI/16E1/16T1 path. 0100 ~ 1111: Reserved.					
3 - 0	-	Reserved.					

CURRENT_DPLL_FREQ[7:0]_STS - DPLL Current Frequency Status 1

Address: 62H
 Type: Read
 Default Value: 00000000

7	6	5	4	3	2	1	0
CURRENT_DP LL_FREQ7	CURRENT_DP LL_FREQ6	CURRENT_DP LL_FREQ5	CURRENT_DP LL_FREQ4	CURRENT_DP LL_FREQ3	CURRENT_DP LL_FREQ2	CURRENT_DP LL_FREQ1	CURRENT_DP LL_FREQ0
Bit	Name	Description					
7 - 0	CURRENT_DPLL_FREQ[7:0]	Refer to the description of the CURRENT_DPLL_FREQ[23:16] bits (b7~0, 64H).					

CURRENT_DPLL_FREQ[15:8]_STS - DPLL Current Frequency Status 2

Address: 63H
 Type: Read
 Default Value: 00000000

7	6	5	4	3	2	1	0
CURRENT_DP LL_FREQ15	CURRENT_DP LL_FREQ14	CURRENT_DP LL_FREQ13	CURRENT_DP LL_FREQ12	CURRENT_DP LL_FREQ11	CURRENT_DP LL_FREQ10	CURRENT_DP LL_FREQ9	CURRENT_DP LL_FREQ8
Bit	Name	Description					
7 - 0	CURRENT_DPLL_FREQ[15:8]	Refer to the description of the CURRENT_DPLL_FREQ[23:16] bits (b7~0, 64H).					

CURRENT_DPLL_FREQ[23:16]_STS - DPLL Current Frequency Status 3

Address: 64H
 Type: Read
 Default Value: 00000000

7	6	5	4	3	2	1	0
CURRENT_DP LL_FREQ23	CURRENT_DP LL_FREQ22	CURRENT_DP LL_FREQ21	CURRENT_DP LL_FREQ20	CURRENT_DP LL_FREQ19	CURRENT_DP LL_FREQ18	CURRENT_DP LL_FREQ17	CURRENT_DP LL_FREQ16
Bit	Name	Description					
7 - 0	CURRENT_DPLL_FREQ[23:16]	The CURRENT_DPLL_FREQ[23:0] bits represent a 2's complement signed integer. If the value in these bits is multiplied by 0.000011, the current frequency offset of the T0 DPLL output in ppm with respect to the master clock will be gotten.					

DPLL_FREQ_SOFT_LIMIT_CNFG - DPLL Soft Limit Configuration

Address: 65H Type: Read / Write Default Value: 10001100							
7	6	5	4	3	2	1	0
FREQ_LIMIT_PH_LOS	DPLL_FREQ_SOFT_LIMIT6	DPLL_FREQ_SOFT_LIMIT5	DPLL_FREQ_SOFT_LIMIT4	DPLL_FREQ_SOFT_LIMIT3	DPLL_FREQ_SOFT_LIMIT2	DPLL_FREQ_SOFT_LIMIT1	DPLL_FREQ_SOFT_LIMIT0
Bit	Name	Description					
7	FREQ_LIMIT_PH_LOS	This bit determines whether the T0 DPLL in hard alarm status will result in it unlocked. 0: Disabled. 1: Enabled. (default)					
6 - 0	DPLL_FREQ_SOFT_LIMIT[6:0]	These bits represent an unsigned integer. If the value is multiplied by 0.724, the DPLL soft limit for T0 path in ppm will be gotten. The DPLL soft limit is symmetrical about zero.					

DPLL_FREQ_HARD_LIMIT[7:0]_CNFG - DPLL Hard Limit Configuration 1

Address: 66H Type: Read / Write Default Value: 10101011							
7	6	5	4	3	2	1	0
DPLL_FREQ_HARD_LIMIT7	DPLL_FREQ_HARD_LIMIT6	DPLL_FREQ_HARD_LIMIT5	DPLL_FREQ_HARD_LIMIT4	DPLL_FREQ_HARD_LIMIT3	DPLL_FREQ_HARD_LIMIT2	DPLL_FREQ_HARD_LIMIT1	DPLL_FREQ_HARD_LIMIT0
Bit	Name	Description					
7 - 0	DPLL_FREQ_HARD_LIMIT[7:0]	Refer to the description of the DPLL_FREQ_HARD_LIMIT[15:8] bits (b7~0, 67H).					

DPLL_FREQ_HARD_LIMIT[15:8]_CNFG - DPLL Hard Limit Configuration 2

Address: 67H Type: Read / Write Default Value: 00011001							
7	6	5	4	3	2	1	0
DPLL_FREQ_HARD_LIMIT15	DPLL_FREQ_HARD_LIMIT14	DPLL_FREQ_HARD_LIMIT13	DPLL_FREQ_HARD_LIMIT12	DPLL_FREQ_HARD_LIMIT11	DPLL_FREQ_HARD_LIMIT10	DPLL_FREQ_HARD_LIMIT9	DPLL_FREQ_HARD_LIMIT8
Bit	Name	Description					
7 - 0	DPLL_FREQ_HARD_LIMIT[15:8]	The DPLL_FREQ_HARD_LIMIT[15:0] bits represent an unsigned integer. If the value is multiplied by 0.0014, the DPLL hard limit for T0 path in ppm will be gotten. The DPLL hard limit is symmetrical about zero.					

CURRENT_DPLL_PHASE[7:0]_STS - DPLL Current Phase Status 1

Address: 68H

Type: Read

Default Value: 00000000

7	6	5	4	3	2	1	0
CURRENT_PH_DATA7	CURRENT_PH_DATA6	CURRENT_PH_DATA5	CURRENT_PH_DATA4	CURRENT_PH_DATA3	CURRENT_PH_DATA2	CURRENT_PH_DATA1	CURRENT_PH_DATA0

Bit	Name	Description
7 - 0	CURRENT_PH_DATA[7:0]	Refer to the description of the CURRENT_PH_DATA[15:8] bits (b7~0, 69H).

CURRENT_DPLL_PHASE[15:8]_STS - DPLL Current Phase Status 2

Address: 69H

Type: Read

Default Value: 00000000

7	6	5	4	3	2	1	0
CURRENT_PH_DATA15	CURRENT_PH_DATA14	CURRENT_PH_DATA13	CURRENT_PH_DATA12	CURRENT_PH_DATA11	CURRENT_PH_DATA10	CURRENT_PH_DATA9	CURRENT_PH_DATA8

Bit	Name	Description
7 - 0	CURRENT_PH_DATA[15:8]	The CURRENT_PH_DATA[15:0] bits represent a 2's complement signed integer. If the value is multiplied by 0.61, the averaged phase error of the T0 DPLL feedback with respect to the selected input clock in ns will be gotten.

T0_T4_APLL_BW_CNFG - T0 / T4 APLL Bandwidth Configuration

Address: 6AH

Type: Read / Write

Default Value: XX01XX01

7	6	5	4	3	2	1	0
-	-	T0_APLL_BW1	T0_APLL_BW0	-	-	T4_APLL_BW1	T4_APLL_BW0
Bit	Name	Description					
7 - 6	-	Reserved.					
5 - 4	T0_APLL_BW[1:0]	These bits set the bandwidth for T0 APLL. 00: 100 kHz. 01: 500 kHz. (default) 10: 1 MHz. 11: 2 MHz.					
3 - 2	-	Reserved.					
1 - 0	T4_APLL_BW[1:0]	These bits set the bandwidth for T4 APLL. 00: 100 kHz. 01: 500 kHz. (default) 10: 1 MHz. 11: 2 MHz.					

6.2.8 OUTPUT CONFIGURATION REGISTERS

OUT2_FREQ_CNFG - Output Clock 2 Frequency Configuration

Address: 6DH							
Type: Read / Write							
Default Value: 00001000							
7	6	5	4	3	2	1	0
OUT2_PATH_S EL3	OUT2_PATH_S EL2	OUT2_PATH_S EL1	OUT2_PATH_S EL0	OUT2_DIVIDER 3	OUT2_DIVIDER 2	OUT2_DIVIDER 1	OUT2_DIVIDER 0
Bit	Name	Description					
7 - 4	OUT2_PATH_SEL[3:0]	These bits select an input to OUT2. 0000 ~ 0011: The output of T0 APLL. (default: 0000) 0100: The output of T0 DPLL 77.76 MHz path. 0101: The output of T0 DPLL 12E1/24T1/E3/T3 path. 0110: The output of T0 DPLL 16E1/16T1 path. 0111: The output of T0 DPLL GSM/OBSAI/16E1/16T1 path. 1000 ~ 1011: The output of T4 APLL. 1100 ~ 1111: Reserved.					
3 - 0	OUT2_DIVIDER[3:0]	These bits select a division factor of the divider for OUT2. The output frequency is determined by the division factor and the signal derived from T0 DPLL or T0/T4 APLL output (selected by the OUT2_PATH_SEL[3:0] bits (b7~4, 6DH)). If the signal is derived from one of the T0 DPLL outputs, please refer to Table 22 for the division factor selection. If the signal is derived from the T0/T4 APLL output, please refer to Table 23 for the division factor selection.					

OUT1_FREQ_CNFG - Output Clock 1 Frequency Configuration

Address: 71H							
Type: Read / Write							
Default Value: 00001000							
7	6	5	4	3	2	1	0
OUT1_PATH_S EL3	OUT1_PATH_S EL2	OUT1_PATH_S EL1	OUT1_PATH_S EL0	OUT1_DIVIDER 3	OUT1_DIVIDER 2	OUT1_DIVIDER 1	OUT1_DIVIDER 0
Bit	Name	Description					
7 - 4	OUT1_PATH_SEL[3:0]	These bits select an input to OUT1. 0000 ~ 0011: The output of T0 APLL. (default: 0000) 0100: The output of T0 DPLL 77.76 MHz path. 0101: The output of T0 DPLL 12E1/24T1/E3/T3 path. 0110: The output of T0 DPLL 16E1/16T1 path. 0111: The output of T0 DPLL GSM/OBSAI/16E1/16T1 path. 1000 ~ 1011: The output of T4 APLL. 1100 ~ 1111: Reserved.					
3 - 0	OUT1_DIVIDER[3:0]	These bits select a division factor of the divider for OUT1. The output frequency is determined by the division factor and the signal derived from T0 DPLL or T0/T4 APLL output (selected by the OUT1_PATH_SEL[3:0] bits (b7~4, 71H)). If the signal is derived from one of the T0 DPLL outputs, please refer to Table 22 for the division factor selection. If the signal is derived from the T0/T4 APLL output, please refer to Table 23 for the division factor selection.					

OUT1_INV_CNFG - Output Clock 1 Invert Configuration

Address:72H
Type: Read / Write
Default Value: XXXXXX0X

7	6	5	4	3	2	1	0
-	-	-	-	-	-	OUT1_INV	-

Bit	Name	Description
7 - 2	-	Reserved.
1	OUT1_INV	This bit determines whether the output on OUT1 is inverted. 0: Not inverted. (default) 1: Inverted.
0	-	Reserved.

OUT2_INV_CNFG - Output Clock 2 Invert Configuration

Address:73H
Type: Read / Write
Default Value: XXXXX0XX

7	6	5	4	3	2	1	0
-	-	-	-	-	OUT2_INV	-	-

Bit	Name	Description
7 - 3	-	Reserved.
2	OUT2_INV	This bit determines whether the output on OUT2 is inverted. 0: Not inverted. (default) 1: Inverted.
1 - 0	-	Reserved.

FR_SYNC_CNFG - Frame Sync Output Configuration

Address: 74H

Type: Read / Write

Default Value: 01X000XX

7	6	5	4	3	2	1	0
IN_2K_4K_8K_INV	8K_EN	-	8K_PUL_POSITION	8K_INV	8K_PUL	-	-

Bit	Name	Description
7	IN_2K_4K_8K_INV	This bit determines whether the input clock is inverted before locked by the T0 DPLL when the input clock is 2 kHz, 4 kHz or 8 kHz. 0: Not inverted. (default) 1: Inverted.
6	8K_EN	This bit determines whether an 8 kHz signal is enabled to be output on FRSYNC_8K. 0: Disabled. FRSYNC_8K outputs low. 1: Enabled. (default)
5	-	Reserved.
4	8K_PUL_POSITION	This bit is valid only when FRSYNC_8K output pulse; i.e., when one of the 8K_PUL bit (b2, 74H) is '1' or when the 8K_PUL bit (b2, 74H) is '1'. It determines the pulse position referring to the standard 50:50 duty cycle. 0: Pulsed on the falling edge of the standard 50:50 duty cycle position. (default) 1: Pulsed on the rising edge of the standard 50:50 duty cycle position.
3	8K_INV	This bit determines whether the output on FRSYNC_8K is inverted. 0: Not inverted. (default) 1: Inverted.
2	8K_PUL	This bit determines whether the output on FRSYNC_8K is 50:50 duty cycle or pulsed. 0: 50:50 duty cycle. (default) 1: Pulsed. The pulse width is defined by the period of the output on OUT2.
1 - 0	-	Reserved.

6.2.9 PBO & PHASE OFFSET CONTROL REGISTERS

PHASE_MON_PBO_CNFG - Phase Transient Monitor & PBO Configuration

Address: 78H

Type: Read / Write

Default Value: 0X000110

7	6	5	4	3	2	1	0
IN_NOISE_WIN DOW	-	PH_MON_EN	PH_MON_PBO _EN	PH_TR_MON_L IMT3	PH_TR_MON_L IMT2	PH_TR_MON_L IMT1	PH_TR_MON_L IMT0
Bit	Name	Description					
7	IN_NOISE_WINDOW	This bit determines whether the input clock whose edge respect to the reference clock is outside $\pm 5\%$ is enabled to be selected for T0 DPLL. 0: Disabled. (default) 1: Enabled.					
6	-	Reserved.					
5	PH_MON_EN	This bit is valid only when the PH_MON_PBO_EN bit (b4, 78H) is '1'. It determines whether the Phase Transient Monitor is enabled to monitor the phase-time changes on the T0 selected input clock. 0: Disabled. (default) 1: Enabled.					
4	PH_MON_PBO_EN	This bit determines whether a PBO event is triggered when the phase-time changes on the T0 selected input clock are greater than a programmable limit over an interval of less than 0.1 seconds with the PH_MON_EN bit being '1'. The limit is programmed by the PH_TR_MON_LIMT[3:0] bits (b3~0, 78H). 0: Disabled. (default) 1: Enabled.					
3 - 0	PH_TR_MON_LIMT[3:0]	These bits represent an unsigned integer. The Phase Transient Monitor limit in ns can be calculated as follows: <i>Limit (ns) = (PH_TR_MON_LIMT[3:0] + 7) X 156.</i>					

6.2.10 SYNCHRONIZATION CONFIGURATION REGISTERS

SYNC_MONITOR_CNFG - Sync Monitor Configuration

Address:7CH
Type: Read / Write
Default Value: 00101011

7	6	5	4	3	2	1	0
SYNC_BYPASS	SYNC_MON_LIMT2	SYNC_MON_LIMT1	SYNC_MON_LIMT0	-	-	-	-

Bit	Name	Description
7	SYNC_BYPASS	This bit selects one frame sync input signal to synchronize the frame sync output signal. 0: EX_SYNC1 is selected. (default) 1: When the T0 selected input clock is IN1_CMOS, EX_SYNC1 is selected; when the T0 selected input clock is IN2_CMOS, EX_SYNC2 is selected;when there is no T0 selected input clock, no frame sync input signal is selected.
6 - 4	SYNC_MON_LIMT[2:0]	These bits set the limit for the external sync alarm. 000: ±1 UI. 001: ±2 UI. 010: ±3 UI. (default) 011: ±4 UI. 100: ±5 UI. 101: ±6 UI. 110: ±7 UI. 111: ±8 UI.
3 - 0	-	These bits must be set to '1011'.

SYNC_PHASE_CNFG - Sync Phase Configuration

Address:7DH
Type: Read / Write
Default Value: XXXX0000

7	6	5	4	3	2	1	0
-	-	-	-	SYNC_PH21	SYNC_PH20	SYNC_PH11	SYNC_PH10

Bit	Name	Description
7 - 4	-	Reserved.
3 - 2	SYNC_PH2[1:0]	These bits set the sampling of EX_SYNC2 when EX_SYNC2 is enabled to synchronize the frame sync output signal. Nominally, the falling edge of EX_SYNC2 is aligned with the rising edge of the T0 selected input clock. 00: On target. (default) 01: 0.5 UI early. 10: 1 UI late. 11: 0.5 UI late.
1 - 0	SYNC_PH1[1:0]	These bits set the sampling of EX_SYNC1 when EX_SYNC1 is enabled to synchronize the frame sync output signal. Nominally, the falling edge of EX_SYNC1 is aligned with the rising edge of the T0 selected input clock. 00: On target. (default) 01: 0.5 UI early. 10: 1 UI late. 11: 0.5 UI late.

7 THERMAL MANAGEMENT

The device operates over the industry temperature range $-40^{\circ}\text{C} \sim +85^{\circ}\text{C}$. To ensure the functionality and reliability of the device, the maximum junction temperature $T_{j\text{max}}$ should not exceed 125°C . In some applications, the device will consume more power and a thermal solution should be provided to ensure the junction temperature T_j does not exceed the $T_{j\text{max}}$.

7.1 JUNCTION TEMPERATURE

Junction temperature T_j is the temperature of package typically at the geographical center of the chip where the device's electrical circuits are. It can be calculated as follows:

$$\text{Equation 1: } T_j = T_A + P \times \theta_{JA}$$

Where:

θ_{JA} = Junction-to-Ambient Thermal Resistance of the Package

T_j = Junction Temperature

T_A = Ambient Temperature

P = Device Power Consumption

In order to calculate junction temperature, an appropriate θ_{JA} must be used. The θ_{JA} is shown in [Table 32](#):

Power consumption is the core power excluding the power dissipated in the loads. [Table 33](#) provides power consumption in special environments.

Table 32: Power Consumption and Maximum Junction Temperature

Package	Power Consumption (W)	Operating Voltage (V)	T_A ($^{\circ}\text{C}$)	Maximum Junction Temperature ($^{\circ}\text{C}$)
VFQFPN/NL68	1.57	3.6	85	125
TQFP/EDG64	1.57	3.6	85	125

7.2 EXAMPLE OF JUNCTION TEMPERATURE CALCULATION

Assume:

$$T_A = 85^{\circ}\text{C}$$

$$\theta_{JA} = 21.7^{\circ}\text{C/W (TQFP/EDG64 Soldered \& when airflow rate is 0 m/s)}$$

$$P = 1.57\text{W}$$

Table 33: Thermal Data

Package	Pin Count	Thermal Pad	θ_{JC} ($^{\circ}\text{C/W}$)	θ_{JB} ($^{\circ}\text{C/W}$)	θ_{JA} ($^{\circ}\text{C/W}$) Air Flow in m/s					
					0	1	2	3	4	5
VFQFPN/NL68	68	Yes/Exposed	9.1	8.3	39.4	34.1	31.7	30.2	29.1	28.2
VFQFPN/NL68	68	Yes/Soldered*	9.1	1.2	20.9	16.2	15.2	14.6	14.1	13.8
TQFP/EDG64	64	Yes/Exposed	12.6	35.3	37.0	32.1	30.4	29.4	28.7	28.1
TQFP/EDG64	64	Yes/Soldered	12.6	1.3	21.7	17.3	16.2	15.6	15.2	14.9

*note: Simulated with 3 x 3 array of thermal vias.

The junction temperature T_j can be calculated as follows:

$$T_j = T_A + P \times \theta_{JA} = 85^{\circ}\text{C} + 1.57\text{W} \times 21.7^{\circ}\text{C/W} = 119.1^{\circ}\text{C}$$

The junction temperature of 119.1°C is below the maximum junction temperature of 125°C so no extra heat enhancement is required.

In some operation environments, the calculated junction temperature might exceed the maximum junction temperature of 125°C and an external thermal solution such as a heatsink is required.

7.3 HEATSINK EVALUATION

A heatsink is expanding the surface area of the device to which it is attached. θ_{JA} is now a combination of device case and heat-sink thermal resistance, as the heat flowing from the die junction to ambient goes through the package and the heatsink. θ_{JA} can be calculated as follows:

$$\text{Equation 2: } \theta_{JA} = \theta_{JC} + \theta_{CH} + \theta_{HA}$$

Where:

θ_{JC} = Junction-to-Case Thermal Resistance

θ_{CH} = Case-to-Heatsink Thermal Resistance

θ_{HA} = Heatsink-to-Ambient Thermal Resistance

$\theta_{CH} + \theta_{HA}$ determines which heatsink and heatsink attachment can be selected to ensure the junction temperature does not exceed the maximum junction temperature. According to Equation 1 and 2,

$\theta_{CH} + \theta_{HA}$ can be calculated as follows:

$$\text{Equation 3: } \theta_{CH} + \theta_{HA} = (T_j - T_A) / P - \theta_{JC}$$

Assume:

$$T_j = 125^{\circ}\text{C (} T_{j\text{max}} \text{)}$$

$$T_A = 85^{\circ}\text{C}$$

$$P = 1.57\text{W}$$

$$\theta_{JC} = 12.6^{\circ}\text{C/W (TQFP/EDG64)}$$

$\theta_{CH} + \theta_{HA}$ can be calculated as follows:

$$\theta_{CH} + \theta_{HA} = (125^{\circ}\text{C} - 85^{\circ}\text{C}) / 1.57\text{W} - 12.6^{\circ}\text{C/W} = 12.9^{\circ}\text{C/W}$$

That is, if a heatsink and heatsink attachment whose $\theta_{CH} + \theta_{HA}$ is below or equal to 12.9°C/W is used in such operation environment, the junction temperature will not exceed the maximum junction temperature.

7.4 VFQFPN EPAD THERMAL RELEASE PATH

In order to maximize both the removal of heat from the package and the electrical performance, a land pattern must be incorporated on the Printed Circuit Board (PCB) within the footprint of the package corresponding to the exposed metal pad or exposed heat slug on the package, as shown in Figure 19. The solderable area on the PCB, as defined

by the solder mask, should be at least the same size/shape as the exposed pad/slug area on the package to maximize the thermal/electrical performance. Sufficient clearance should be designed on the PCB between the outer edges of the land pattern and the inner edges of pad pattern for the leads to avoid any shorts.

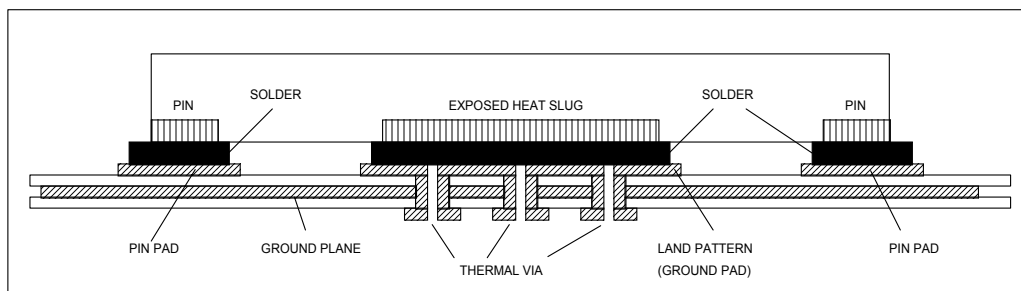


Figure 19. Assembly for Expose Pad thermal Release Path (Side View)

While the land pattern on the PCB provides a means of heat transfer and electrical grounding from the package to the board through a solder joint, thermal vias are necessary to effectively conduct from the surface of the PCB to the ground plane(s). The land pattern must be connected to ground through these vias. The vias act as 'heat pipes'. The number of vias (i.e. 'heat pipes') are application specific and dependent upon the package power dissipation as well as electrical conductivity requirements. Thus, thermal and electrical analysis and/or testing are recommended to determine the minimum number needed. Maximum thermal and electrical performance is achieved when an array of vias is incorporated in the land pattern. It is recommended to use as many vias connected to ground as possible. It is also recommended that the via

diameter should be 12 to 13mils (0.30 to 0.33mm) with 1 oz copper via barrel plating. This is desirable to avoid any solder wicking inside the via during the soldering process which may result in voids in solder between the exposed pad/slug and the thermal land. Precautions should be taken to eliminate any solder voids between the exposed heat slug and the land pattern.

Note: These recommendations are to be used as a guideline only. For further information, please refer to the Application Note on the Surface Mount Assembly of Amkor's Thermally/Electrically Enhance Lead frame Base Package, Amkor Technology.

8 ELECTRICAL SPECIFICATIONS

8.1 ABSOLUTE MAXIMUM RATING

Table 34: Absolute Maximum Rating

Symbol	Parameter	Min	Max	Unit
V_{DD}	Supply Voltage VDD	-0.5	4.0	V
V_{IN}	Input Voltage (non-supply pins)		5.5	V
V_{OUT}	Output Voltage (non-supply pins)		5.5	V
T_{STOR}	Storage Temperature	-50	+150	°C

8.2 RECOMMENDED OPERATION CONDITIONS

Table 35: Recommended Operation Conditions

Symbol	Parameter	Min	Typ	Max	Unit	Test Condition
V_{DD}	Power Supply (DC voltage) VDD	3.0	3.3	3.6	V	
T_A	Ambient Temperature Range	-40		+85	°C	
I_{DD}	Supply Current		233	262	mA	Exclude the loading current and power
P_{TOT}	Total Power Dissipation		0.77	0.94	W	

8.3 I/O SPECIFICATIONS

8.3.1 CMOS INPUT / OUTPUT PORT

Table 36: CMOS Input Port Electrical Characteristics

Parameter	Description	Min	Typ	Max	Unit	Test Condition
V_{IH}	Input Voltage High	2.0			V	
V_{IL}	Input Voltage Low			0.8	V	
I_{IN}	Input Current			10	μA	
V_{IN}	Input Voltage	-0.5		5.5	V	

Table 37: CMOS Input Port with Internal Pull-Up Resistor Electrical Characteristics

Parameter	Description	Min	Typ	Max	Unit	Test Condition
V_{IH}	Input Voltage High	2.0			V	
V_{IL}	Input Voltage Low			0.8	V	
P_U	Pull-Up Resistor	23		38	$K\Omega$	TDI, TMS pin
		41		82		$\overline{RST}$ pin
		82		165		
I_{IN}	Input Current	85		140	μA	TDI, TMS pin
		40		80		$\overline{RST}$ pin
		20		40		
V_{IN}	Input Voltage	-0.5		5.5	V	

Table 38: CMOS Input Port with Internal Pull-Down Resistor Electrical Characteristics

Parameter	Description	Min	Typ	Max	Unit	Test Condition
V_{IH}	Input Voltage High	2.0			V	
V_{IL}	Input Voltage Low			0.8	V	
P_D	Pull-Down Resistor	8		14	$K\Omega$	$\overline{TRST}$ and TCK pin
		16		23		other CMOS input port with internal pull-down resistor
		183		366		SDI, CLKE pin
I_{IN}	Input Current	390		640	μA	$\overline{TRST}$ and TCK pin
		180		340		other CMOS input port with internal pull-down resistor
		15		30		SDI, CLKE pin
V_{IN}	Input Voltage	-0.5		5.5	V	

Table 39: CMOS Output Port Electrical Characteristics

Application Pin	Parameter	Description	Min	Typ	Max	Unit	Test Condition
Output Clock	V_{OH}	Output Voltage High	2.4		V_{DD}	V	$I_{OH} = 8 \text{ mA}$
	V_{OL}	Output Voltage Low	0		0.4	V	$I_{OL} = 8 \text{ mA}$
	t_R	Rise time (20% to 80%)		3	4	ns	15 pF
	t_F	Fall time (20% to 80%)		3	4	ns	15 pF
Other Output	V_{OH}	Output Voltage High	2.4		V_{DD}	V	$I_{OH} = 4 \text{ mA}$
	V_{OL}	Output Voltage Low	0		0.4	V	$I_{OL} = 4 \text{ mA}$
	t_R	Rise Time (20% to 80%)			10	ns	50 pF
	t_F	Fall Time (20% to 80%)			10	ns	50 pF

8.3.2 PECL / LVDS OUTPUT PORT

8.3.2.1 PECL Output Port

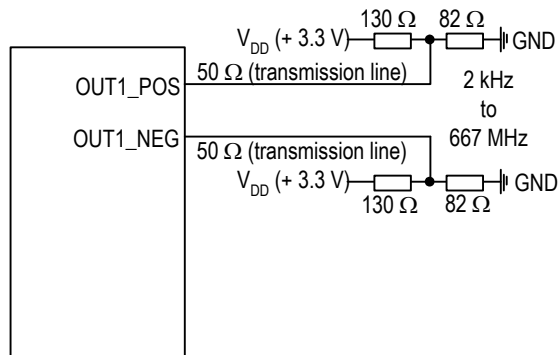


Figure 20. Recommended PECL Output Port Line Termination

Table 40: PECL Output Port Electrical Characteristics

Parameter	Description	Min	Typ	Max	Unit	Test Condition
V _{IL}	Input Low Voltage, Differential Inputs ¹	V _{DD} - 2.5		V _{DD} - 0.5	V	
V _{IH}	Input High Voltage, Differential Inputs ¹	V _{DD} - 2.4		V _{DD} - 0.4	V	
V _{ID}	Input Differential Voltage	0.1		1.4	V	
V _{IL_S}	Input Low Voltage, Single-ended Input ²	V _{DD} - 2.4		V _{DD} - 1.5	V	
V _{IH_S}	Input High Voltage, Single-ended Input ²	V _{DD} - 1.3		V _{DD} - 0.5	V	
I _{IH}	Input High Current, Input Differential Voltage V _{ID} = 1.4 V	-10		10	μA	
I _{IL}	Input Low Current, Input Differential Voltage V _{ID} = 1.4 V	-10		10	μA	
V _{OL}	Output Voltage Low ³	V _{DD} - 2.1		V _{DD} - 1.62	V	
V _{OH}	Output Voltage High ³	V _{DD} - 1.25		V _{DD} - 0.88	V	
V _{OD}	Output Differential Voltage ³	580		900	mV	
t _{RISE}	Output Rise time (20% to 80%)	200		300	pS	
t _{FALL}	Output Fall time (20% to 80%)	200		300	pS	
t _{SKEW}	Output Differential Skew			50	pS	

Note:

1. Assuming a differential input voltage of at least 100 mV.

2. Unused differential input terminated to V_{DD}-1.4 V.

3. With 50 Ω load on each pin to V_{DD}-2 V, i.e. 82 to GND and 130 to V_{DD}.

8.3.2.2 LVDS Output Port

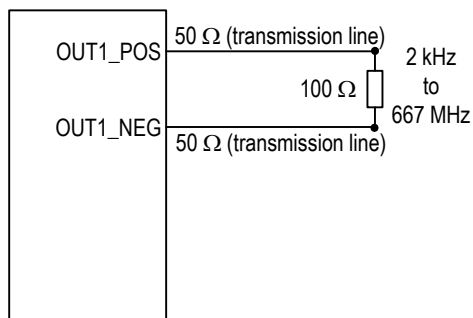


Figure 21. Recommended LVDS Output Port Line Termination

Table 41: LVDS Output Port Electrical Characteristics

Parameter	Description	Min	Typ	Max	Unit	Test Condition
V_{CM}	Input Common-mode Voltage Range	0	1200	2400	mV	
V_{DIFF}	Input Peak Differential Voltage	100		900	mV	
V_{IDTH}	Input Differential Threshold	-100		100	mV	
R_{TERM}	External Differential Termination Impedance	95	100	105	Ω	
V_{OH}	Output Voltage High	1350		1475	mV	$R_{LOAD} = 100 \Omega \pm 1\%$
V_{OL}	Output Voltage Low	925		1100	mV	$R_{LOAD} = 100 \Omega \pm 1\%$
V_{OD}	Differential Output Voltage	250		400	mV	$R_{LOAD} = 100 \Omega \pm 1\%$
V_{OS}	Output Offset Voltage	1125		1275	mV	$R_{LOAD} = 100 \Omega \pm 1\%$
R_O	Differential Output Impedance	80	100	120	Ω	$V_{CM} = 1.0 \text{ V or } 1.4 \text{ V}$
ΔR_O	R_O Mismatch between A and B			20	%	$V_{CM} = 1.0 \text{ V or } 1.4 \text{ V}$
ΔV_{OD}	Change in V_{OD} between Logic 0 and Logic 1			25	mV	$R_{LOAD} = 100 \Omega \pm 1\%$
ΔV_{OS}	Change in V_{OS} between Logic 0 and Logic 1			25	mV	$R_{LOAD} = 100 \Omega \pm 1\%$
I_{SA}, I_{SB}	Output Current			24	mA	Driver shorted to GND
I_{SAB}	Output Current			12	mA	Driver shorted together
t_{RISE}	Output Rise time (20% to 80%)	200		300	pS	$R_{LOAD} = 100 \Omega \pm 1\%$
t_{FALL}	Output Fall time (20% to 80%)	200		300	pS	$R_{LOAD} = 100 \Omega \pm 1\%$
t_{SKEW}	Output Differential Skew			50	pS	$R_{LOAD} = 100 \Omega \pm 1\%$

8.4 JITTER & WANDER PERFORMANCE

Table 42: Output Clock Jitter Generation

Test Definition ¹	Peak to Peak Typ	RMS Typ	Note	Test Filter
N x 2.048MHz without APLL	<2 ns	<200 ps		20 Hz - 100 kHz
N x 2.048MHz with T0/T4 APLL	<1 ns	<100 ps	See Table 43: Output Clock Phase Noise for details	20 Hz - 100 kHz
N x 1.544 MHz without APLL	<2 ns	<200 ps		10 Hz - 40 kHz
N x 1.544 MHz with T0/T4 APLL	<1 ns	<100 ps	See Table 43: Output Clock Phase Noise for details	10 Hz - 40 kHz
44.736 MHz with T0/T4 APLL	<1 ns	<100 ps	See Table 43: Output Clock Phase Noise for details	100 Hz - 800 kHz
44.736 MHz without APLL	<2 ns	<200 ps		100 Hz - 800 kHz
34.368 MHz with T0/T4 APLL	<1 ns	<100 ps	See Table 43: Output Clock Phase Noise for details	10 Hz - 400 kHz
34.368 MHz without APLL	<2 ns	<200 ps		10 Hz - 400 kHz
OC-3 (Chip T0 DPLL + T0/T4 APLL) 6.48 MHz, 19.44 MHz, 25.92 MHz, 38.88 MHz, 51.84 MHz, 77.76 MHz, 155.52 MHz, 311.04 MHz, 622.08 MHz output	0.004 UI p-p	0.001 UI RMS	GR-253, G.813 Option 2 limit 0.1 UI p-p (1 UI-6430 ps)	12 kHz - 1.3 MHz
	0.004 UI p-p	0.001 UI RMS	G.813 Option 1, G.812 limit 0.5 UI p-p (1 UI-6430 ps)	500 Hz - 1.3 MHz
	0.001 UI p-p	0.001 UI RMS	G.813 Option 1 limit 0.1 UI p-p (1 UI-6430 ps)	65 kHz - 1.3 MHz
OC-12 (Chip T0 DPLL + T0/T4 APLL) 6.48 MHz, 19.44 MHz, 25.92 MHz, 38.88 MHz, 51.84 MHz, 77.76 MHz, 155.52 MHz, 311.04 MHz, 622.08 MHz output + Intel GD16523 + Optical transceiver)	0.018 UI p-p	0.007 UI RMS	GR-253, G.813 Option 2 limit 0.1 UI p-p (1 UI-1608 ps)	12 kHz - 5 MHz
	0.028 UI p-p	0.009 UI RMS	G.813 Option 1, G.812 limit 0.5 UI p-p (1 UI-1608 ps)	1 kHz - 5 MHz
	0.002 UI p-p	0.001 UI RMS	G.813 Option 1, G.812 limit 0.1 UI p-p (1 UI-160 8ps)	250 kHz - 5 MHz
STM-16 (Chip T0 DPLL + T0/T4 APLL) 6.48 MHz, 19.44 MHz, 25.92 MHz, 38.88 MHz, 51.84 MHz, 77.76 MHz, 155.52 MHz, 311.04 MHz, 622.08 MHz output + Intel GD16523 + Optical transceiver)	0.162 UI p-p	0.03 UI RMS	G.813 Option 1, G.812 limit 0.5 UI p-p (1 UI-402 ps)	5 kHz - 20 MHz
	0.01 UI p-p	0.009 UI RMS	G.813 Option 1, G.812 limit 0.1 UI p-p (1 UI-402 ps)	1 MHz - 20 MHz
Note: 1. CMAC E2747 TCXO is used.				

Table 43: Output Clock Phase Noise

Output Clock ¹	@100Hz Offset Typ	@1kHz Offset Typ	@10kHz Offset Typ	@100kHz Offset Typ	@1MHz Offset Typ	@5MHz Offset Typ	Unit
622.08 MHz (T0 DPLL + T0/T4 APLL)	-70	-86	-95	-100	-107	-128	dBC/Hz
155.52 MHz (T0 DPLL + T0/T4 APLL)	-82	-98	-107	-112	-119	-140	dBC/Hz
38.88 MHz (T0 DPLL + T0/T4 APLL)	-94	-110	-118	-124	-131	-143	dBC/Hz
16E1 (T0/T4 APLL)	-94	-110	-118	-125	-131	-142	dBC/Hz
16T1 (T0/T4 APLL)	-95	-112	-120	-127	-132	-143	dBC/Hz
E3 (T0/T4 APLL)	-93	-109	-116	-124	-131	-138	dBC/Hz
T3 (T0/T4 APLL)	-92	-108	-116	-122	-126	-141	dBC/Hz

Note:

1. CMAC E2747 TCXO is used.

Table 44: Input Jitter Tolerance (155.52 MHz)

Jitter Frequency	Jitter Tolerance Amplitude (UI p-p)
12 μ Hz	> 2800
178 μ Hz	> 2800
1.6 mHz	> 311
15.6 mHz	> 311
0.125 Hz	> 39
19.3 Hz	> 39
500 Hz	> 1.5
6.5 kHz	> 1.5
65 kHz	> 0.15
1.3 MHz	> 0.15

Table 46: Input Jitter Tolerance (2.048 MHz)

Jitter Frequency	Jitter Tolerance Amplitude (UI p-p)
1 Hz	150
5 Hz	140
20 Hz	130
300 Hz	40
400 Hz	33
700 Hz	18
2400 Hz	5.5
10 kHz	1.3
50 kHz	0.4
100 kHz	0.4

Table 45: Input Jitter Tolerance (1.544 MHz)

Jitter Frequency	Jitter Tolerance Amplitude (UI p-p)
1 Hz	150
5 Hz	140
20 Hz	130
300 Hz	38
400 Hz	25
700 Hz	15
2400 Hz	5
10 kHz	1.2
40 kHz	0.5

Table 47: Input Jitter Tolerance (8 kHz)

Jitter Frequency	Jitter Tolerance Amplitude (UI p-p)
1 Hz	0.8
5 Hz	0.7
20 Hz	0.6
300 Hz	0.16
400 Hz	0.14
700 Hz	0.07
2400 Hz	0.02
3600 Hz	0.01

Table 48: T0 DPLL Jitter Transfer & Damping Factor

3 dB Bandwidth	Programmable Damping Factor
0.1 Hz	1.2, 2.5, 5, 10, 20
0.3 Hz	1.2, 2.5, 5, 10, 20
0.6 Hz	1.2, 2.5, 5, 10, 20
1.2 Hz	1.2, 2.5, 5, 10, 20
2.5 Hz	1.2, 2.5, 5, 10, 20
4 Hz	1.2, 2.5, 5, 10, 20
8 Hz	1.2, 2.5, 5, 10, 20
18 Hz	1.2, 2.5, 5, 10, 20
35 Hz	1.2, 2.5, 5, 10, 20
70 Hz	1.2, 2.5, 5, 10, 20
560 Hz	1.2, 2.5, 5, 10, 20

8.5 OUTPUT WANDER GENERATION

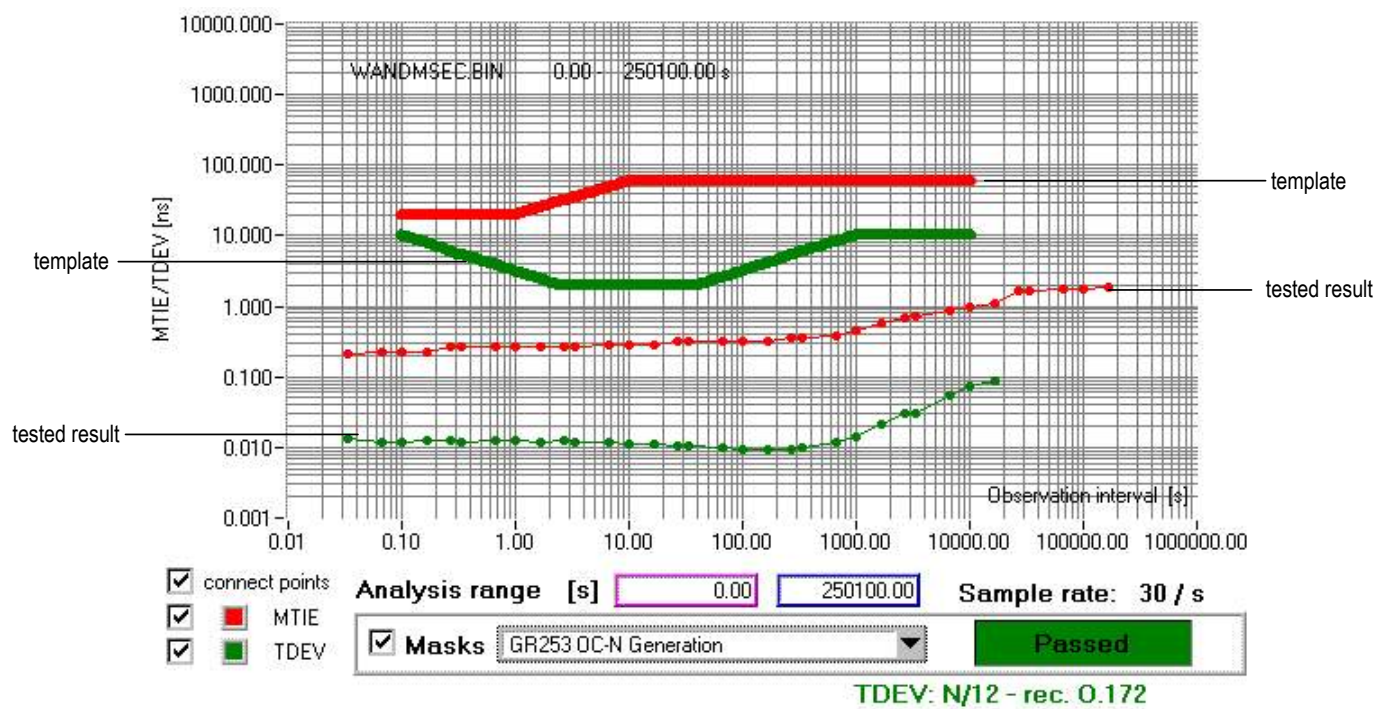


Figure 22. Output Wander Generation

8.6 INPUT / OUTPUT CLOCK TIMING

The inputs and outputs are aligned ideally. But due to the circuit delays, there is delay between the inputs and outputs.

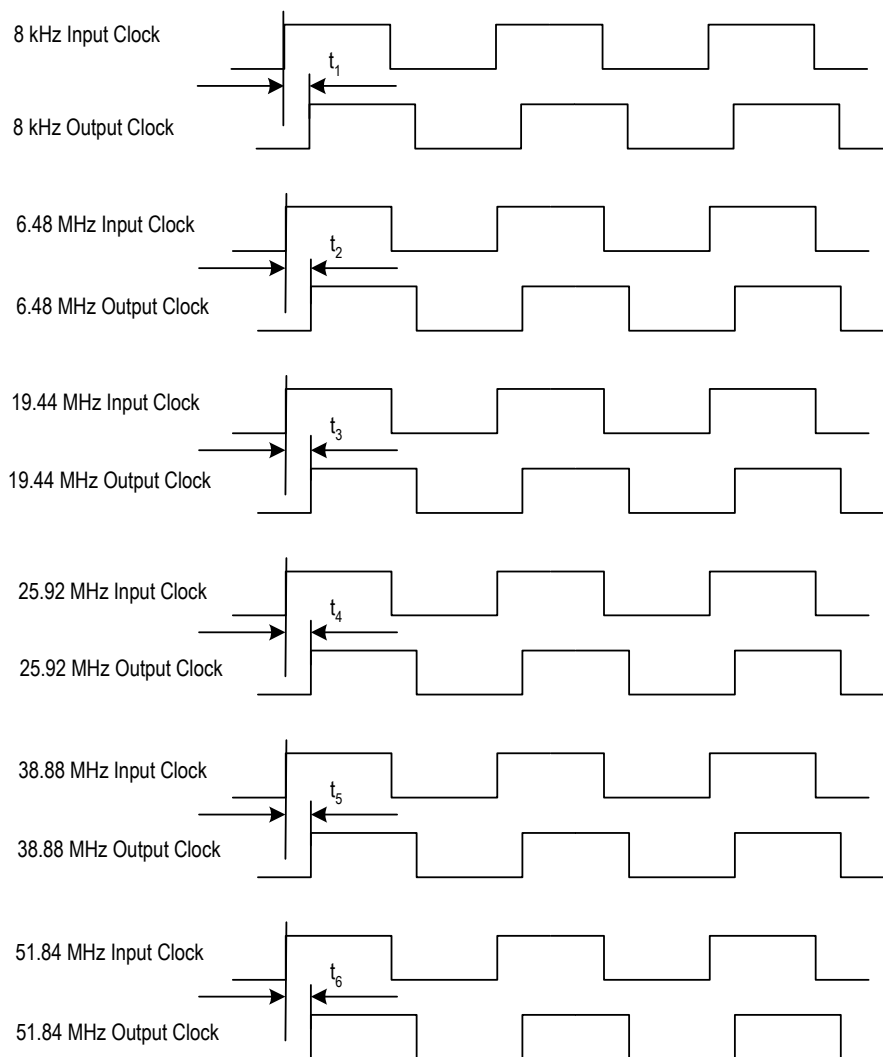


Figure 23. Input / Output Clock Timing

Table 49: Input/Output Clock Timing

Symbol	Typical Delay ¹ (ns)	Peak to Peak Delay Variation (ns)
t_1	4	1.6
t_2	1	1.6
t_3	1	1.6
t_4	2	1.6
t_5	1.4	1.6
t_6	3	1.6

Note:

1. Typical delay provided as reference only.

8.7 OUTPUT CLOCK TIMING

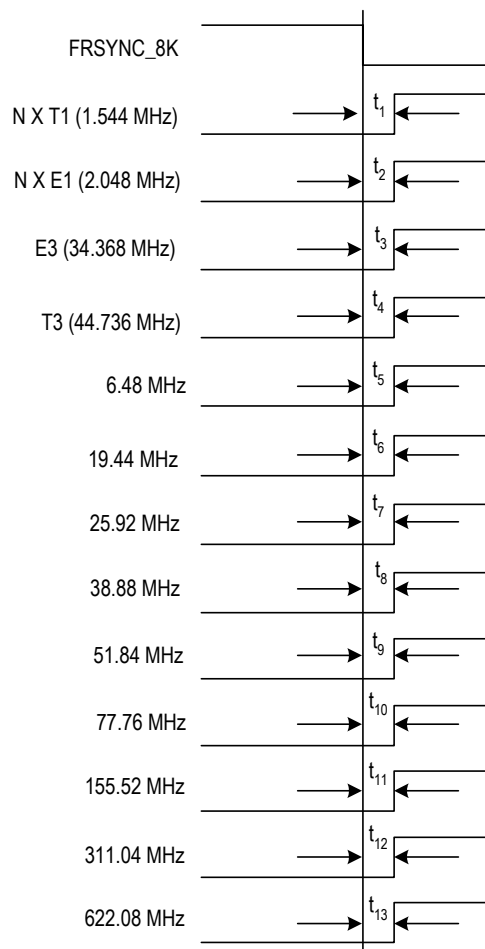


Table 50: Output Clock Timing

Symbol	Typical Delay (ns)	Peak to Peak Delay Variation (ns)
t_1	0	2
t_2	0	2
t_3	0	2
t_4	0	2
t_5	0	2
t_6	0	2
t_7	0	2
t_8	0	2
t_9	0	2
t_{10}	0	2
t_{11}	0	1.5
t_{12}	0	1.5 (not recommended to use)
t_{13}	0	1.5 (not recommended to use)



Glossary

3G	---	Third Generation
ADSL	---	Asymmetric Digital Subscriber Line
AMI	---	Alternate Mark Inversion
APLL	---	Analog Phase Locked Loop
ATM	---	Asynchronous Transfer Mode
BITS	---	Building Integrated Timing Supply
CMOS	---	Complementary Metal-Oxide Semiconductor
DCO	---	Digital Controlled Oscillator
DPLL	---	Digital Phase Locked Loop
DSL	---	Digital Subscriber Line
DSLAM	---	Digital Subscriber Line Access MUX
DWDM	---	Dense Wavelength Division Multiplexing
EPROM	---	Erasable Programmable Read Only Memory
GPS	---	Global Positioning System
GSM	---	Global System for Mobile Communications
IIR	---	Infinite Impulse Response
IP	---	Internet Protocol
ISDN	---	Integrated Services Digital Network
JTAG	---	Joint Test Action Group
LOS	---	Loss Of Signal
LPF	---	Low Pass Filter
LVDS	---	Low Voltage Differential Signal
MTIE	---	Maximum Time Interval Error
MUX	---	Multiplexer
OBSAI	---	Open Base Station Architecture Initiative
OC-n	---	Optical Carried rate, n = 1, 3, 12, 48, 192, 768; 51 Mbit/s, 155 Mbit/s, 622 Mbit/s, 2.5 Gbit/s, 10 Gbit/s, 40 Gbit/s.

PBO	---	Phase Build-Out
PDH	---	Plesiochronous Digital Hierarchy
PECL	---	Positive Emitter Coupled Logic
PFD	---	Phase & Frequency Detector
PLL	---	Phase Locked Loop
RMS	---	Root Mean Square
PRS	---	Primary Reference Source
SDH	---	Synchronous Digital Hierarchy
SEC	---	SDH / SONET Equipment Clock
SMC	---	SONET Minimum Clock
SONET	---	Synchronous Optical Network
SSU	---	Synchronization Supply Unit
STM	---	Synchronous Transfer Mode
TCM-ISDN	---	Time Compression Multiplexing Integrated Services Digital Network
TDEV	---	Time Deviation
UI	---	Unit Interval
WLL	---	Wireless Local Loop



Index

A		Frequency Hard Alarm	22, 27
Averaged Phase Error	31	Frequency Hard Alarm Threshold	22
B		H	
Bandwidths and Damping Factors	31	Hard Limit	25
Acquisition Bandwidth and Damping Factor	31	Holdover Frequency Offset	32
Locked Bandwidth and Damping Factor	31	I	
Starting Bandwidth and Damping Factor	31	IIR	32
C		Input Clock Frequency	22
Calibration	18	Input Clock Selection	23
Coarse Phase Loss	25	Automatic selection	24, 27
Crystal Oscillator	18	External Fast selection	27
Current Frequency Offset	31	Forced selection	24, 27
D		Internal Leaky Bucket Accumulator	21
DCO	31	Bucket Size	21
Division Factor	20	Decay Rate	21
DPLL Hard Alarm	25	Lower Threshold	21
DPLL Hard Limit	25	Upper Threshold	21
DPLL Operating Mode		L	
Free-Run mode	31	Limit	34
Holdover mode	31	LPF	31
Automatic Fast Averaged	32	M	
Automatic Instantaneous	32	Master Clock	18
Automatic Slow Averaged	32	N	
Manual	32	No-activity Alarm	21, 27
Locked mode	31	P	
Temp-Holdover mode	31	PFD	31
Lost-Phase mode	31	Phase Lock Alarm	25, 27
Pre-Locked mode	31	Phase-compared	25, 34
Pre-Locked2 mode	32	Phase-time	34
DPLL Soft Alarm	25	Pre-Divider	20
DPLL Soft Limit	25	DivN Divider	20
E		Lock 8k Divider	20
External Sync Alarm	38	R	
F		Reference Clock	22
Fast Loss	25		
Fine Phase Loss	25		

S

Selected Input Clock Switch	27
Non-Revertive switch	27
Revertive switch	27

State Machine	29
---------------------	----

V

Validity	27
----------------	----

PACKAGE DIMENSIONS

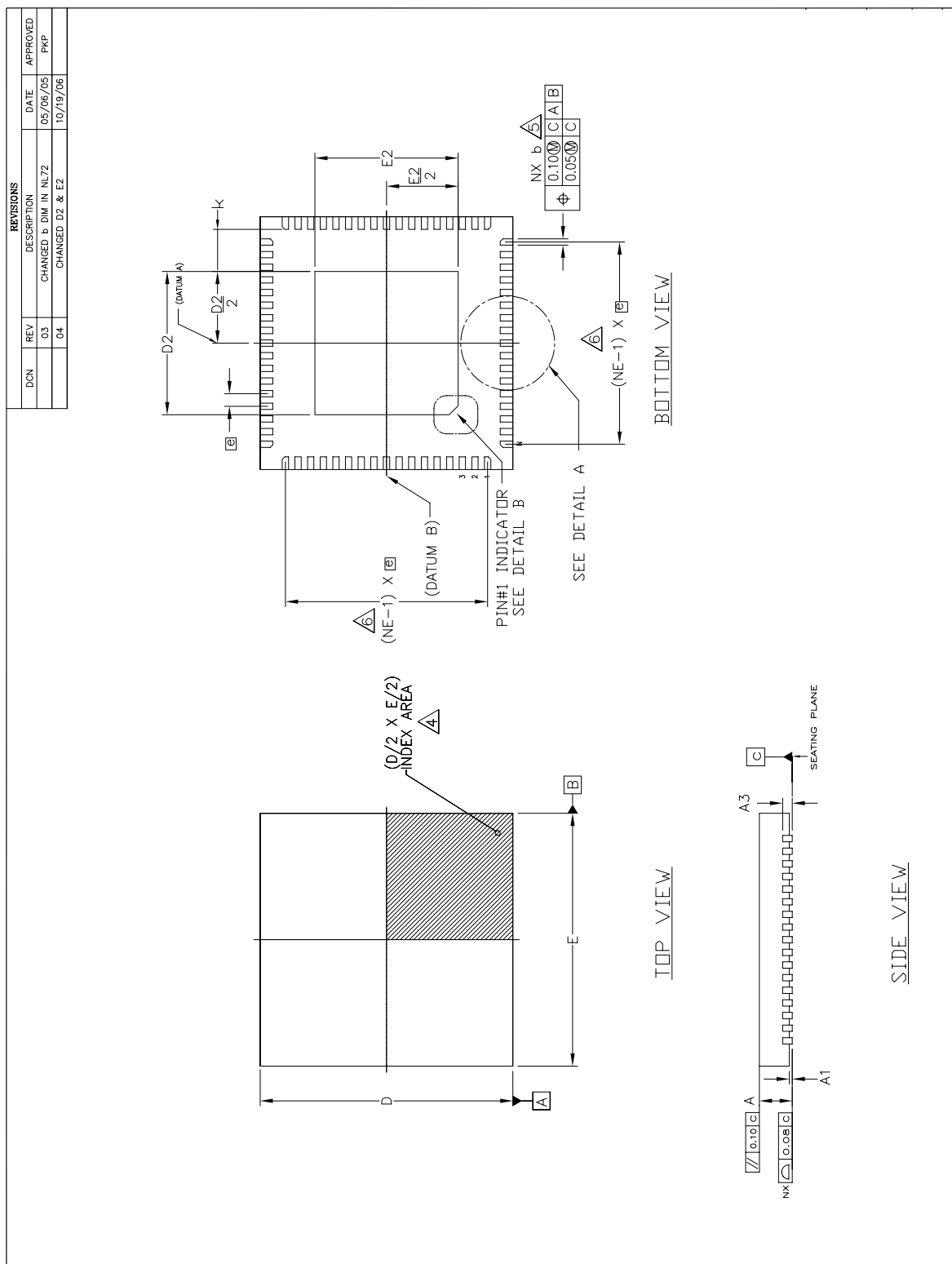


Figure 24. 68-Pin NL Package Dimensions (a) (in Millimeters)

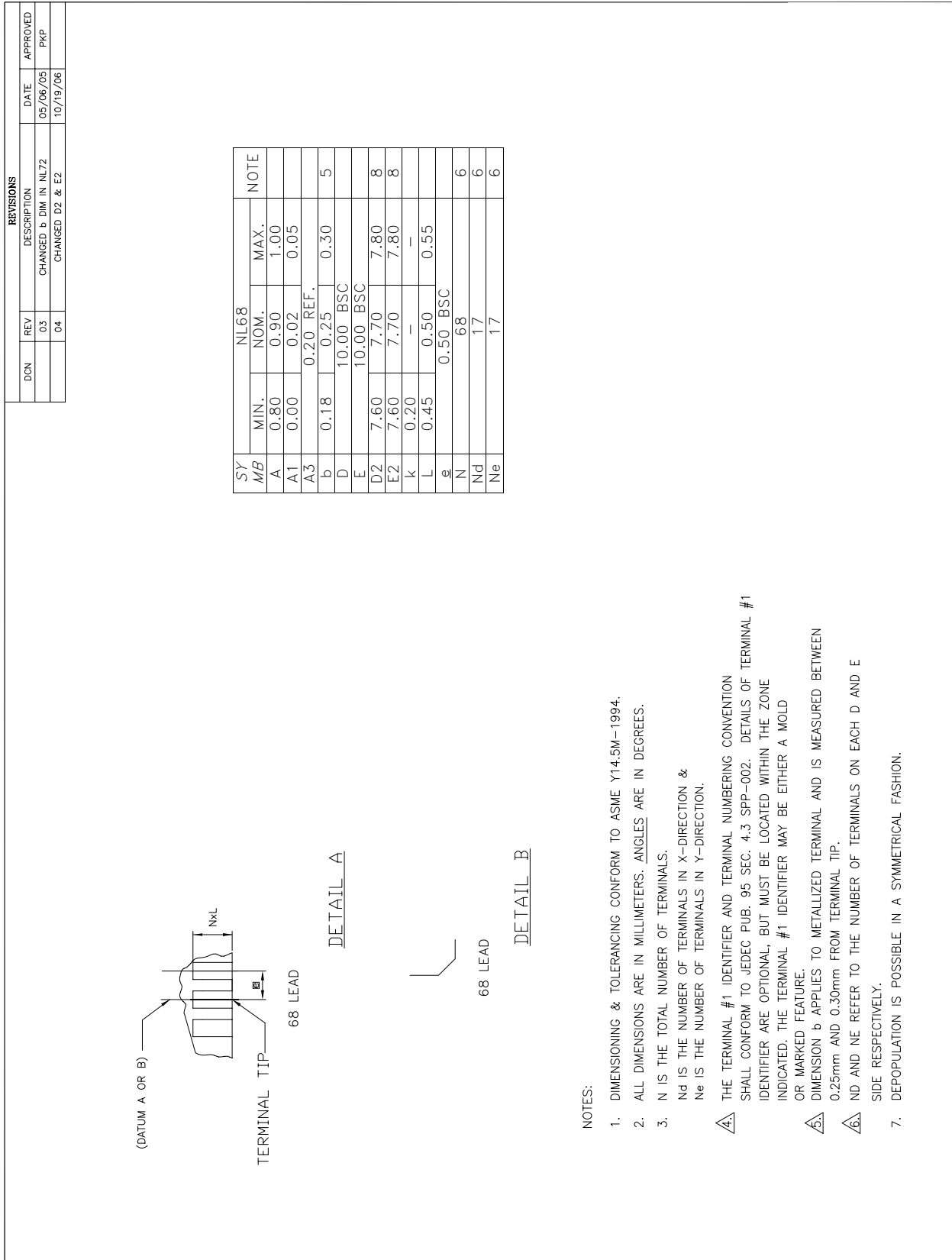


Figure 25. 68-Pin NL Package Dimensions (b) (in Millimeters)

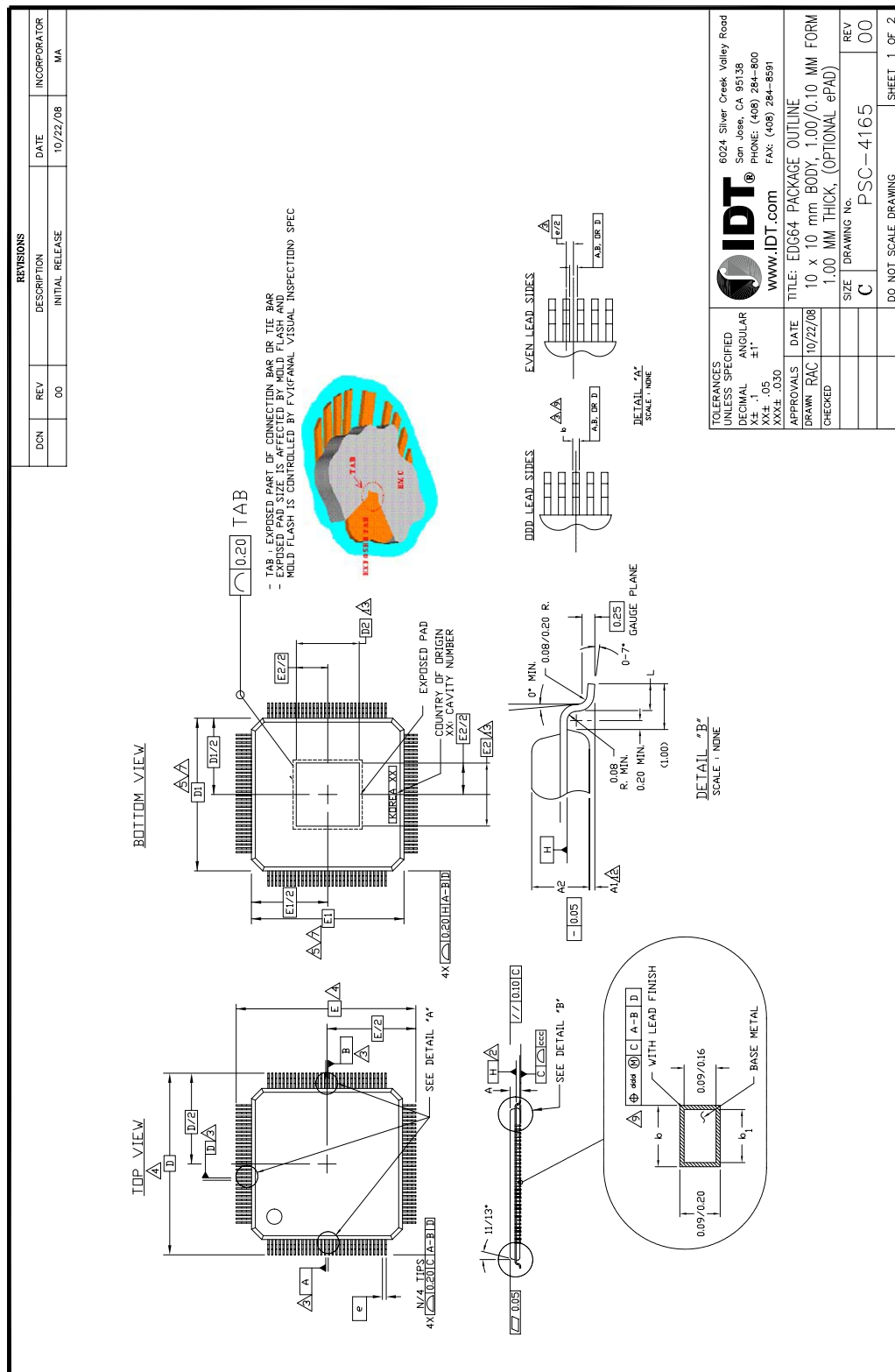


Figure 26. 64-Pin EDG Package Dimensions (a) (in Millimeters)

NOTES:

1. ALL DIMENSIONING AND TOLERANCING CONFORM TO ANSI Y14.5-1982.

DATUM PLANE **(H)** LOCATED AT MOLD PARTING LINE AND COINCIDENT WITH LEAD, WHERE LEAD EXITS PLASTIC BODY AT BOTTOM OF PARTING LINE.

DATUMS **(A-B)** AND **(D)** TO BE DETERMINED AT CENTERLINE BETWEEN LEADS WHERE LEADS EXIT PLASTIC BODY AT DATUM PLANE **(H)**.

TO BE DETERMINED AT SEATING PLANE **(C)**.

DIMENSIONS D1 AND E1 DO NOT INCLUDE MOLD PROTRUSION. ALLOWABLE MOLD PROTRUSION IS 0254 MM ON D1 AND E1 DIMENSIONS.

6. "N" IS THE TOTAL NUMBER OF TERMINALS.

THESE DIMENSIONS TO BE DETERMINED AT DATUM PLANE **(H)**.

JEDEC VARIATION ALL DIMENSIONS IN MILLIMETERS				
SYMBOL	ACD			N D T E
	MIN.	NDR.	MAX.	
A	~	~	1.20	
A1	0.05	~	0.15	12
A2	0.95	1.00	1.05	
D	12.00 BSC.			4
D1	10.00 BSC.			7.8
E	12.00 BSC.			4
E1	10.00 BSC.			7.8
L	0.45	0.60	0.75	
N	64			
e	0.50 BSC.			
b	0.17	0.22	0.27	9
b1	0.17	0.20	0.23	
ccc	~	~	0.08	
ddd	~	~	0.08	

REVISIONS			
DCN	REV	DESCRIPTION	DATE
	00	INITIAL RELEASE	10/22/08
			MA

8. PACKAGE TOP DIMENSIONS ARE SMALLER THAN BOTTOM DIMENSIONS AND TOP OF PACKAGE WILL NOT OVERHANG BOTTOM OF PACKAGE.

DIMENSION **b** DOES NOT INCLUDE DAMBAR PROTRUSION. ALLOWABLE DAMBAR PROTRUSION SHALL BE 0.08mm TOTAL IN EXCESS OF THE **b** DIMENSION AT MAXIMUM MATERIAL CONDITION. DAMBAR CANNOT BE LOCATED ON THE LOWER RADIUS OR THE FOOT.

10. CONTROLLING DIMENSION: MILLIMETER.

11. THIS OUTLINE CONFORMS TO JEDEC PUBLICATION 95 REGISTRATION MS-026, VARIATIONS ACB, ACC, ACD & ACE.

A1 IS DEFINED AS THE DISTANCE FROM THE SEATING PLANE TO THE LOWEST POINT OF THE PACKAGE BODY.

DIMENSION D2 AND E2 REPRESENT THE SIZE OF THE EXPOSED PAD. THE ACTUAL DIMENSIONS ARE SPECIFIED ON THE BONDING DIAGRAM, AND IS DEPENDENT ON THE DIE SIZE.

14. EXPOSED PAD SHALL BE COPLANAR WITH BOTTOM OF PACKAGE.

TOLERANCES UNLESS SPECIFIED DECIMAL ANGULAR ±1	 6024 Silver Creek Valley Road San Jose, CA 95138 PHONE: (408) 284-3800 FAX: (408) 284-8591		
APPROVALS	DATE	TITLE: EDG64 PACKAGE OUTLINE	
DRAWN RAC	10/22/08	10 x 10 mm BODY, 1.00/0.10 MM FORM 1.00 MM THICK, (OPTIONAL ePAD)	
CHECKED		SIZE	DRAWING No.
		REV	
		C	PSC-4165
			00
		DO NOT SCALE DRAWING	
		SHEET 2 OF 2	

Figure 27. 64-Pin EDG Package Dimensions (b) (in Millimeters)

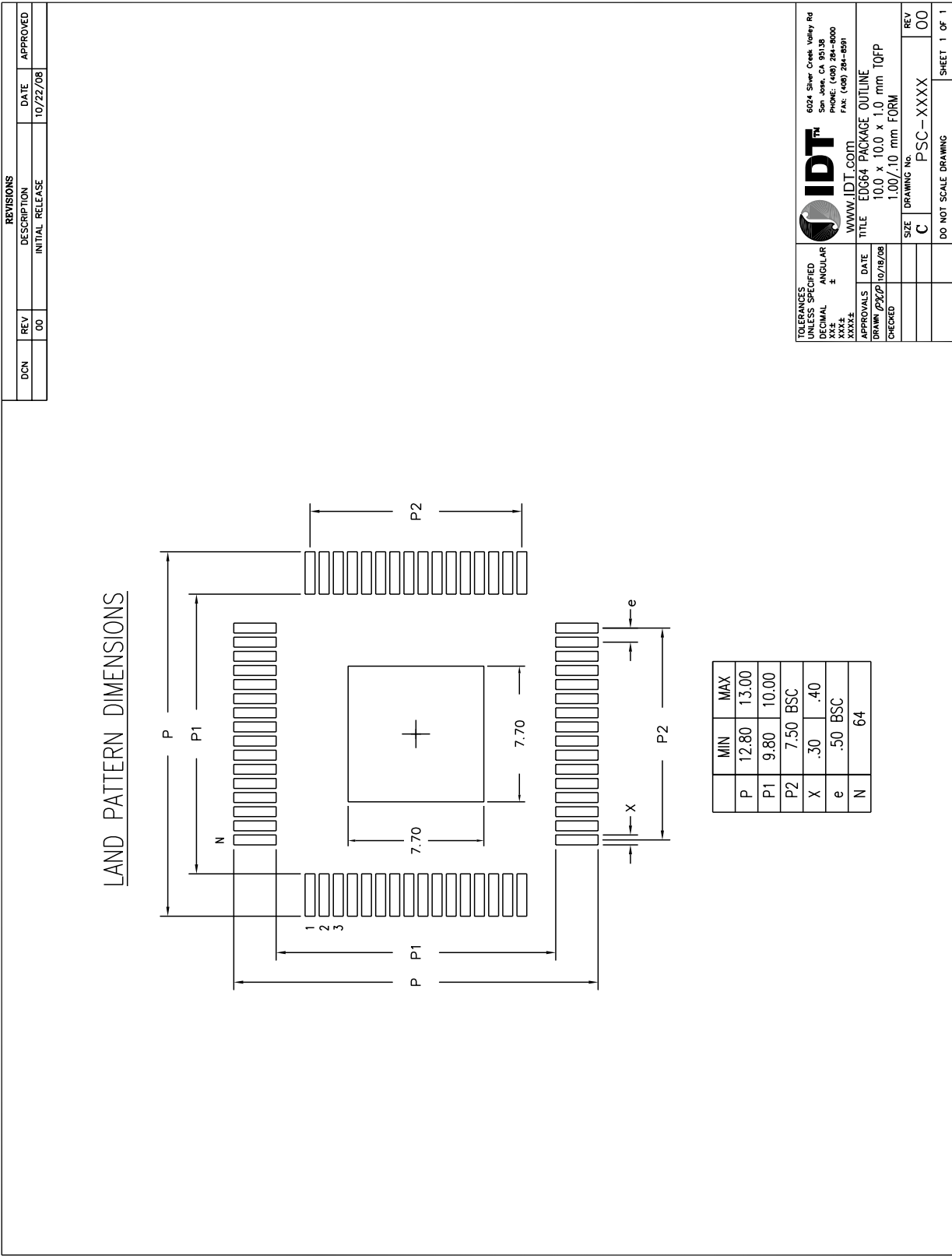
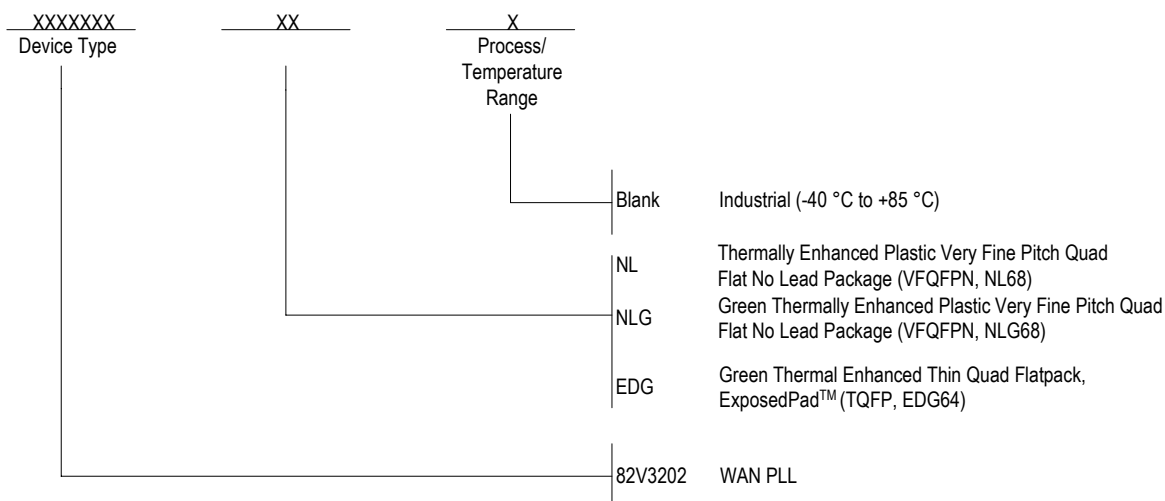


Figure 28. EDG64 Recommended Land Pattern with Exposed Pad (in Millimeters)

ORDERING INFORMATION



DATASHEET DOCUMENT HISTORY

3/11/2008	Pages 7, 11, 14, 110, 103, 111, 112, 113,
9/17/2008	Page 108
3/20/2009	Pages 94, 95, 101, 113, 114, 115, 116
7/23/2009	Pages 14, 15, 98
9/11/2009	Page 45



CORPORATE HEADQUARTERS
 6024 Silver Creek Valley Road
 San Jose, CA 95138
www.idt.com

for SALES:
 1-800-345-7015 or 408-284-8200
 fax: 408-284-2775

for Tech Support:
 408-360-1552
 email: telecomhelp@idt.com